

Pseudo SRAM and NOR Flash Memory Mixed Multi-Chip Package**DESCRIPTION**

The TY00680002/003ADGB is a mixed multi-chip package containing a 67,108,864-bit pseudo static RAM and a 268,435,456-bit Nor Flash Memory. The TY00680002/003ADGB is available in a 81-pin BGA package making it suitable for a variety of applications.

MCP Features

- Power supply voltage of 1.70 to 1.95 V
- Operating temperature of -30° to 85°C
- Package
P-TFBGA81-0710-0.80BZ (Weight: 0.15 g)

Pseudo SRAM Features

- Organization : 4M × 16 bits
- Power dissipation
 - Operating : 50 mA maximum
 - Standby : 200 μA maximum
 - Deep power-down standby : 10 μA maximum
- Access time :
 - Random / Page : 75 ns / 25 ns @CL=30pF
- Page read operation by 8 words
- Deep power-down mode : Memory cell data invalid

Nor Flash Memory Features

- Organization: 16M × 16 bits
- Power dissipation
 - Read operation : 40 mA maximum
 - Address Increment Read operation : 8.2 mA maximum
 - Page Read operating : 5 mA maximum
 - Program operation : 20 mA maximum
 - Erase operation : 25 mA maximum
 - Standby : 25 μA maximum
- Access time :
 - Random : 70 ns @CL=30pF
 - Page : 15 ns @CL=30pF
- Functions
 - Simultaneous Read/Write
 - Page Read
 - Auto Program
 - Auto Page Program(8word)
 - Auto Block Erase
 - Auto Chip Erase
 - Program Suspend/Resume
 - Erase Suspend/Resume
 - Data polling/Toggle bit
 - Password block protection
 - Block protection/ Boot block protection
 - Automatic Sleep, support for hidden ROM area
 - Common Flash memory Interface (CFI)
- Block erase architecture
 - 8 × 8 Kwords / 255 × 64 Kwords
- Bank architecture
 - 16 Mbits × 16 Banks
- Boot block architecture
 - TY00680002ADGB : top boot block
 - TY00680003ADGB : bottom boot block
- Mode control
 - Compatible with JEDEC standard commands
- Erase/Program cycles
 - 100,000 cycles typ.

PIN ASSIGNMENT (TOP VIEW)

	1	2	3	4	5	6	7	8
A	NC							NC
B	NC	NC	NC	NC	NC	NC	NC	NC
C	NC	A7	\overline{LB}	\overline{WP}	\overline{WE}	A8	A11	
D	A3	A6	\overline{UB}	\overline{RESET}	CE2ps	A19	A12	A15
E	A2	A5	A18	RY/ \overline{BYf}	A20	A9	A13	A21
F	A1	A4	A17	NC	A23	A10	A14	A22
G	A0	V _{SS}	DQ1	NC	NC	DQ6	NC	A16
H	\overline{CEf}	\overline{OE}	DQ9	DQ3	DQ4	DQ13	DQ15	NC
J	$\overline{CE1ps}$	DQ0	DQ10	V _{CCf}	V _{CCps}	DQ12	DQ7	V _{SS}
K		DQ8	DQ2	DQ11	NC	DQ5	DQ14	
L	NC	NC	NC	NC	NC	NC	NC	NC
M	NC							NC

PIN NAMES

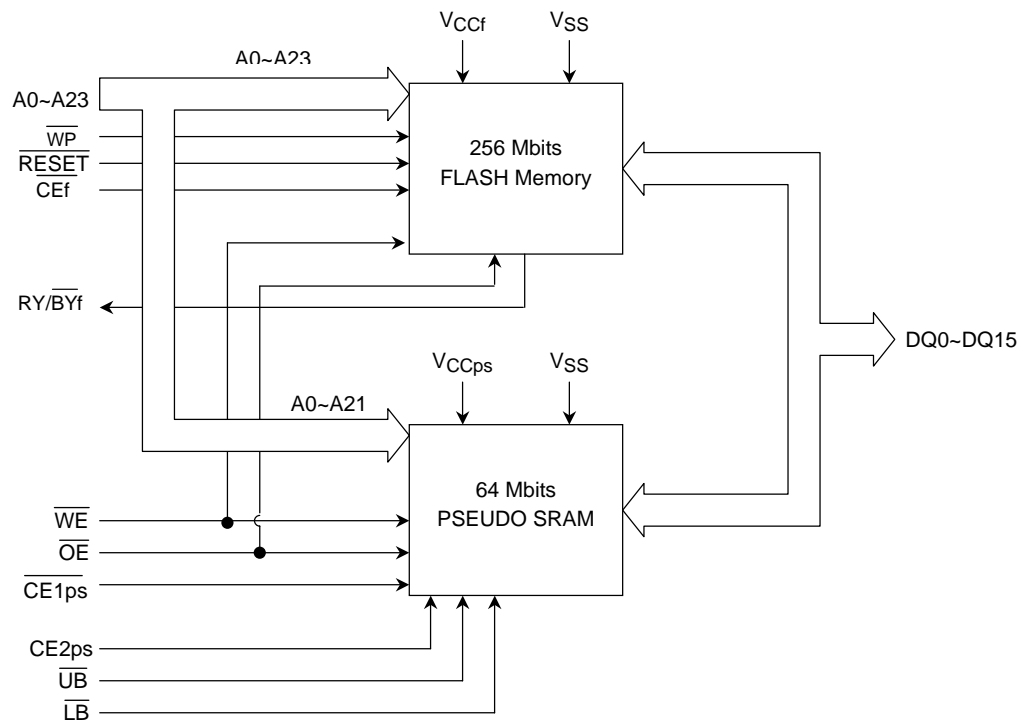
A0 to A23	Address inputs
DQ0 to DQ15	Data inputs / outputs
$\overline{CE1ps}$, $\overline{CE2ps}$	Chip enable inputs for Pseudo SRAM
\overline{CEf}	Chip enable inputs for Nor Flash Memory
\overline{OE}	Output enable input
\overline{WE}	Write enable input
\overline{LB} , \overline{UB}	Data byte control inputs for Pseudo SRAM
\overline{WP}	Write protect for Nor Flash Memory
\overline{RESET}	Hardware reset input for Nor Flash Memory
RY/ \overline{BYf}	Ready/Busy output for Nor Flash Memory
V _{CCps}	Power supply for Pseudo SRAM
V _{CCf}	Power supply for Nor Flash Memory
V _{SS}	Ground
NC	Not connected

PIN NAME CONVERSION TABLE

MCP Pin		64M	256M
Location	Name	PSRAM	Nor
A1	NC	–	–
A2	–	–	–
A3	–	–	–
A4	–	–	–
A5	–	–	–
A6	–	–	–
A7	–	–	–
A8	NC	–	–
B1	NC	–	–
B2	NC	–	–
B3	NC	–	–
B4	NC	–	–
B5	NC	–	–
B6	NC	–	–
B7	NC	–	–
B8	NC	–	–
C1	NC	–	–
C2	A7	A7	A7
C3	LB	LB	–
C4	WP	–	WP
C5	WE	WE	WE
C6	A8	A8	A8
C7	A11	A11	A11
C8	–	–	–
D1	A3	A3	A3
D2	A6	A6	A6
D3	UB	UB	–
D4	RESET	–	RESET
D5	CE2ps	CE2	–
D6	A19	A19	A19
D7	A12	A12	A12
D8	A15	A15	A15
E1	A2	A2	A2
E2	A5	A5	A5
E3	A18	A18	A18
E4	RY/ BY f	–	RY/ BY
E5	A20	A20	A20
E6	A9	A9	A9
E7	A13	A13	A13
E8	A21	A21	A21
F1	A1	A1	A1
F2	A4	A4	A4
F3	A17	A17	A17
F4	NC	–	–
F5	A23	–	A23
F6	A10	A10	A10
F7	A14	A14	A14
F8	A22	–	A22

MCP Pin		64M	256M
Location	Name	SRAM	Nor
G1	A0	A0	A0
G2	V _{SS}	GND	V _{SS}
G3	DQ1	I/O2	DQ1
G4	NC	–	–
G5	NC	–	–
G6	DQ6	I/O7	DQ6
G7	NC	–	–
G8	A16	A16	A16
H1	CE	–	CE
H2	OE	OE	OE
H3	DQ9	I/O10	DQ9
H4	DQ3	I/O4	DQ3
H5	DQ4	I/O5	DQ4
H6	DQ13	I/O14	DQ13
H7	DQ15	I/O16	DQ15
H8	NC	–	–
J1	CE1ps	CE1	–
J2	DQ0	I/O1	DQ0
J3	DQ10	I/O11	DQ10
J4	V _{CCf}	–	V _{CC}
J5	V _{CCps}	V _{DD}	–
J6	DQ12	I/O13	DQ12
J7	DQ7	I/O8	DQ7
J8	V _{SS}	GND	V _{SS}
K1	–	–	–
K2	DQ8	I/O9	DQ8
K3	DQ2	I/O3	DQ2
K4	DQ11	I/O12	DQ11
K5	NC	NC	NC
K6	DQ5	I/O6	DQ5
K7	DQ14	I/O15	DQ14
K8	–	–	–
L1	NC	–	–
L2	NC	–	–
L3	NC	–	–
L4	NC	–	–
L5	NC	–	–
L6	NC	–	–
L7	NC	–	–
L8	NC	–	–
M1	NC	–	–
M2	–	–	–
M3	–	–	–
M4	–	–	–
M5	–	–	–
M6	–	–	–
M7	–	–	–
M8	NC	–	–

BLOCK DIAGRAM




MODE SELECTION

Pseudo SRAM

MODE	$\overline{CE1ps}$	CE2ps	\overline{OE}	\overline{WE}	\overline{LB}	\overline{UB}	Add	DQ0~DQ7	DQ8~DQ15
Read(Word)	L	H	L	H	L	L	X	D _{OUT}	D _{OUT}
Read(Lower Byte)					L	H		D _{OUT}	High-Z
Read(Upper Byte)					H	L		High-Z	D _{OUT}
Write(Word)			X	L	L	L		D _{IN}	D _{IN}
Write(Lower Byte)					L	H		D _{IN}	Invalid
Write(Upper Byte)					H	L		Invalid	D _{IN}
Outputs Disabled					H	H		X	X
Standby	H	H	X	X	X	X	High-Z	High-Z	
Deep Power-down Standby	H	L	X	X	X	X	High-Z	High-Z	

Nor Flash Memory

MODE	\overline{CEf}	\overline{OE}	\overline{WE}	\overline{RESET}	\overline{WP}	DQ0~DQ15
Read / Page Read	L	L	H	H	X	D _{OUT}
Standby	H	X	X	H	X	High-Z
Output Disable	X	H	H	X	X	High-Z
Write	L	H	 ⁽¹⁾	H	X	D _{IN}
Hardware Reset / Standby	X	X	X	L	X	High-Z
Boot Block Protect	X	X	X	X	L	X

Notes: L = V_{IL}; H = V_{IH}; X = V_{IH} or V_{IL}

Does not apply when $\overline{CEf} = V_{IL}$ and $\overline{CE1ps} = V_{IL}$ and CE2ps = V_{IH} at the same time.

(1) Pulse input

ID CODE TABLE

TYPE		A23~A12	A6	A1	A0	CODE (HEX)
Manufacturer Code		*	L	L	L	0098H
Device Code	TY00680002ADGB	*	L	L	H	006Fh
	TY00680003ADGB	*	L	L	H	00EFh
Verify Block Protect		BA ⁽¹⁾	L	H	L	Data ⁽²⁾

Note: * = V_{IH} or V_{IL}, L = V_{IL} H = V_{IH}

(1) BA: Block address

(2) 0001H: Protected block, 0000H: Unprotected block

ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	RANGE	UNIT
V _{CC}	V _{CCps} /V _{CCf} Power Supply Voltage	-0.3~2.5	V
V _{IN}	Input Voltage	-0.5~2.5	V
V _{DQ}	Input/Output Voltage	-0.5~V _{CC} + 0.5 (≤ 3.6)	V
T _{opr}	Operating Temperature	-30~85	°C
P _D	Power Dissipation	0.6	W
T _{solder}	Soldering Temperature	260	°C
I _{OSHORT}	Output Short Circuit Current ⁽¹⁾	100	mA
T _{stg}	Storage Temperature	-55~125	°C

Note : (1) Output shorted for no more than one second. No more than one output shorted at a time

RECOMMENDED DC OPERATING CONDITIONS (Ta = -30°~85°C)

SYMBOL	PARAMETER	MIN	TYP.	MAX	UNIT
V _{CC}	V _{CCps} /V _{CCf} Power Supply Voltage	1.70 ⁽¹⁾	—	1.95 ⁽¹⁾	V
V _{IH}	Input High-Level Voltage	V _{CC} × 0.8	—	V _{CC} + 0.3	
V _{IL}	Input Low-Level Voltage	-0.3	—	V _{CC} × 0.2	

Note : (1) The potential difference of V_{CCps} and V_{CCf} is less than 0.5 V

CAPACITANCE (Ta = 25°C, f = 1 MHz)

SYMBOL	PARAMETER	CONDITION	MIN	TYP.	MAX	UNIT
C _{IN}	Input Capacitance	V _{IN} = GND	—	—	17	pF
C _{OUT}	Output Capacitance	V _{OUT} = GND	—	—	22	pF

Note: These parameters are sampled periodically and are not tested for every device.

DC CHARACTERISTICS (Ta = -30°~85°C, VCCps/ VCCf = 1.70 V~1.95 V)

SYMBOL	PARAMETER	CONDITION	MIN	MAX	UNIT	
I _{IL}	Input Leakage Current	V _{IN} = 0 V~V _{CCf} (V _{CCps})	—	±1	μA	
I _{OHps}	Pseudo SRAM Output High Current	V _{OH} = V _{CCps} - 0.2 V	-0.5	—	mA	
I _{OLps}	Pseudo SRAM Output Low Current	V _{OL} = 0.2 V	1.0	—	mA	
I _{OHf}	Flash Output High Current	V _{OH} = V _{CCf} - 0.1 V	-0.1	—	mA	
I _{OLf}	Flash Output Low Current	V _{OL} = 0.1 V	0.1	—	mA	
I _{LO}	Output Leakage Current	V _{OUT} = 0 V~V _{CCf} (V _{CCps}), $\overline{OE} = V_{IH}$	—	±1	μA	
I _{CCO1f}	Flash Random Read Current	$\overline{CEf} = V_{IL}$, I _{OUT} = 0 mA, t _{cycle} = 100ns	—	40	mA	
I _{CCO2f}	Flash Program Current	$\overline{CEf} = V_{IL}$, I _{OUT} = 0 mA	—	20	mA	
I _{CCO3f}	Flash Erase Current	$\overline{CEf} = V_{IL}$, I _{OUT} = 0 mA	—	25	mA	
I _{CCO4f}	Flash Read-While-Program Current	V _{IN} = V _{IH} /V _{IL} , I _{OUT} = 0 mA, t _{cycle} = 100 ns	—	60	mA	
I _{CCO5f}	Flash Read-While- Erase Current	V _{IN} = V _{IH} /V _{IL} , I _{OUT} = 0 mA, t _{cycle} = 100 ns	—	65	mA	
I _{CCO6f}	Flash Program-while- Erase-Suspend Current	V _{IN} = V _{IH} /V _{IL} , I _{OUT} = 0 mA	—	20	mA	
I _{CCO7f}	Flash Page Read Current	$\overline{CEf} = V_{IL}$, I _{OUT} = 0 mA, t _{RC} = 100 ns	—	5	mA	
I _{CCO8f}	Flash Address Increment Read Current(4)	$\overline{CEf} = V_{IL}$, I _{OUT} = 0 mA t _{RC} = 100 ns, t _{RPC} = 25 ns	—	8.2	mA	
I _{CCO1ps}	Pseudo SRAM Operating Current ^(2,3)	$\overline{CE1ps} = V_{IL}$, CE2ps = V _{IH} , I _{OUT} = 0 mA	t _{RC} = min	—	50	mA
I _{CCO2ps}	Pseudo SRAM Page Access Operating Current (2,3)	$\overline{CE1ps} = V_{IL}$, CE2ps = V _{IH} , Page add. Cycling, I _{OUT} = 0 mA	t _{PC} = min	—	25	mA
I _{CCSps}	Pseudo SRAM Standby Current (MOS)	$\overline{CE1ps} = V_{CCps} - 0.2 V$, CE2ps = V _{CCps} - 0.2 V	—	200	μA	
I _{CCSDps}	Pseudo SRAM Deep Power-down Standby Current	CE2ps = 0.2 V	—	5	μA	
I _{CCS1f}	Flash Standby Current	$\overline{CEf} = \overline{RESET} = V_{CCf}$ or $\overline{RESET} = V_{SS}$	—	10	μA	
I _{CCS2f}	Flash Standby Current (Automatic Sleep Mode ⁽¹⁾)	V _{IH} = V _{CCf} or V _{IL} = V _{SS}	—	10	μA	
V _{LKO}	Low Voltage Lock-out Voltage	—	1.0	1.6	V	

(1) The device is going to Automatic Sleep Mode, when address remain steady during 150 ns.

(2) I_{CCO} depends on the cycle time.

(3) I_{CCO} depends on output loading. Specified values are defined with the output open condition.

(4) (I_{CCO1f}+ I_{CCO7f} × 7) / 8word

See page P-1 to page P-8 for the specification of Pseudo Static RAM.

See page F-1 to page F-73 for the specification of Nor Flash Memory.

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070122EBA_R6

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64 Mbits PSEUDO STATIC RAM

TC51YHM616B

Organization : 4M × 16bits

AC CHARACTERISTICS AND OPERATING CONDITIONS

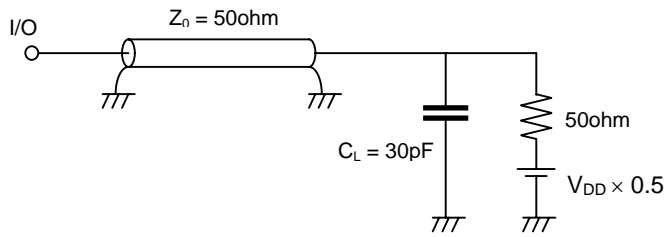
(Ta = -30°C to 85°C, V_{DD} = 1.7 to 1.95 V) (See Notes 1 to 5)

SYMBOL	PARAMETER	MIN	MAX	UNIT
t _{RC}	Read Cycle Time	75	10000	ns
t _{ACC}	Address Access Time	—	75	ns
t _{CO}	Chip Enable(CE1) Access Time	—	75	ns
t _{OE}	Output Enable Access Time	—	25	ns
t _{BA}	Data Byte Control Access Time	—	25	ns
t _{COE}	Chip Enable Low to Output Active	10	—	ns
t _{OEE}	Output Enable Low to Output Active	8	—	ns
t _{BE}	Data Byte Control Low to Output Active	0	—	ns
t _{OD}	Chip Enable High to Output High-Z	—	15	ns
t _{ODO}	Output Enable High to Output High-Z	—	15	ns
t _{BD}	Data Byte Control High to Output High-Z	—	15	ns
t _{OH}	Output Data Hold Time	5	—	ns
t _{PM}	Page Mode Time	75	10000	ns
t _{PRC}	Page Mode Read Cycle Time	25	—	ns
t _{AA}	Page Mode Address Access Time	—	25	ns
t _{AOH}	Page Mode Output Data Hold Time	3	—	ns
t _{WC}	Write Cycle Time	75	10000	ns
t _{WP}	Write Pulse Width	50	—	ns
t _{CW}	Chip Enable to End of Write	75	—	ns
t _{BW}	Data Byte Control to End of Write	65	—	ns
t _{AW}	Address Valid to End of Write	65	—	ns
t _{AS}	Address Setup Time	0	—	ns
t _{WR}	Write Recovery Time	0	—	ns
t _{WEHA}	Write Enable High Pulse Width	6	—	ns
t _{CEHA}	Chip Enable High Pulse Width	10	—	ns
t _{BEHA}	Data Byte Control High Pulse Width	10	—	ns
t _{ODW}	\overline{WE} Low to Output High-Z	—	15	ns
t _{OEW}	\overline{WE} High to Output Active	0	—	ns
t _{DS}	Data Setup Time	15	—	ns
t _{DH}	Data Hold Time	0	—	ns
t _{PWC1}	Page Mode Write Bigin Cycle Time	75	—	ns
t _{PWC2}	Page Mode Write Cycle Time	25	—	ns
t _{PWC3}	Page Mode Write End Cycle Time	25	—	ns
t _{DSP}	Page Mode Write Data Set-up Time	15	—	ns
t _{WPPM}	Page Mode Write Pulse Width(/WE toggle)	15	—	ns
t _{WHP}	Page Mode Write High Pulse Width	5	—	ns
t _{WRP}	Page Mode Write Recovery Time	10	—	ns
t _{CS}	CE2 Set-up Time	0	—	ns
t _{CH}	CE2 Hold Time from Deep Power Down	200	—	us
t _{CHR}	CE2 Hold Time from Partial Refresh	5	—	ns
t _{DPD}	CE2 Pulse Width	10	—	ms
t _{CHC}	CE2 Hold from $\overline{CE1}$	0	—	ns
t _{CHP}	CE2 Hold from Power On	50	—	μs
t _{ASV}	Address Setup Time from \overline{ADV}	0	—	ns
t _{AHV}	Address Hold Time from \overline{ADV}	5	—	ns
t _{AVLA}	\overline{ADV} Pulse Width	12	—	ns
t _{CSV}	Chip Enable Setup Time from \overline{ADV}	0	—	ns
t _{OEHV}	Output Enable Hold Time from \overline{ADV}	5	—	ns
t _{WEHV}	Write Enable Hold Time from \overline{ADV}	5	—	Ns
t _{MH}	Mode Register Set Hold Time	10	—	ns

AC TEST CONDITIONS

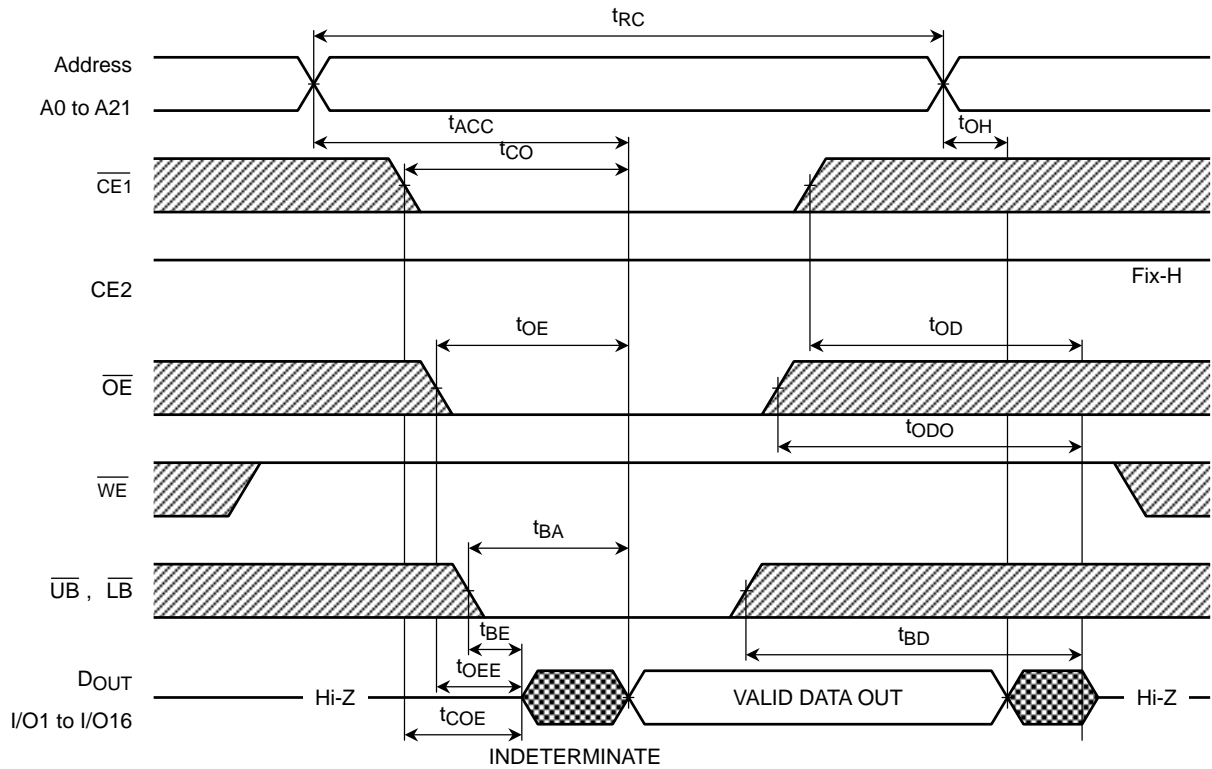
PARAMETER	CONDITION
Output load	As shown in Fig.1
Input pulse level	$V_{DD} - 0.2 V, 0.2 V$
Timing measurements	$V_{DD} \times 0.5$
Reference level	$V_{DD} \times 0.5$
t_R, t_F	2 ns

Fig.1

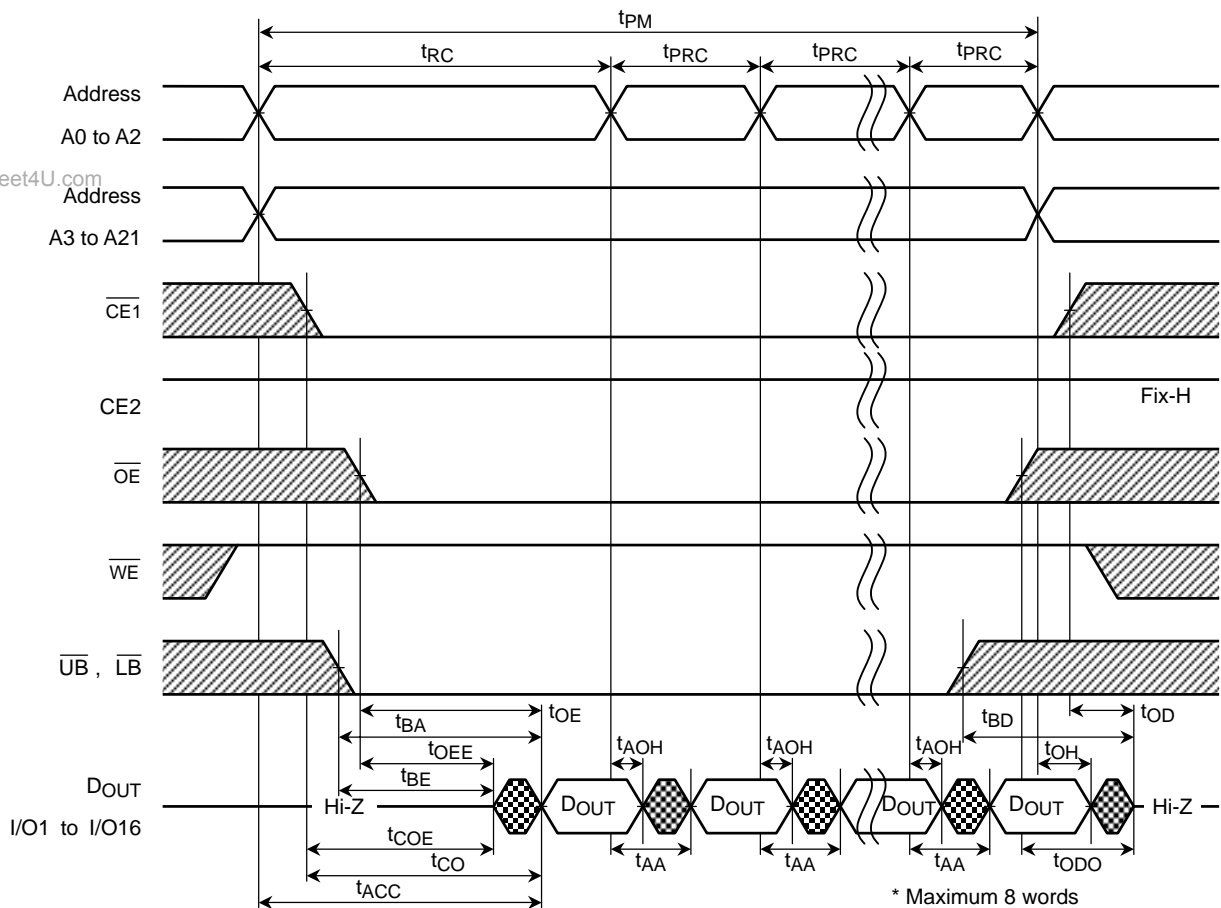


TIMING DIAGRAMS

READ CYCLE

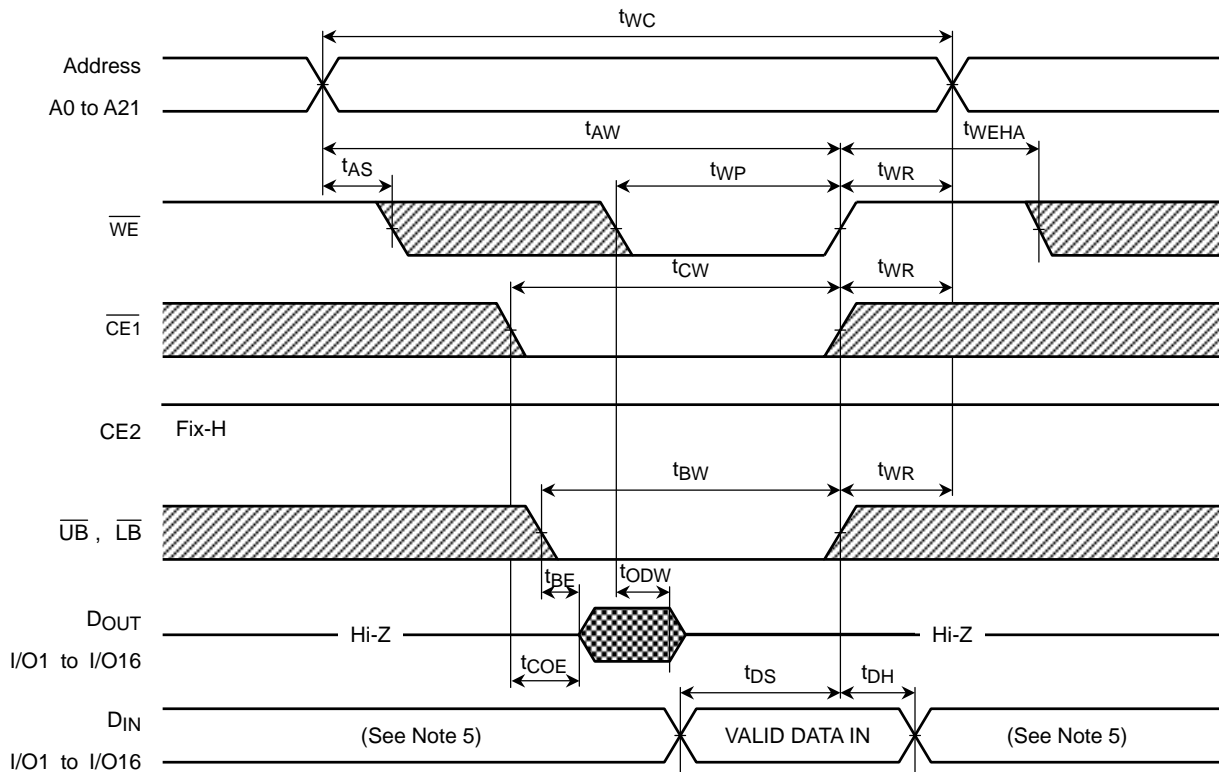


PAGE READ CYCLE (8 words access)

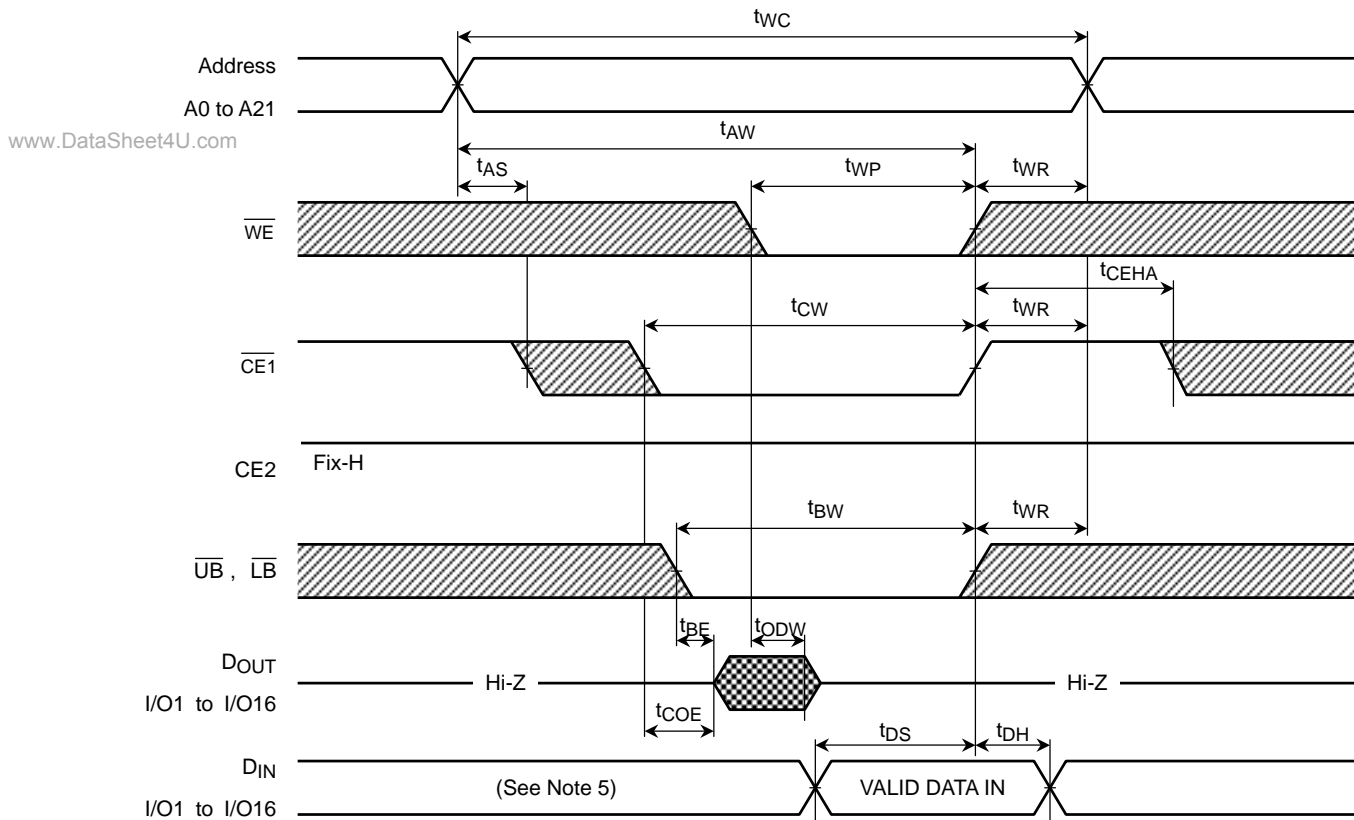


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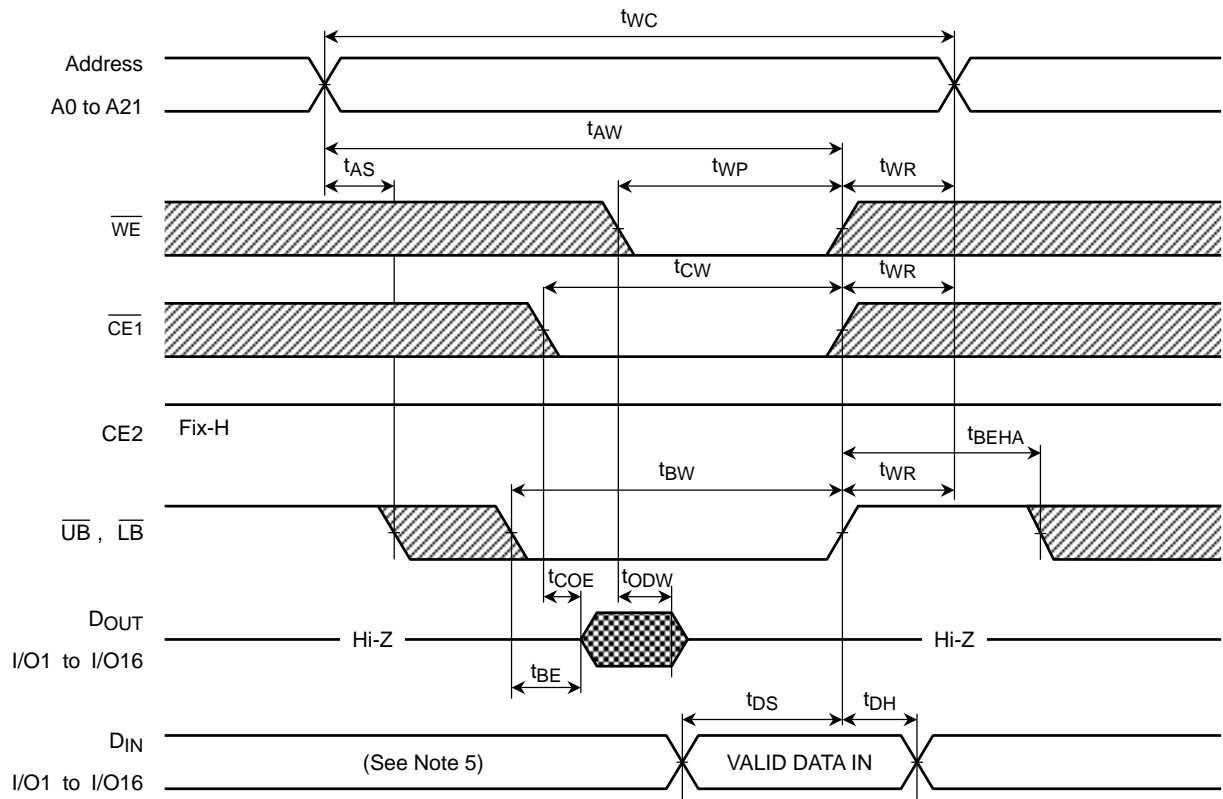
WRITE CYCLE 1 (\overline{WE} CONTROLLED) (See Note 4)



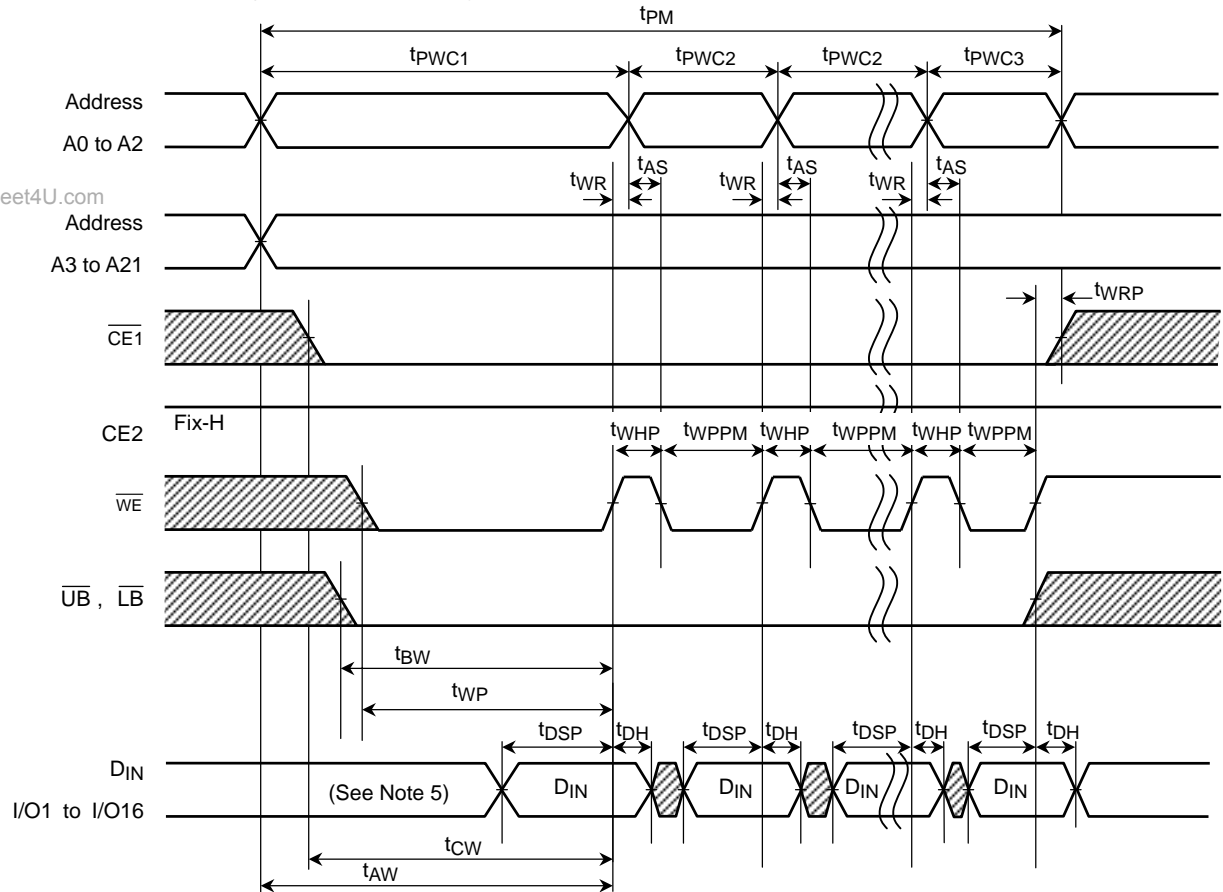
WRITE CYCLE 2 (\overline{CE} CONTROLLED) (See Note 4)



WRITE CYCLE 3 (\overline{UB} , \overline{LB} CONTROLLED) (See Note 4)

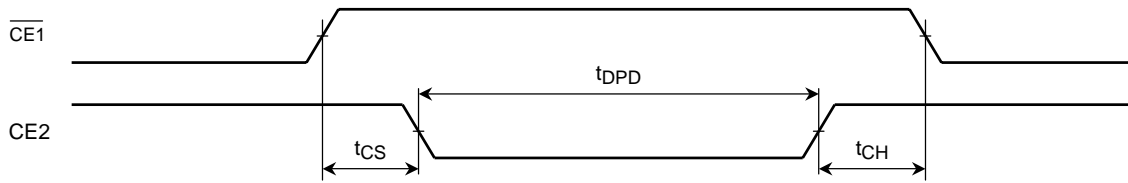


PAGE WRITE CYCLE (8 words access)

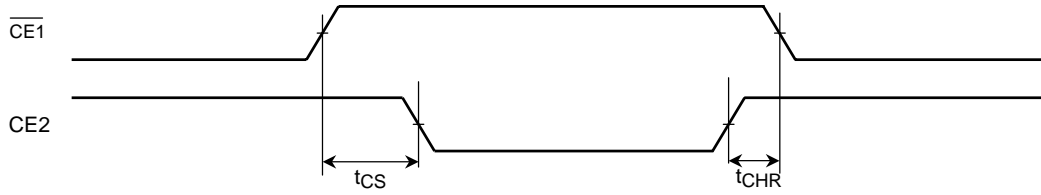


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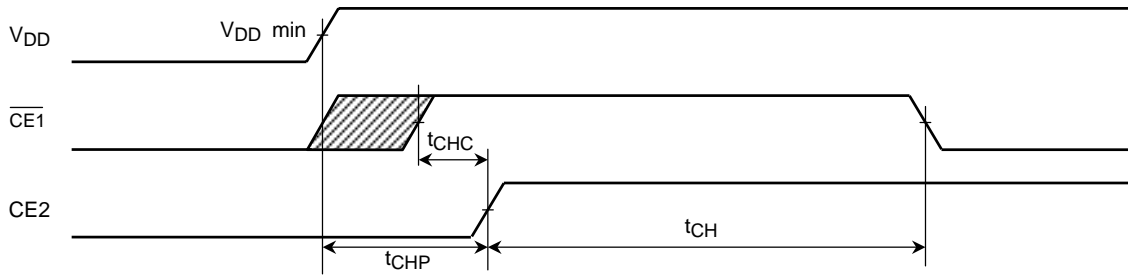
Deep Power-down Timing



Partial Refresh Timing



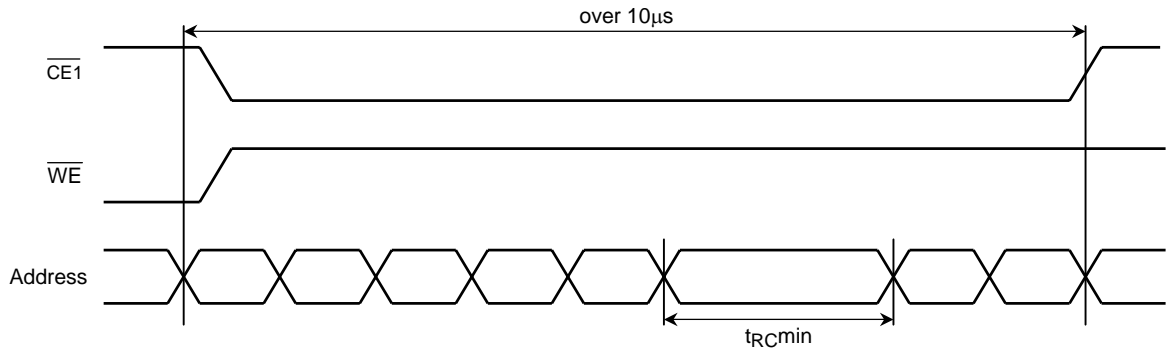
Power-on Timing



Provisions for Address Skew

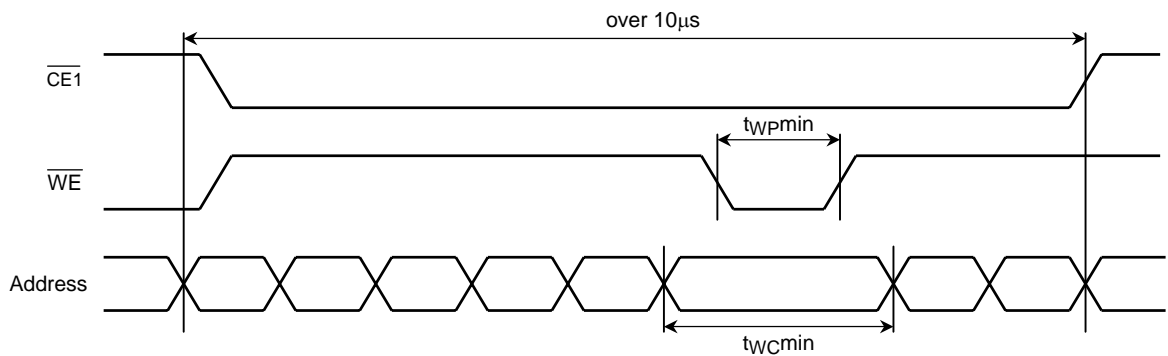
Read

If multiple invalid address cycles shorter than t_{RCmin} are sustained over $10\mu s$ in an active state, as least one valid address cycle(with address change of any pins of A3-A21) over t_{RCmin} is needed during the $10\mu s$.



Write

If multiple invalid address cycles shorter than t_{WCmin} are sustained over $10\mu s$ in an active state, as least one valid address cycle(with address change of any pins of A3-A21) over t_{WCmin} with t_{WPmin} is needed during the $10\mu s$.



Notes:

- (1) AC measurements are assumed $t_R, t_F = 2 \text{ ns}$.
- (2) Parameters $t_{OD}, t_{ODO}, t_{BD}, t_{ODW}, t_{KQX}, t_{CEHZ}$ and t_{OEZ} define the time at which the output goes into the open condition and are not output voltage reference levels.
- (3) Data cannot be retained during deep power-down stand-by mode.
- (4) If \overline{OE} is high during the write cycle, the outputs will remain at high impedance.
- (5) During the output state of I/O signals, input signals of reverse polarity must not be applied.

256 Mbits NOR FLASH MEMORY***TC58FYM8T7D : Top Boot Block******TC58FYM8B7D : Bottom Boot Block******Organization : 16M × 16bits***

1. MODE SELECTION

Mode	\overline{CE}	\overline{OE}	\overline{WE}	\overline{WP}	A23-A0	\overline{RESET}	DQ0-DQ15
Read Cycle	L	L	H	X	Addr In	H	D _{OUT}
Command Write Cycle	L	H	⁽¹⁾ L	X	Addr In	H	D _{IN}
Standby	H	X	X	X	X	H	High-Z
	X	X	X	X	X	L	High-Z
Output Disable	X	H	X	X	X	X	High-Z
Hardware Reset/Standby	X	X	X	X	X	L	High-Z
Boot Block Protect ⁽²⁾	X	X	X	L	X	X	X

Notes: X: V_{IH} or V_{IL} L: V_{IL} H: V_{IH}

(1) Pulse Input

(2) When $\overline{WP} = V_{IL}$, BA0-BA1 in Bottom Boot block device and BA261-BA262 in Top Boot Block device are protected.

2. ID CODE TABLE

CODE TYPE	A23-A13	A6	A1	A0	CODE (HEX)	
Manufacturer Code	X	L	L	L	0098h	
Device Code	Top Boot Block	X	L	L	H	006Fh
	Bottom Boot Block	X	L	L	H	00EFh
Verify Block Protect	BA ⁽¹⁾	L	H	L	Data ⁽²⁾	

Notes : X: V_{IH} or V_{IL}

L: V_{IL} H: V_{IH}

(1) BA: Block Address

(2) 0001h-Protected Block , 0000h- Unprotected Block

3. COMMAND SEQUENCES

COMMAND SEQUENCE	BUS WRITE CYCLES REQ'D	FIRST BUS WRITE CYCLE		SECOND BUS WRITE CYCLE		THIRD BUS WRITE CYCLE		FOURTH BUS WRITE CYCLE		FIFTH BUS WRITE CYCLE		SIXTH BUS WRITE CYCLE	
		Addr.	Data	Addr.	Data	Addr.	Data	Addr.	Data	Addr.	Data	Addr.	Data
Read/Reset	1	XXXh	F0h										
Read/Reset	3	555h	AAh	2AAh	55h	555h	F0h	RA ⁽¹⁾	RD ⁽²⁾				
ID Read	3	555h	AAh	2AAh	55h	BK ⁽³⁾ + 555h	90h	IA ⁽⁴⁾	ID ⁽⁵⁾				
Auto Program	4	555h	AAh	2AAh	55h	555h	A0h	PA ⁽⁶⁾	PD ⁽⁷⁾				
Auto Page Program (8word)	11	555h	AAh	2AAh	55h	555h	E6h	PA ⁽⁶⁾	PD ⁽⁷⁾	PA ⁽⁶⁾	PD ⁽⁷⁾	PA ⁽⁶⁾	PD ⁽⁷⁾
Program Suspend	1	BK ⁽³⁾	B0h										
Program Resume	1	BK ⁽³⁾	30h										
Auto Chip Erase	6	555h	AAh	2AAh	55h	555h	80h	555h	AAh	2AAh	55h	555h	10h
Auto Block Erase	6	555h	AAh	2AAh	55h	555h	80h	555h	AAh	2AAh	55h	BA ⁽⁹⁾	30h
Block Erase Suspend	1	BK ⁽³⁾	B0h										
Block Erase Resume	1	BK ⁽³⁾	30h										
Hidden ROM Mode Entry	3	555h	AAh	2AAh	55h	555h	88h						
Hidden ROM Program	4	555h	AAh	2AAh	55h	555h	A0h	PA ⁽⁶⁾	PD ⁽⁷⁾				
Hidden ROM Erase	6	555h	AAh	2AAh	55h	555h	80h	555h	AAh	2AAh	55h	BA ⁽⁸⁾	30h
Hidden ROM Protect	4	555h	AAh	2AAh	55h	555h	60h	X1Ah	68h				
Hidden ROM Exit	4	555h	AAh	2AAh	55h	555h	90h	XXXh	00h				
CFI	2	BK ⁽³⁾ + 55h	98h	CA ⁽⁹⁾	CD ⁽¹⁰⁾								

3. COMMAND SEQUENCES (continue)

COMMAND SEQUENCE	BUS WRITE CYCLES REQ'D	FIRST BUS WRITE CYCLE		SECOND BUS WRITE CYCLE		THIRD BUS WRITE CYCLE		FOURTH BUS WRITE CYCLE		FIFTH BUS WRITE CYCLE		SIXTH BUS WRITE CYCLE		SEVENTH BUS WRITE CYCLE	
		Addr.	Data	Addr.	Data	Addr.	Data	Addr.	Data	Addr.	Data	Addr.	Data	Addr.	Data
Password Program	4	555h	AAh	2AAh	55h	555h	38h	XX0h	PD0 ⁽¹¹⁾						
		555h	AAh	2AAh	55h	555h	38h	XX1h	PD1 ⁽¹¹⁾						
		555h	AAh	2AAh	55h	555h	38h	XX2h	PD2 ⁽¹¹⁾						
		555h	AAh	2AAh	55h	555h	38h	XX3h	PD3 ⁽¹¹⁾						
Password Unlock	7	555h	AAh	2AAh	55h	555h	28h	XX0h	PD0 ⁽¹¹⁾	XX1h	PD1 ⁽¹¹⁾	XX2h	PD2 ⁽¹¹⁾	XX3h	PD3 ⁽¹¹⁾
Password Verify	4	555h	AAh	2AAh	55h	555h	C8h	PWA ⁽¹²⁾	PWD ⁽¹³⁾						
Password Protection Mode Lock Set	6	555h	AAh	2AAh	55h	555h	60h	X0Ah	68h						
Non-Password Protection Mode Lock	6	555h	AAh	2AAh	55h	555h	60h	X12h	68h						
PPB Set	6	555h	AAh	2AAh	55h	555h	60h	BA ⁽⁸⁾ +X02h	68h						
PPB Clear	6	555h	AAh	2AAh	55h	555h	60h	X02h	60h						
Verify Block Protect	4	555h	AAh	2AAh	55h	BA ⁽⁸⁾ + 555h	90h	BA ⁽⁸⁾ +X02h	PD(0) ⁽¹⁴⁾						
PPB Lock Set	3	555h	AAh	2AAh	55h	555h	78h								
PPB Lock Verify	4	555h	AAh	2AAh	55h	555h	58h	BA ⁽⁸⁾	PD(1) ⁽¹⁴⁾						
DPB Set	4	555h	AAh	2AAh	55h	555h	48h	BA ⁽⁸⁾	X1h						
DPB Clear	4	555h	AAh	2AAh	55h	555h	48h	BA ⁽⁸⁾	X0h						
DPB Verify	4	555h	AAh	2AAh	55h	555h	58h	BA ⁽⁸⁾	PD(0) ⁽¹⁴⁾						

Notes: The system should generate the following address patterns:

555h or 2AAh on address pins A10~A0.

DQ8~DQ15 are ignored.

X : V_IH or V_IL (0h-Fh)

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- | | |
|---|--|
| <ul style="list-style-type: none"> (1) RA: Read Address (2) RD: Read Data Output (3) BK: Bank Address = A23~A20 (4) IA: Bank Address and ID Read Address(A6,A1,A0)
Bank Address = A23~A20
Manufacturer Code = (0,0,0)
Device Code = (0,0,1) (5) ID: ID Code Output (6) PA: Program Address
Input continuous 8 addresses from
(A0,A1,A2) = (0, 0, 0) to (1,1,1) in Page program. | <ul style="list-style-type: none"> (7) PD: Program Data Input
Input continuous 8 address from
(A0,A1,A2) = (0,0,0) to (1,1,1) in Page program. (8) BA: Block Address = A23~A13 (9) CA: CFI Address (10) CD: CFI Data Output (11) PD0 : 1st Password (Data of 1-16bit)
PD1 : 2nd Password (Data of 17-32bit)
PD2 : 3rd Password (Data of 33-48bit)
PD3 : 4th Password (Data of 49-64bit) (12) PWA: Password Address Input (13) PWD: Password Data Output (14) PD(0): Data (1: Set/ 0: Clear) on DQ0.
PD(1): Data (1: Set/ 0: Clear) on DQ1. |
|---|--|

4. SIMULTANEOUS READ/WRITE OPERATION

The TC58FYM8T7D/B7D features a Simultaneous Read/Write operation. The Simultaneous Read/Write operation enables the device to simultaneously write data to or erase data from a bank while reading data from another bank.

The TC58FYM8T7D/B7D has a total of 16 Banks (16Mbits x 16 Banks). Banks can be switched by using the bank addresses (A23~A20). For a description of bank blocks and addresses, please refer to the Block Address Table and Block Size Table.

The Simultaneous Read/Write operation cannot perform multiple operations within a single bank. The table below shows the operation modes in which simultaneous operation can be performed.

Note that during Auto-Program execution or Auto Block Erase operation, the Simultaneous Read/Write operation cannot read data from addresses in the same bank which have not been selected for operation. However, Data from these addresses can be read using the Program Suspend or Erase Suspend function.

In order to perform simultaneous operation during automatic operation execution, when changing a bank, it is necessary to set OE to VIH.

SIMULTANEOUS READ/WRITE OPERATION

STATUS OF BANK ON WHICH OPERATION IS BEING PERFORMED	STATUS OF OTHER BANKS
Read Mode	Read Mode
ID Read Mode	
Auto-Program Mode	
Auto-Page Program Mode	
Program Suspend Mode	
Auto Block Erase Mode	
Erase Suspend Mode	
Program during Erase Suspend	
Program Suspend during Erase Suspend	
CFI Mode	
Password Unlock	

Notes:

Excluding times when Acceleration Mode is in use.

5. OPERATION MODES

In addition to the Read, Write and Erase Modes, the TC58FYM8T7D/B7D features many functions including block protection and data polling. When incorporating the device into a design, please refer to the timing charts and flowcharts in combination with the descriptions below.

5.1. Read Mode

To read data from the memory cell array, set the device to Read Mode.

The device is automatically set to Read Mode immediately after power-on or on completion of an automatic operation. The Software Reset Command releases the ID Read Mode, releases the lock state when an automatic operation ends abnormally, and sets the device to Read Mode. Hardware Reset terminates operation of the device and resets it to Read Mode. When reading data without changing the address immediately after power-on, the host should input Hardware Reset or change \overline{CE} from High to Low.

This mode can execute high-speed random access and Page Read (8 words). The appropriate page area is selected by address pins A0-A2.

When reading data from a memory cell array, the address (A23-A0) must be input under $\overline{CE} = V_{IL}$, $\overline{WE} = V_{IH}$. After the address is acknowledged, the data is outputted to DQ0-DQ15. And 1'st read just after command input need $t_{WEHH} + t_{ACC}$.

5.2. ID Read

ID Read Mode is used to read the Manufacture code and the Device code. The mode is useful in that it allows EPROM programmers to identify the device type automatically.

Access time in ID Read Mode is the same as that in Read Mode. However 1st access after command input need $t_{WEHH} + t_{ACC}$. For a list of the codes, please refer to the ID Code Table.

Inputting an ID Read command sets the specified bank to ID Read Mode. Banks are specified by inputting the bank address (BK) in the third Bus Write cycle of the Command cycle. To read an ID code, the bank address as well as the ID read address must be specified. The Manufacture code is output from address BK + 00; the device code is output from address BK + 01. From other banks, data is output from the memory cells. Inputting a Reset command releases ID Read Mode and returns the device to Read Mode.

5.3. Standby Mode

TC58FYM8T7D/B7D has two ways to put the device into Standby Mode. In Standby Mode, DQ is put into the High-Impedance state.

(1) Control using \overline{CE} and \overline{RESET}

With the device in Read Mode, input V_{IH} to \overline{CE} and \overline{RESET} . The device will enter Standby Mode. However, if the device is in the process of performing simultaneous operation, the device will not enter Standby Mode but will instead cause the operating current to flow.

(2) Control using \overline{RESET} only

With the device in Read Mode, input V_{IL} to \overline{RESET} . The device will enter Standby Mode. Even if the device is in the process of performing simultaneous operation, this method will terminate the current operation and set the device to Standby Mode. This is a hardware reset and is described later.

5.4. Auto-Sleep Mode

This function suppresses power dissipation during reading. If the address input does not change for 150 ns, the device will automatically enter Sleep Mode and the current will be reduced to the standby current (I_{DD2}). However, if the device is in the process of performing simultaneous operation, the device will not enter Standby Mode but will instead cause the operating current to flow. Because the output data is latched, data is output in Sleep Mode. When the address is changed, Sleep Mode is automatically released, and data from the new address is output.

5.5. Output Disable Mode

Inputting V_{IH} to \overline{OE} disables output from the device and sets DQ to High-Impedance.

5.6. Ready pin (Ready/Busy pin)

The $\overline{RY/BY}$ pin indicates the status of auto operation as the Ready/Busy pin. During an auto operation, the $\overline{RY/BY}$ pin outputs V_{OL} . At the end of auto operation, the $\overline{RY/BY}$ pin outputs Hi-Z. The $\overline{RY/BY}$ pin behaves as an open-drain type circuit.

5.7. Command Write

The TC58FYM8T7D/B7D uses the standard JEDEC control commands for a single-power supply E²PROM. A Command of Write is executed by inputting the address and data into the Command Register. The command is written by inputting a pulse to \overline{WE} with $\overline{CE} = V_{IL}$ and $\overline{OE} = V_{IH}$ (\overline{WE} control). The command can also be written by inputting a pulse to \overline{CE} with $\overline{WE} = V_{IL}$ (\overline{CE} control). The address is latched on the falling edge of either \overline{WE} or \overline{CE} . DQ0~DQ7 are valid for data input and DQ8~DQ15 are ignored.

To abort input of the command sequence uses the Reset command. The device will reset the Command Register and enter Read Mode. If an undefined command is input, the Command Register will be reset and the device will enter Read Mode.

5.8. Software Reset: Read/Reset Command

Initiate the software reset by inputting a Read/Reset command. The software reset returns the device from ID Read Mode or CFI Mode to Read Mode, releases the lock state if automatic operation has ended abnormally, and clears the Command Register.

5.9. Hardware Reset

The Hardware Reset initializes the device and sets it to the Read Mode. When a pulse is input to \overline{RESET} for t_{RP} , the device abandons the operation which is in progress and enters the Read Mode after t_{READY} . Note that if a Hardware Reset is applied during data overwriting, such as a Write or Erase operation, data at the address or block being written to at the time of the reset will become undefined.

After a Hardware Reset, the device enters Read Mode if $\overline{RESET} = V_{IH}$ or Standby Mode if $\overline{RESET} = V_{IL}$. The DQ pins are High-Impedance when $\overline{RESET} = V_{IL}$. After the device has entered Read Mode, Read operations and input of any command are allowed.

5.10. Comparison between Software Reset and Hardware Reset

ACTION	SOFTWARE RESET	HARDWARE RESET
Releases ID Read Mode or CFI Mode	True	True
Clears the Command Register	True	True
Releases the lock state if automatic operation has ended abnormally	True	True
Stops any automatic operation which is in progress	False	True
Stops any operation other than the above and returns the device to Read Mode	False	True

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5.11. Auto-Program Mode

The TC58FYM8T7D/B7D can be programmed in word units. Auto-Program Mode is set using the Program command. The program address and program data is latched in the fourth Bus Write cycle. Auto programming starts on the rising edge of the \overline{WE} signal in the fourth Bus Write cycle. The Program and Program Verify commands are automatically executed by the chip. The device status during programming is indicated by the Hardware Sequence flag. To read the Hardware Sequence flag, specify the address to which the Write is being performed.

During Auto Program execution, a command sequence for the bank on which execution is being performed cannot be accepted. To terminate execution, use a Hardware Reset. Note that if the Auto-Program operation is terminated in this manner, the data written so far is invalid.

Any attempt to program a protected block is ignored. In this case, the device enters Read Mode 5 μ s (typ.) after a latch of program data in the fourth Bus Write cycle.

If an Auto-Program operation fails, the device remains in the programming state and does not automatically return to Read Mode. The device status is indicated by the Hardware Sequence flag. Either a Reset command or a Hardware Reset is required to return the device to Read Mode after a failure. If a programming operation fails, the device should not be used. To build a more reliable system, the host processor should take measures to prevent subsequent use of failed blocks.

The device allows 0s to be programmed into memory cells which contain a 1. 1s cannot be programmed into cells which contain 0s. If this is attempted, execution of Auto Program will fail. This is a user error, not a device error. A cell containing 0 must be erased in order to set it to 1.

5.12. Auto-Page Program Mode

Auto-Page Program is a function which enables simultaneously Programming 8words of data. In this mode, the Programming time for 256M bits is about 50% compared with the Auto program mode. In word mode, input the page program command during first bus write cycle to third bus writes cycle. Input program data and address of (A0,A1,A2) = (0,0,0) in the forth bus write cycle. Input increment address and program data during the fifth bus write cycle to the 11th bus write cycle. After input of the 11th bus write cycle, page program operation starts.

Word size and address group in Page program

Word size	Third bus writes cycles command	Address Group					
		00~07h	08~0Fh	10~17h	18~1Fh	20~27h	-----
8word program	E6h	00~07h	08~0Fh	10~17h	18~1Fh	20~27h	-----

5.13. Program Suspend/Resume Mode

Program Suspend is used to enable a Data Read by suspending the Write operation. The device accepts a Program Suspend command in Write Mode (including Write operations performed during Erase Suspend) but ignores the command in other modes. When the command is input, the address of the bank on which Write is being performed must be specified. In Program Suspend Mode, it is invalid except a Read/Reset command, an ID Read command, a CFI Read command, and a Resume command. After input of the command, the device will enter Program Suspend Read Mode after t_{SUSP} .

When Data Write is suspended, the address to which Write was being performed becomes undefined. ID Read and CFI Data Read are the same as usual.

After completion of Program Suspend, input a Program Resume command to return to Write Mode. When inputting the command, specify the address of the bank on which Write is being performed. If the ID Read or CFI Data Read function is being used, abort the function before inputting the Resume command. On receiving the Resume command, the device returns to Write Mode and resumes outputting the Hardware Sequence flag for the bank to which data is being written.

5.14. Auto Chip Erase Mode

The Auto Chip Erase Mode is set using the Chip Erase command. An Auto Chip Erase operation starts on the latch of the command in the sixth bus cycle. All memory cells are automatically preprogrammed to 0, erased and verified as erased by the chip. The device status is indicated by the Hardware Sequence flag.

Command input is ignored during an Auto Chip Erase. A Hardware Reset can interrupt an Auto Chip Erase operation. If an Auto Chip Erase operation is interrupted, it cannot be completed correctly. Hence, an additional Erase operation must be performed.

Any attempt to erase a protected block is ignored. If all blocks are protected, the Auto Erase operation will not be executed and the device will enter Read mode about 1ms after the latch of command in the sixth bus cycle.

If an Auto Chip Erase operation fails, the device will remain in the erasing state and will not return to the Read Mode. The device status is indicated by the Hardware Sequence flag. Either a Reset command or a hardware reset is required to return the device to Read Mode after a failure.

In this case, it cannot be ascertained which block the failure occurred in. Either abandon use of the device altogether, or perform a Block Erase on each block, identify the failed blocks, and stop using them. To build a more reliable system, the host processor should take measures to prevent subsequent use of failed blocks.

5.15. Auto Block Erase

The Auto Block Erase Mode is set using the Block Erase command. The block address is latched in the sixth bus cycle. Once operation starts, all memory cells in the selected block are automatically preprogrammed to 0, erased and verified as erased by the chip. The device status is indicated by the setting of the Hardware Sequence flag. When the Hardware Sequence flag is read, the addresses of the blocks on which auto-erase operation is being performed must be specified.

All commands (except Erase Suspend) are ignored during an Auto Block Erase operation. Either operation can be aborted using a Hardware Reset. If an Auto Erase operation is interrupted, it cannot be completed correctly; therefore, a further erase operation is necessary to complete the erasing.

Any attempt to erase a protected block is ignored. If the selected block is protected, the Auto Erase operation is not executed and the device returns to Read Mode 20 μ s (typ.) after the latch of command in the last bus cycle.

If an Auto Block Erase operation fails, the device remains in the Erasing state and does not return to Read Mode. The device status is indicated by the Hardware Sequence flag. After a failure, either a Reset command or a Hardware Reset is required to return the device to Read Mode. If an Auto Block Erase operation fails, the device should not be used. To build a more reliable system, the host processor should take measures to prevent subsequent use of failed blocks.

5.16. Erase Suspend/Erase Resume Modes

Erase Suspend Mode suspends Auto Block Erase and reads data from or writes data to an unselected block. The Erase Suspend command is allowed during an Auto Block Erase operation but it is ignored in all other operation modes. When the command is input, the address of the bank on which Erase is being performed must be specified.

In Erase Suspend Mode, it is invalid except a Read/Reset command, an ID Read command, a CFI Read command, a Program command, and a Resume command. If an Erase Suspend command is input during an Auto Block Erase, the device will enter Erase Suspend Read Mode after t_{SUSE} . The device status (Erase Suspend Read Mode) can be verified by checking the Hardware Sequence flag. If data is read consecutively from the block selected for Auto Block Erase, the DQ2 output will toggle and the DQ6 output will stop toggling and $\overline{RY/BY}$ will be set to High-Impedance.

Inputting a Write command during an Erase Suspend enables a Write to be performed to a block which has not been selected for the Auto Block Erase. Data is written in the usual manner.

To resume the Auto Block Erase, input an Erase Resume command. On input of the command, the address of the bank on which the Write was being performed must be specified. On receiving an Erase Resume command, the device returns to the state it was in when the Erase Suspend command was input. If an Erase Resume command is input during an Auto Block Erase, Erase resumes. At this time toggle output of DQ6 resumes and 0 is output on $\overline{RY/BY}$.

5.17. Block Protection

TC58FYM8T7D/B7D has Block Protection that is a function for disabling writing and erasing specific blocks. Block Protection features several level of Block Protection.

(1) Write Protect (\overline{WP} pin) [Hardware Protection]

The TC58FYM8T7D/B7D has Hardware Block protection feature by $\overline{WP} = V_{IL}$. The TC58FYM8T7D protects BA261 and BA262 with $\overline{WP} = V_{IL}$. TC58FYM8B7D protects BA0 and BA1 with $\overline{WP} = V_{IL}$. This mode is released with $\overline{WP} = V_{IH}$. When the device is programming operation or erasing operation, \overline{WP} pin has to fix to V_{IH} or V_{IL} .

(2) Block Protection 1 Persistent Protection Bit(PPB) [Software Protection]

By using Persistent Protection Bit, protection can be set to each block. The PPBs retains the state across power cycle. Each PPB can be individually set through the PPB Set command. All PPB can be cleared by the PPB Clear Command at a time. The PPB Verify command to the device can check the PPB status.

The PPB set and the PPB clear are an auto operation same as the auto erase and auto program. An auto operation starts from the command latch in the 4th write bus cycle of the PPB Set and the PPB clear. The status of the PPB set and the PPB clear are indicated by the below hardware sequence flags. When completely finish the PPB set and the PPB clear, whether the block is protect or unprotect is indicated by the verify block protect command. Therefore, whether the PPB is set or clear is indicated by verify protect command, when the device is unprotected by other protect like \overline{ABP} , \overline{WP} , \overline{RESET} , DPB. When the device outputs '1' on DQ0 at the fourth bus write cycle of the PPB verify command, the PPB is Set. When the device outputs '0' on DQ0, the PPB is clear. If an auto operation fails, either a Hidden ROM exit command or a Hardware Reset is required to return the device to Read Mode.

When PPB is locked by the PPB Lock Set command, PPB is disabled for PPB Set and PPB Clear Operation. The PPB Lock Verify command can check the PPB Lock status on the DQ1 ('1' is Locked state and '0' is Unlocked state). Behaviors of PPB Lock differ between password protection mode and non-password protection mode.

At the time of the finishing PPB Set, PPB Clear, PPB Lock Set and PPB Lock Verify, the hosts have to input the Hidden ROM Exit command. At the time of shipment, the PPBs and PPB Lock are settled to "0".

(3) Block Protection 2 Dynamic Protection Bit (DPB) [Software Protection]

By using Dynamic Protection Bit, protection can be set to each block. After power-up or hardware reset cycle, all DPB are settled to "0" as clear. Each DPB can be individually modifiable through the DPB Set command and DPP Clear command. The Writing of the DPB Verify command to the device can check the Set or Clear of the DPB status. When completely finish the DPB Set, the device will be outputting '1' on DQ0 at the fourth bus write cycle in the DPB verify command. When the device is outputting '0' on DQ0, the DPB Set is not complete, then the hosts must retry from the DPB set command. Similarly, when completely finish the DPB Clear, the device will be outputting '0' on DQ0 at the fourth bus write cycle in the DPB verify command. When the device is outputting '1' on DQ0, the DPB Clear is not complete, then the user must retry from the DPB clear command. At the time of the finishing DPB Set, DPB Clear, and DPB Verify, the hosts have to input the Hidden ROM Exit command.

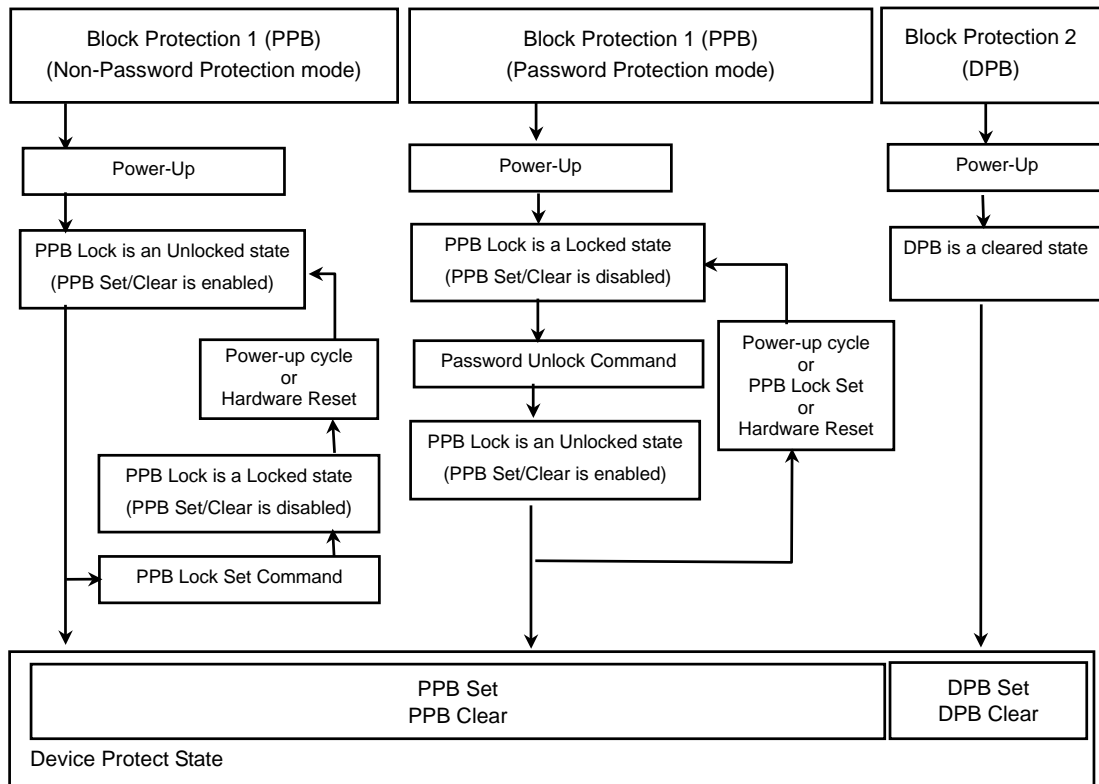
The hardware Sequence Flags of the PPB set

	DQ7	DQ6	DQ5	DQ4	DQ3	DQ2	DQ1	DQ0	RY/ \overline{BY}
In progress	0	Toggle	0	0	0	1	0	0	0
Set finished	1	1	0	0	0	1	0	0	High-Z
Set Failed	0	Toggle	1	0	0	1	0	0	0

The hardware Sequence Flags of the PPB clear

	DQ7	DQ6	DQ5	DQ4	DQ3	DQ2	DQ1	DQ0	RY/ \overline{BY}
In progress	0	Toggle	0	0	1	Toggle	0	0	0
Clear finished	1	1	0	0	1	1	0	0	High-Z
Clear Failed	0	Toggle	1	0	1	N/A	0	0	0

5.17.1 Relationship of the Each Block Protection



* Either PPB set or DPB set protects an object block.

5.17.2. Block Protection Matrix

Hardware Protection		Software Protection		Block Protect Status	
\overline{WP}	\overline{RESET}	PPB	DPB	Top Boot : Block 261,262 Bottom Boot : Block 0,1	Other Block
L	H	Clear	Clear	Protect	Unprotect
		Set	X		Protect
		X	Set		Protect
H	H	Clear	Clear	Unprotect	Unprotect
		Set	X	Protect	Protect
		X	Set		

Notes X: H or L, Set state or Clear state

5.17.3. Non-Password Protection Mode and Password Protection Mode

At Block Protection 1, there are two Protection Mode of Non-Password Protection Mode and Password Protection Mode. Operation of a PPB lock differs in each mode. The hosts need to choose either Non-Password Protection Mode or Password Protection Mode before using of this device.

Non-Password Protection Mode Lock Command sets the device to Non-Password Protection Mode. Password Protection Mode Lock Command sets the device to Password Protection Mode. Hosts can execute either of Password Lock or Non-Password Lock only once, and Mode Lock Erase is impossible. At the shipment, the Non-Password Protection Mode and the Password Protection Mode aren't set state. In the case of using Non-Password Protection Mode, the hosts have to execute a Non-Password Protection Mode Lock in order to prevent the device from being changed to Password Protection Mode. In the case of using Password Protection Mode, the hosts have to execute a Password Protection Mode Lock. Once a Protection Mode is set, it is not eternally changeable.

When the Protection Mode Lock (Set) is finished, the hosts have to execute the Hidden ROM Exit command. The Password Protection Mode Lock and the Non-Password Protection Mode Lock time is tPPRW (Auto PPB set time).

Non-Password Protection Mode Lock	Password Protection Mode Lock	Device Status
0	0	Non-Password Protection Mode (At Shipment)
Set ("1")	0	Non-Password Protection Mode
0	Set ("1")	Password Protection Mode
Set ("1")	Set ("1")	Inhibit

The hardware sequence flags of non-password protect mode lock and password protect mode lock

	DQ7	DQ6	DQ5	DQ4	DQ3	DQ2	DQ1	DQ0	RY/ $\overline{\text{BY}}$
In progress	0	Toggle	0	0	0	1	0	0	0
Protect finished	1	1	0	0	0	1	0	0	High-Z
Protect failed	0	Toggle	1	0	0	1	0	0	0

5.17.4. PPB Lock in Non-Password Protection Mode and Password Protection Mode

In the case of Non-Password Protection Mode, the PPB Lock is cleared by power-up cycle and Hardware Reset. When PPB Lock is set, the PPBs are disabled for modification by Block Protection 1. After Power-up cycle or Hardware Reset again, PPB Lock becomes '0' as clear. In Non-Password Protection Mode, Password Unlock command is ignored.

In the case of Password Protection Mode, the PPB Lock is set by power-up cycle and Hardware Reset. Once Password Protection Mode is set, PPB is disabled for modification by PPB Set and Clear without the Password Unlock command. The state of PPB Lock doesn't differ before and after Password Protection Mode Lock Command. PPB Lock is set again by power-up cycle, Hardware Reset, or PPB lock Set. After entering Password Protection Mode, Password Program command and Password Verify command is permanently ignored. Therefore, when the user chooses the Password Protection Mode, it is necessary to program a 64-bit password to this device before performing a password protection mode lock command. After Password program command, the user has to check by Password Verify command whether the desired Password is correctly programmed. Once Password Protection Mode was set, the user cannot check the Password. At modifying PPB, the user has to use the Password Unlock command with a 64-bit password. Please set a Password certainly.

PPB Lock Status of the Non-Password Protection Mode and the Password Protection Mode

	Non-Password Protection Mode	Password Protection Mode
After Power-up cycle or Hardware Reset	PPB Lock is '0' (clear)	PPB Lock is '1' (set)

PPB Lock Status change method of the each Protection Mode

	Non-Password Protection Mode	Password Protection Mode
PPB Lock Set	PPB Lock Set	PPB Set Command Power-up cycle Hardware Reset
PPB Lock Clear	Power-up cycle Hardware Reset	Password Unlock Command

5.17.5. Description of Password Protection Command

(1) Password Program Command

The Password Protect Command permits programming the password that is used as part of the Hardware Protection scheme. The actual Password length is 64-bits. The 64-bits password is split to four of 16-bits Password Program. In Password Protection Mode, Password Program and Password verify are disabled. During programming the Password, Simultaneous Operation is disabled. Read operations to any memory location is available after completion of the password programming. The status of password program operation can be checked by hardware sequence flags. When this mode is finished, the hosts have to execute the Hidden ROM Exit command. Password is set as four words of "FFFFh" at the time of shipment. Password programming time is equal to tPPW (Auto Word Program time).

The Hardware Sequence Flags of the Password Program

	DQ7	DQ6	DQ5	DQ4	DQ3	DQ2	DQ1	DQ0	RY/ $\overline{\text{BY}}$
In Progress	0	Toggle	0	0	0	1	0	0	0
Program Complete	1	1	0	0	0	1	0	0	High-Z
Program Failed	0	Toggle	1	0	0	1	0	0	0

(2) Password Verify Command

The Password Verify Command is verify the Password. Verification of a Password can be performed when the Password Protection Mode Lock is not programmed. In Password Protection Mode, if the user attempts to verify the Password, the device output "FFFFh". During verification the Password, Simultaneous Operation is disabled. At the forth bus write cycle of Password Verify Command, the hosts have to fix the two address bits (A1, A0). When this mode is finished, the hosts have to execute the Hidden ROM Exit command.

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(3) Password Unlock Command

The Password Unlock Command clears the PPB Lock Bit when the user sets the Password Protection Mode. In order to perform Password Unlock command, the exact Password is necessary. It is necessary to input password unlock command at intervals of 11μs or more. If the interval is shorter than 11μs, the command is ignored.

At Password Unlock Command the 64-bits password is input in four step at 4th, 5th, 6th, 7th write bus cycles. The address A1:A0 is 0:0 at 4th write bus cycle, A1:A0 is 0:1 at 5th write bus cycle, A1:A0 is 1:0 at 6th write bus cycle, and finally A1:A0 is 1:1 at 7th write bus cycle. A wrong Password input at the Password Unlock sequence causes mismatch of Password and PPB Lock Bit is not changed.

When the Password Unlock Command is entered, the RY/ $\overline{\text{BY}}$ pin is Low, which is indicating the device is busy. The status of password unlock operation can be checked by hardware sequence flags. Then flags are output by specifying the address of Bank0 (Bottom Boot Block) or Bank15 (Top Boot Block). Inputting address of the other Bank then, actual cell array data is output. The hardware sequence flags indicate whether exact password is inputted at 4-6th write bus cycles by intervals of 11μs or more. During inputting password at 4-7th write bus cycles, DQ6 is toggling. When the first Password Unlock is successful, RY/ $\overline{\text{BY}}$ pin is LOW and DQ6 stop toggling. Then user can input next password. When the Password Unlock Command operation completes, the user has to perform Hidden ROM Exit command. PPB Lock Bit should be read in order to check whether Password Unlock has completed successfully.

Status Flags of progressing the Password Unlock Command

	DQ7	DQ6	DQ5	DQ4	DQ3	DQ2	DQ1	DQ0	RY/B \bar{Y}
PWD Unlock in Progress	0	Toggle	0	0	0	1	0	0	0
Finished Input PWD ⁽¹⁾	0 ⁽²⁾	1	0	0	0	1	0	0	0
Finished Input PWD ⁽¹⁾	1 ⁽³⁾	1	0	0	0	1	0	0	High-Z
Finished Input PWD ⁽⁴⁾	Array Data								High-Z

Notes:

- (1) Specified BA within Bank-0 (Bottom Boot Block Device)/ Bank-15 (Top Boot Block Device)
- (2) After inputting PWD at the 4th ,5th and 6th bus write cycles, DQ7 is "0"
- (3) After inputting PWD at the 7th bus write cycle, DQ7 is "1"
- (4) Specified BA without Bank-0 (Bottom Boot Block Device)/ Bank-15 (Top Boot Block Device)

5.17.6. Verify Block Protect

The Verify Block Protect command is used to ascertain whether a block is protected or unprotected. Verification is performed by inputting the Verify Block Protect command. The Verify Block Protect command, which can be performed simultaneously with operations in another bank, is performed by setting the block address with A0=A6=VIL and A1=VIH. If the block is protected, 01h is output. If the block is unprotected, 00h is output. The status depends on PPB, DPB, \overline{WP} and \overline{ABP} and \overline{RESET} state.

Inputting the verify block protect command sequence sets the specified bank to the Verify Block Protect mode. Inputting a Reset command releases this mode and returns the device to Read Mode. When verifying block protect across a bank boundary, a Reset command is needed at the time of the change of a bank.

5.18. Hidden ROM Area

The TC58FYM8T7D/B7D features a 64-Kwords hidden ROM area, which is separate from the memory cells. The area consists of one block. Data Read, Write and Protect can be performed on this block. Because Protect cannot be released, once the block is protected, data in the block cannot be overwritten.

The hidden ROM area is located in the address space indicated in the HIDDEN ROM AREA ADDRESS TABLE. To access the Hidden ROM area, input a Hidden ROM Mode Entry command. The device now enters Hidden ROM Mode, allowing Read, Write, Erase and Block Protect to be executed. Write and Erase operations are the same as auto operations except that the device is in Hidden ROM Mode.

To protect the hidden ROM area, use the Hidden ROM Protect Command. The status of Hidden ROM protect operation can be checked by hardware sequence flags. Hidden ROM protect time is equal to tPPRW (Auto PPB set time). The hosts have to decide the protection state of Hidden ROM Area before the PPB Lock has been settled. Once the block has been protected, protection cannot be released. Using Block Protection for Hidden ROM Area must be careful.

Note that in Hidden ROM Mode, simultaneous operation cannot be performed for BANK15 in top boot type and for BANK0 in bottom boot type. To exit Hidden ROM Mode, use the Hidden ROM Mode Exit command. This will return the device to Read Mode.

HIDDEN ROM AREA ADDRESS TABLE

TYPE	BOOT BLOCK ARCHITECTURE	ADDRESS RANGE	SIZE
TC58FYM8T7D	TOP BOOT BLOCK	FF0000h~FFFFFFh	64 Kwords
TC58FYM8B7D	BOTTOM BOOT BLOCK	000000h~00FFFFh	64 Kwords

The Hardware Sequence Flags of the Hidden ROM Protect mode

	DQ7	DQ6	DQ5	DQ4	DQ3	DQ2	DQ1	DQ0	RY/ $\overline{\text{BY}}$
In Progress	0	Toggle	0	0	0	1	0	0	0
Protect Complete	1	1	0	0	0	1	0	0	High-Z
Protect Failed	0	Toggle	1	0	0	1	0	0	0

5.21. CFI (Common Flash memory Interface)

The TC58FYM8T7D/B7D conforms to the CFI specifications. To read information from the device, input the Query command followed by the address. In Word Mode DQ8~DQ15 all output 0s. To exit this mode, input the Reset command..

CFI CODE TABLE 1 (Continue)

ADDRESS A6~A0	DATA DQ15~DQ0	DESCRIPTION
10h 11h 12h	0051h 0052h 0059h	ASCII string "QRY"
13h 14h	0002h 0000h	Primary OEM command set 2: AMD/FJ standard type
15h 16h	0040h 0000h	Address for primary extended table
17h 18h	0000h 0000h	Alternate OEM command set 0: none exists
19h 1Ah	0000h 0000h	Address for alternate OEM extended table
1Bh	0017h	V _{DD} (min) (Write/Erase) DQ7~DQ4: 1 V DQ3~DQ0: 100 mV
1Ch	0019h	V _{DD} (max) (Write/Erase) DQ7~DQ4: 1 V DQ3~DQ0: 100 mV
1Dh	0000h	V _{PP} (min) voltage
1Eh	0000h	V _{PP} (max) voltage
1Fh	0004h	Typical time per single word write (2 ^N μs)
20h	0000h	Typical time for minimum size buffer write (2 ^N μs)
21h	000Ah	Typical time per individual block erase (2 ^N ms)
22h	0000h	Typical time for full chip erase (2 ^N ms)
23h	0005h	Maximum time-out for word write (2 ^N times typical)
24h	0000h	Maximum time-out for buffer write (2 ^N times typical)
25h	0004h	Maximum time-out per individual block erase (2 ^N times typical)
26h	0000h	Maximum time-out for full chip erase (2 ^N times typical)
27h	0019h	Device Size (2 ^N byte) 1Ah:512Mbit, 19h:256Mbit, 18h:128Mbit
28h 29h	0001h 0000h	Flash device interface description 1: x 16
2Ah 2Bh	0004h 0000h	Maximum number of bytes in multi-byte write (2 ^N)

CFI CODE TABLE 2(Sequel)

ADDRESS A6~A0	DATA DQ15~DQ0	DESCRIPTION
2Ch	0002h	Number of erase block regions within device
2Dh 2Eh 2Fh 30h	0007h 0000h 0040h 0000h	Erase Block Region 1 information Bits 0~15: y = block number Bits 16~31: z = block size (z × 256 bytes)
31h 32h 33h 34h	00FEh 0000h 0000h 0002h	Erase Block Region 2 information
40h 41h 42h	0050h 0052h 0049h	ASCII string "PRI"
43h	0031h	Major version number, ASCII
44h	0031h	Minor version number, ASCII
45h	0000h	Address-Sensitive Unlock 0: Required 1: Not required
46h	0002h	Erase Suspend 0: Not supported 1: For Read-only 2: For Read & Write
47h	0001h	Block Protect 0: Not supported X: Number of blocks per group
48h	0000h	Block Temporary Unprotect 0: Not supported 1: Supported
49h	0007h	Block Protect/Unprotect scheme
4Ah	0001h	Simultaneous operation 0: Not supported 1: Supported
4Bh	0000h	Burst Mode 0: Not supported 1: Supported
4Ch	0001h	Page Mode 0: Not supported 1: Supported
4Dh	00B4h	V _{ACC} (min) voltage DQ7~DQ4: 1 V DQ3~DQ0: 100 mV
4Eh	00C6h	V _{ACC} (max) voltage DQ7~DQ4: 1 V DQ3~DQ0: 100 mV
4Fh	000xh	Top/Bottom Boot Block Flag X = 2: Bottom Boot Block: TC58FYM8B7D X = 3: Top Boot Block: TC58FYM8T7D
50h	0001h	Program Suspend 0: Not supported 1: Supported

CFI CODE TABLE 3(Sequel)

ADDRESS A6~A0	DATA DQ15~DQ0	DESCRIPTION
57h	0010h	Bank Organization 00h: Data at 4Ah is zero , X: Number of Banks
58h	00XXh	Bank0 Region information XX: Number of blocks Bank0 TOP : 10h BOTTOM:17h
59h	0010h	Bank1 Region information , Number of blocks Bank1 , n=16
5Ah	0010h	Bank2 Region information , Number of blocks Bank2 , n=16
5Bh	0010h	Bank3 Region information , Number of blocks Bank3 , n=16
5Ch	0010h	Bank4 Region information , Number of blocks Bank4 , n=16
5Dh	0010h	Bank5 Region information , Number of blocks Bank5 , n=16
5Eh	0010h	Bank6 Region information , Number of blocks Bank6 , n=16
5Fh	0010h	Bank7 Region information , Number of blocks Bank7 , n=16
60h	0010h	Bank8 Region information , Number of blocks Bank8 , n=16
61h	0010h	Bank9 Region information , Number of blocks Bank9 , n=16
62h	0010h	Bank10 Region information , Number of blocks Bank10 , n=16
63h	0010h	Bank11 Region information , Number of blocks Bank11 , n=16
64h	0010h	Bank12 Region information , Number of blocks Bank12 , n=16
65h	0010h	Bank13 Region information , Number of blocks Bank13 , n=16
66h	0010h	Bank14 Region information , Number of blocks Bank14 , n=16
67h	00XXh	Bank15 Region information XX: Number of blocks Bank15 TOP : 17h BOTTOM:10h

5.20. HARDWARE SEQUENCE FLAGS

The TC58FYM8T7D/B7D has a Hardware Sequence flag which allows the device status to be determined during an auto mode operation. The output data is read out using the same timing as that used when $\overline{CE} = \overline{OE} = V_{IL}$ in Read Mode. The $\overline{RY}/\overline{BY}$ output can be either High or Low.

The device re-enters Read Mode automatically after an auto mode operation has been completed successfully. The Hardware Sequence flag is read to determine the device status and the result of the operation is verified by comparing the read-out data with the original data.

STATUS				DQ7	DQ6	DQ5	DQ3	DQ2	$\overline{RY}/\overline{BY}$
In Progress	Auto Programming/Auto Page Programming			$\overline{DQ7}^{(4)}$	Toggle	0	0	1	0
	Read in Program Suspend ⁽¹⁾			Data	Data	Data	Data	Data	High-Z
	In Auto Erase	Auto Erase	Selected ⁽²⁾	0	Toggle	0	1	Toggle	0
			Not-selected ⁽³⁾	0	Toggle	0	1	1	0
	In Erase Suspend	Read	Selected	1	1	0	0	Toggle	High-Z
			Not-selected	Data	Data	Data	Data	Data	High-Z
		Programming	Selected	$\overline{DQ7}$	Toggle	0	0	Toggle	0
			Not-selected	$\overline{DQ7}$	Toggle	0	0	1	0
Time Limit Exceeded	Auto Programming/Auto Page Programming			$\overline{DQ7}^{(4)}$	Toggle	1	0	1	0
	Auto Erase			0	Toggle	1	1	N/A	0
	Programming in Erase Suspend			$\overline{DQ7}$	Toggle	1	0	N/A	0

Notes: DQ outputs cell data and $\overline{RY}/\overline{BY}$ goes High-Impedence when the operation has been completed.

DQ0 and DQ1 pins are reserved for future use. 0 is output on DQ0, DQ1 and DQ4.

- (1) Data output from an address to which Write is being performed is undefined.
- (2) Output when the block address selected for Auto Block Erase is specified and data is read from there.
- (3) Output when a block address not selected for Auto Block Erase of same bank as selected block is specified and data is read from there. During Auto Chip Erase, all blocks are selected.
- (4) In case of Page program operation is program data of (A0, A1, A2) = (1, 1, 1) in eleventh bus write cycle.

5.20.1. DQ7 (\overline{DATA} polling)

During an Auto-Program or an Auto-Erase operation, the device status can be determined using the data polling function. \overline{DATA} polling begins on the rising edge of \overline{WE} in the last bus cycle. In an Auto-Program operation, DQ7 outputs inverted data during the programming operation and outputs actual data after programming has finished. In an Auto-Erase operation, DQ7 outputs 0 during the Erase operation and outputs 1 when the Erase operation has finished. If an Auto-Program or an Auto-Erase operation fails, DQ7 simply outputs the data.

When the operation has finished, the address latch is reset. Data polling is asynchronous with the \overline{OE} signal.

5.20.2. DQ6 (Toggle bit 1)

The device status can be determined by the Toggle Bit function during an Auto-Program or an Auto-Erase operation. The Toggle bit begins toggling on the rising edge of \overline{WE} in the last bus cycle. DQ6 alternately outputs a 0 or a 1 for each \overline{OE} access while $\overline{CE} = V_{IL}$ while the device is busy. When the internal operation has been completed, toggling stops and valid memory cell data can be read by subsequent reading. If the operation fails, the DQ6 output toggles.

If an attempt is made to execute an Auto Program operation on a protected block, DQ6 will toggle for around 3 μ s (typ.). It will then stop toggling. If an attempt is made to execute an Auto Erase operation on a protected block, DQ6 will toggle for around 3 μ s (typ.). It will then stop toggling. After toggling has stopped the device will return to Read Mode.

5.20.3. DQ5 (internal time-out)

If an Auto-Program or an Auto-Erase operates normally, DQ5 outputs a 0. If the internal timer times out during a Program or an Erase operation, DQ5 outputs a 1. This indicates that the operation has not been completed within the allotted time.

Any attempt to program a 1 into a cell containing a 0 will fail (see Auto-Program Mode). In this case, DQ5 outputs a 1. In this case, DQ5 doesn't indicate defective device but mistaken usage.

After an Auto-Program or an Auto-Erase operation ends normally, the device outputs actual cell array data. Therefore only with the data of DQ5 can't specify whether cell array data or hardware sequence flag. The hosts should check the state of device whether progress or not, using DQ7 or DQ6.

In the case of internal time-out, either hardware reset or a software Reset command is required to return the device to Read Mode.

5.20.4. DQ3 (Block Erase timer)

DQ3 is used to detect whether in the Auto Erase Mode and the Erase Suspend Mode.

The device automatically begins the Erase operation when the command sequence of the Chip Erase or the Block Erase is input, and DQ3 outputs 1. DQ3 outputs 0 to the selection block of the Block Erase at the Erase Suspend Read Mode. DQ3 outputs 0 regardless of the block at the Erase Suspend Program Mode. When DQ3 is a result of an Auto Erase operation failure or outputs 1, and is a result of an Erase Suspend Program failure, DQ3 outputs 0.

5.20.5. DQ2 (Toggle bit 2)

DQ2 is used to indicate which blocks have been selected for an Auto Block Erase or to indicate whether the device is in an Erase Suspend Mode.

If the data is read continuously from the selected block during an Auto Block Erase, the DQ2 output will toggle. Now 1 will be output from non-selected blocks; thus, the selected block can be ascertained. If the data is read continuously from the block selected for the Auto Block Erase while the device is in the Erase Suspend Mode, the DQ2 output will toggle. Because the DQ6 output is not toggling, it can be determined that the device is in the Erase Suspend Mode. If the data is read from the address to which data is being written during the Erase Suspend in the Programming Mode, DQ2 will output a 1.

5.20.6. RY/ $\overline{\text{BY}}$ (Ready/ $\overline{\text{BUSY}}$)

The TC58FYM8T7D/B7D has a RY/ $\overline{\text{BY}}$ signal to indicate the device status to the host processor. A 0 (Busy state) indicates that an Auto-Program or an Auto-Erase operation is in progress. A 1 (Ready state) indicates that the operation has finished and that the device can now accept a new command. RY/ $\overline{\text{BY}}$ outputs a 0 when an operation has failed.

RY/ $\overline{\text{BY}}$ outputs a 0 after the rising edge of $\overline{\text{WE}}$ in the last command cycle.

During an Auto Block Erase operation, commands other than Erase Suspend are ignored. RY/ $\overline{\text{BY}}$ outputs a 1 during an Erase Suspend operation. The output buffer for the RY/ $\overline{\text{BY}}$ pin is an open-drain type circuit, allowing a wired-OR connection. A pull-up resistor must be inserted between V_{DD} and the RY/ $\overline{\text{BY}}$ pin.

6. DATA PROTECTION

TC58FYM8T7D/B7D includes a function which guards against malfunction or data corruption.

6.1. Protection against Program/Erase Caused by Low Supply Voltage

To prevent malfunction at power-on or power-down, the device will not accept commands while V_{DD} is below V_{LKO}. In this state, command input is ignored.

If V_{DD} drops below V_{LKO} during an Auto operation, the device will terminate the Auto operation execution. In this case, the Auto operation is not executed again when V_{DD} returns to recommended V_{DD} voltage. Therefore, command need to be input to execute the Auto operation again.

6.2. Protection against Malfunction Caused by Glitches

To prevent malfunction write during operation caused by noise from the system, the device will not accept pulses shorter than 3 ns (Typ.) input on \overline{WE} , \overline{CE} or \overline{OE} . However, if a glitch exceeding 3 ns (Typ.) occurs and the glitch is input to the device malfunction write may occur.

The device uses standard JEDEC commands. It is conceivable that, in extreme cases, system noise may be misinterpreted as part of a command sequence input and that the device will acknowledge it. Then, even if a proper command is input, the device may not operate. To avoid this possibility, clear the Command Register before command input. In an environment prone to system noise, Toshiba recommends input of a software or hardware reset before command input.

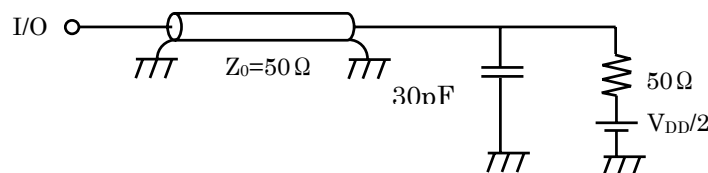
6.3. Protection against Malfunction at Power-on

To prevent damage to data caused by sudden noise at power-on, when power is turned on with $\overline{WE} = \overline{CE} = V_{IL}$ the device does not latch the command on the first rising edge of \overline{WE} or \overline{CE} . Instead, the device automatically Resets the Command Register and enters the Read Mode.

7. AC TEST CONDITIONS

PARAMETER	CONDITION
Input Pulse Level	V _{DD} , 0.0 V
Input Pulse Rise and Fall Time (10%~90%)	2ns
Timing Measurement Reference Level (input)	V _{DD} /2, V _{DD} /2
Timing Measurement Reference Level (output)	V _{DD} /2, V _{DD} /2
Output Load	C _L (30 pF) + 1 TTL Gate

(AC Test Condition)



8. AC CHARACTERISTICS AND OPERATING CONDITIONS**8.1. Read Cycle**

SYMBOL	PARAMETER	MIN	MAX	UNIT
t _{RC}	Read Cycle Time	70	—	ns
t _{PRC}	Page Read Cycle Time	15	—	ns
t _{ACC}	Address Access Time	—	70	ns
t _{CE}	\overline{CE} Access Time	—	70	ns
t _{OE}	\overline{OE} Access Time	—	15	ns
t _{PACC}	Page Access Time	—	15	ns
t _{OEHigh}	\overline{OE} High Level Hold Time (Read)	0	—	ns
t _{CEE}	\overline{CE} to Output Low-Z	0	—	ns
t _{OEE}	\overline{OE} to Output Low-Z	0	—	ns
t _{OH}	Output Data Hold Time	3	—	ns
t _{AOH}	Output Data Hold Time (Page Read)	3	—	ns
t _{DF1}	\overline{CE} to Output High-Z	—	12	ns
t _{DF2}	\overline{OE} to Output High-Z	—	12	ns

8.2. Command Write/Program/Eraser cycle

SYMBOL	PARAMETER	MIN	MAX	UNIT
t _{CMD}	Command Write Cycle Time	60	—	ns
t _{AS}	Address Set-up Time	0	—	ns
t _{AH}	Address Hold Time	20	—	ns
t _{DS}	Data Set-up Time	20	—	ns
t _{DH}	Data Hold Time	0	—	ns
t _{WELH}	\overline{WE} Low-Level Hold Time (\overline{WE} Control)	35	—	ns
t _{WEHH}	\overline{WE} High-Level Hold Time (\overline{WE} Control)	25	—	ns
t _{CES}	\overline{CE} Set-up Time to \overline{WE} Active (\overline{WE} Control)	0	—	ns
t _{CEH}	\overline{CE} Hold Time from \overline{WE} High Level (\overline{WE} Control)	0	—	ns
t _{CELH}	\overline{CE} Low-Level Hold Time (\overline{CE} Control)	35	—	ns
t _{CEHH}	\overline{CE} High-Level Hold Time (\overline{CE} Control)	25	—	ns
t _{WES}	\overline{WE} Set-up time to \overline{CE} Active (\overline{CE} Control)	0	—	ns
t _{WEH}	\overline{WE} Hold Time from \overline{CE} High Level (\overline{CE} Control)	0	—	ns
t _{OES}	\overline{OE} Set-up Time	0	—	ns
t _{OEHP}	\overline{OE} High Level Hold Time (Polling)	6	—	ns
t _{OEHT}	\overline{OE} High Level Hold Time (Toggle Read)	18	—	ns
t _{CEHT}	\overline{CE} High Level Hold Time (Toggle Read)	18	—	ns
t _{AHT}	Address Hold Time (Toggle)	0	—	ns
t _{AST}	Address Set-up Time (Toggle)	0	—	ns
t _{VDS}	V _{DD} Set-up Time	500	—	μs
t _{BUSY}	Program/Eraser Valid to RY/ \overline{BY} Delay	—	90	ns
	Program Valid to RY/ \overline{BY} Delay during Eraser Suspend Mode	—	500	ns
t _{RB}	RY/ \overline{BY} Recovery Time	0	—	ns
t _{SUSP}	Program Suspend Command to Suspend Mode	—	7	μs
t _{SUSPA}	Page Program Suspend Command to Suspend Mode	—	7	μs
t _{RESP}	Program Resume Command to Program Mode	—	500	ns
t _{SUSE}	Eraser Suspend Command to Suspend Mode	—	25	μs
t _{RESE}	Eraser Resume Command to Eraser Mode	—	500	μs

8.3. Hardware RESET

SYMBOL	PARAMETER	MIN	MAX	UNIT
t _{READY}	Read Mode Recovery Time from $\overline{\text{RESET}}$ (During Auto Operation)	—	25	μs
t _{READY}	Read Mode Recovery Time from $\overline{\text{RESET}}$ (During Non Auto Operation)	—	500	ns
t _{RP}	$\overline{\text{RESET}}$ Low Level Hold Time	500	—	ns
t _{RH}	Recovery Time from $\overline{\text{RESET}}$	50	—	ns

8.4. Program and Erase characteristics

SYMBOL	PARAMETER	MIN	TYP.	MAX	UNIT
t _{PPW}	Auto-Program Time (Word Mode)	—	12	300	μs
t _{PPAW}	Auto-Page program time (8 word)	—	60	2400	μs
t _{PCEW}	Auto Chip Erase Time ⁽¹⁾	—	316	1315	s
t _{PBEW}	Auto Block Erase Time ⁽¹⁾	—	1.2	5 ⁽²⁾	s
t _{PPRW}	Auto PPB Set Time	—	100	4000	μs
t _{PPEW}	Auto PPB Clear Time	—	2.5	5000	ms

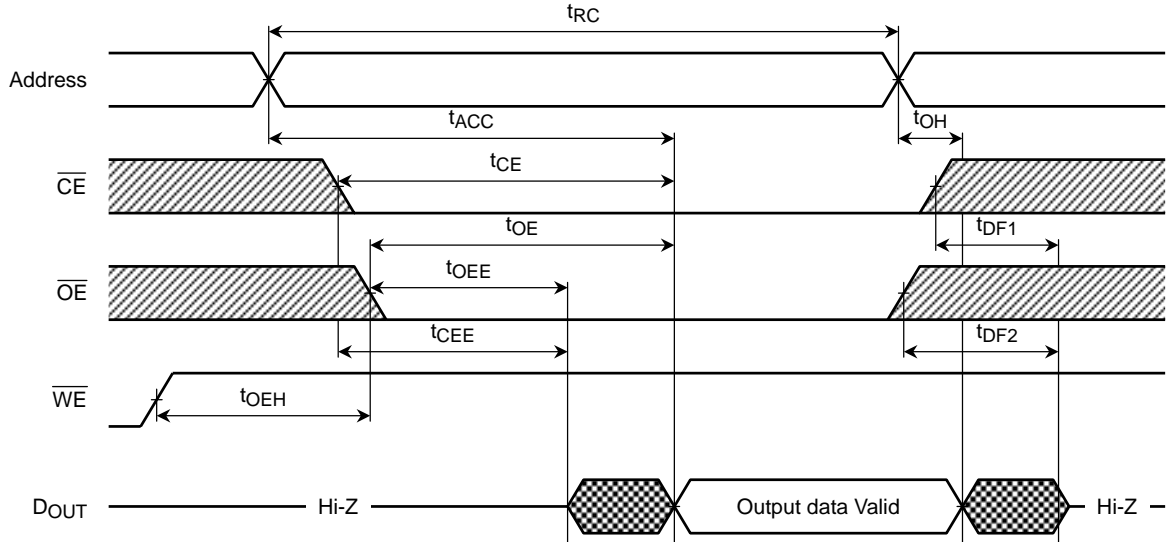
(1) Auto Chip Erase Time and Auto Block Erase Time include internal pre program time.

(2) Minimum interval between resume and the following suspend command is 150 μs. If it's shorter than 150 μs, Auto Block Erase Time expand more than maximum (5.0s).

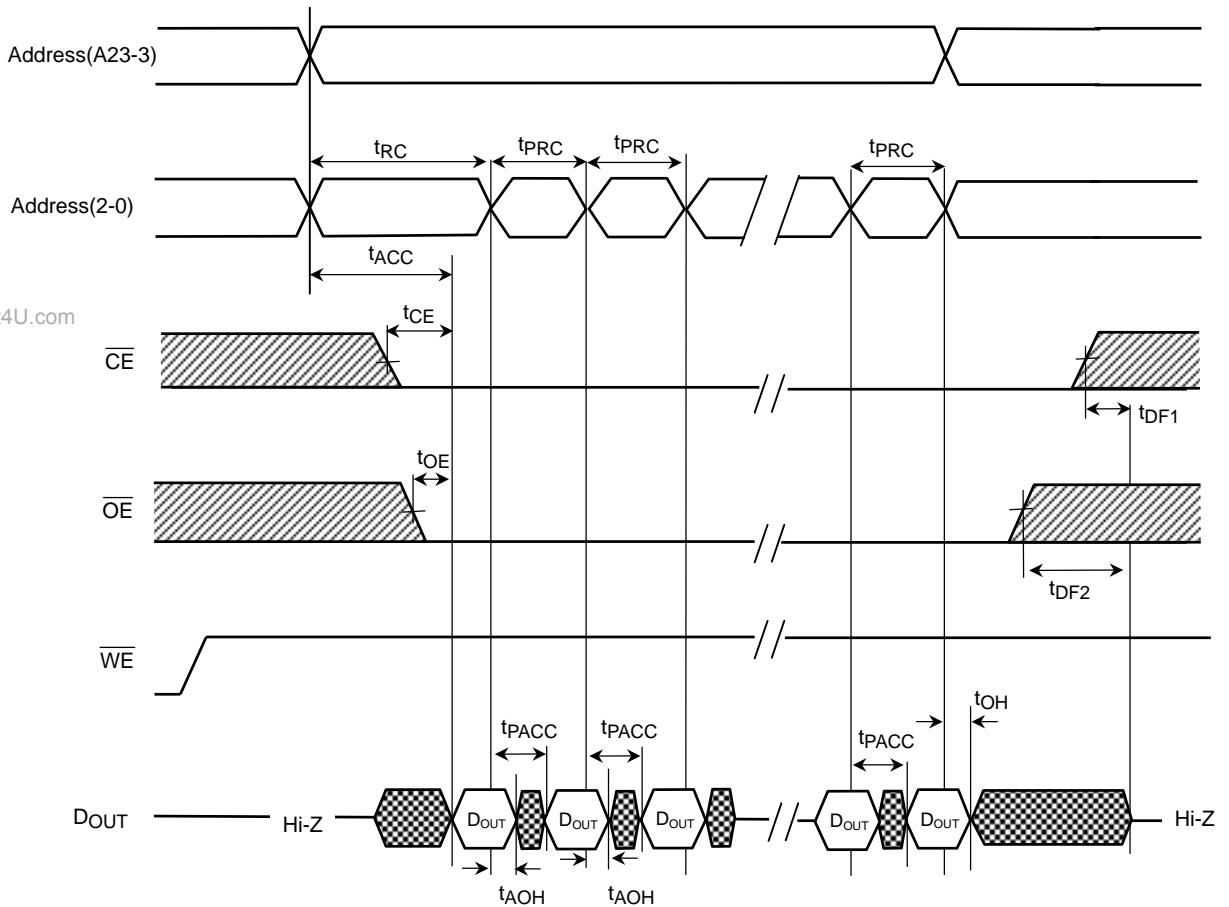
9. TIMING DIAGRAMS



Read/ID Read Operation



Page Read Operation

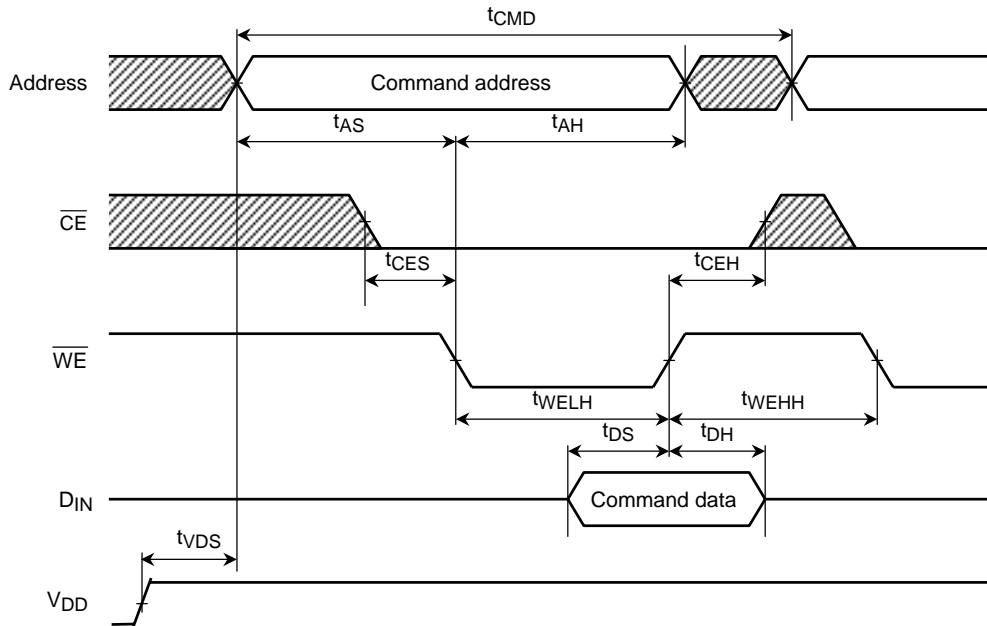


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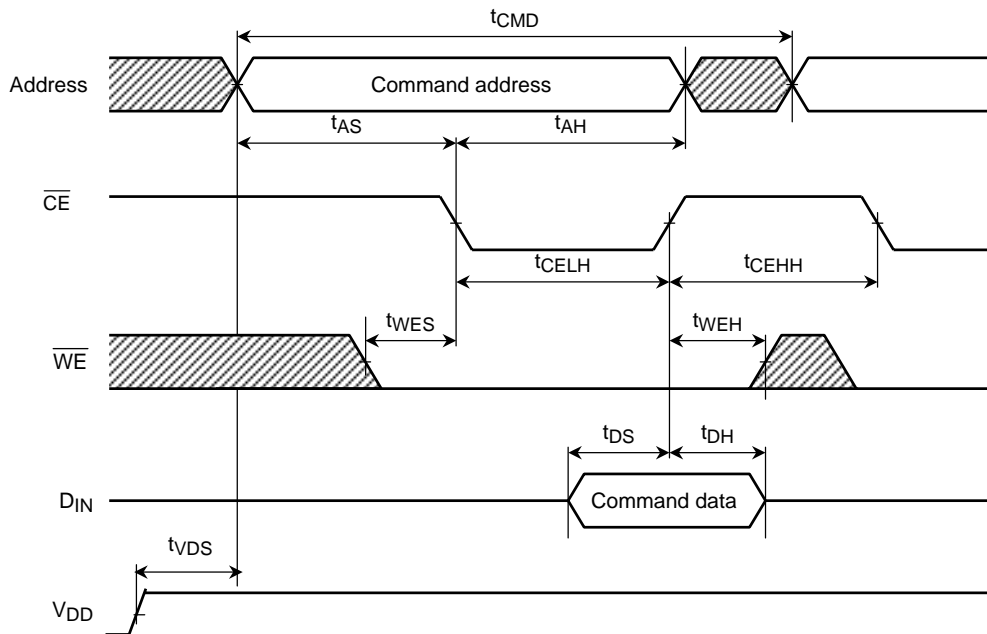
Command Write Operation

This is the timing of the Command Write Operation. The timing which is described in the following pages is essentially the same as the timing shown on this page.

\overline{WE} Control

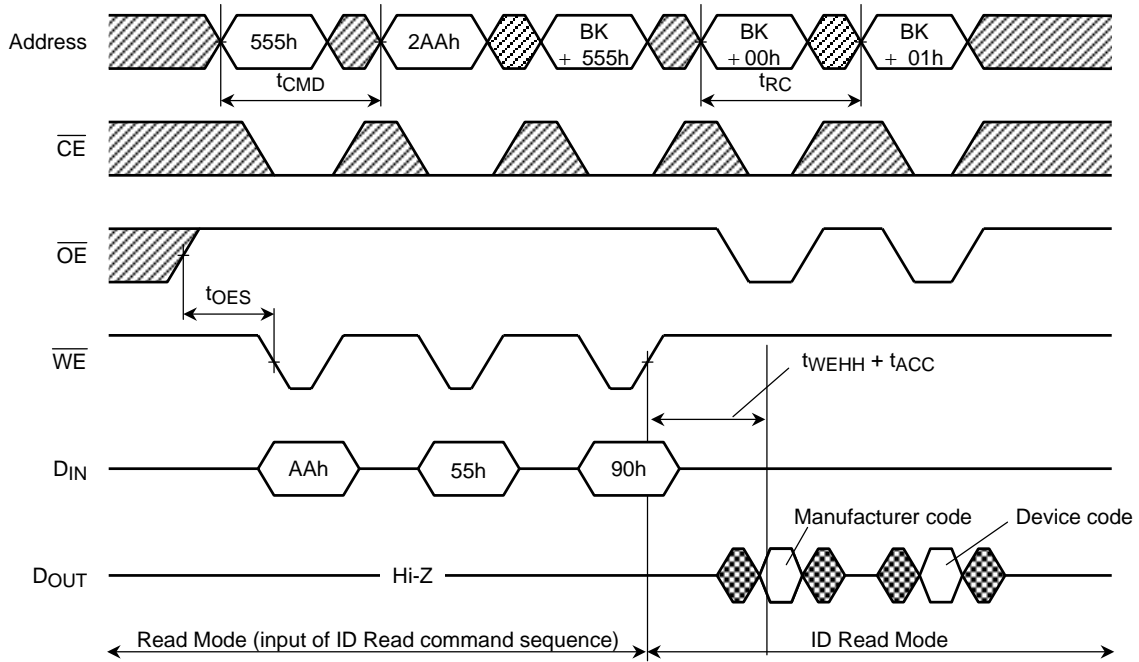


\overline{CE} Control

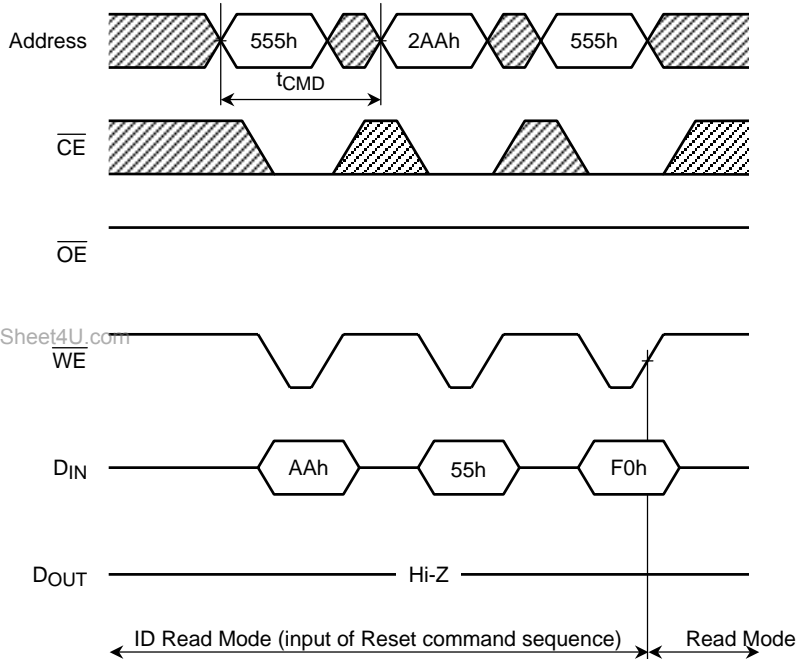


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ID Read Operation (Command Mode)

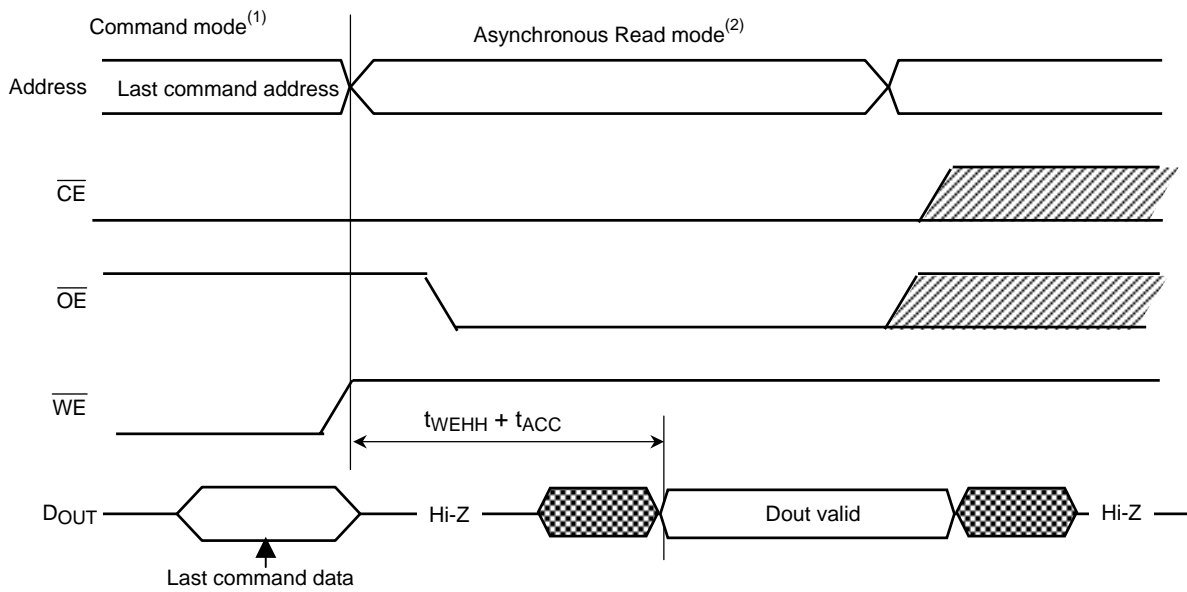


(Continued)



Note. BK: Bank address

Read after command input



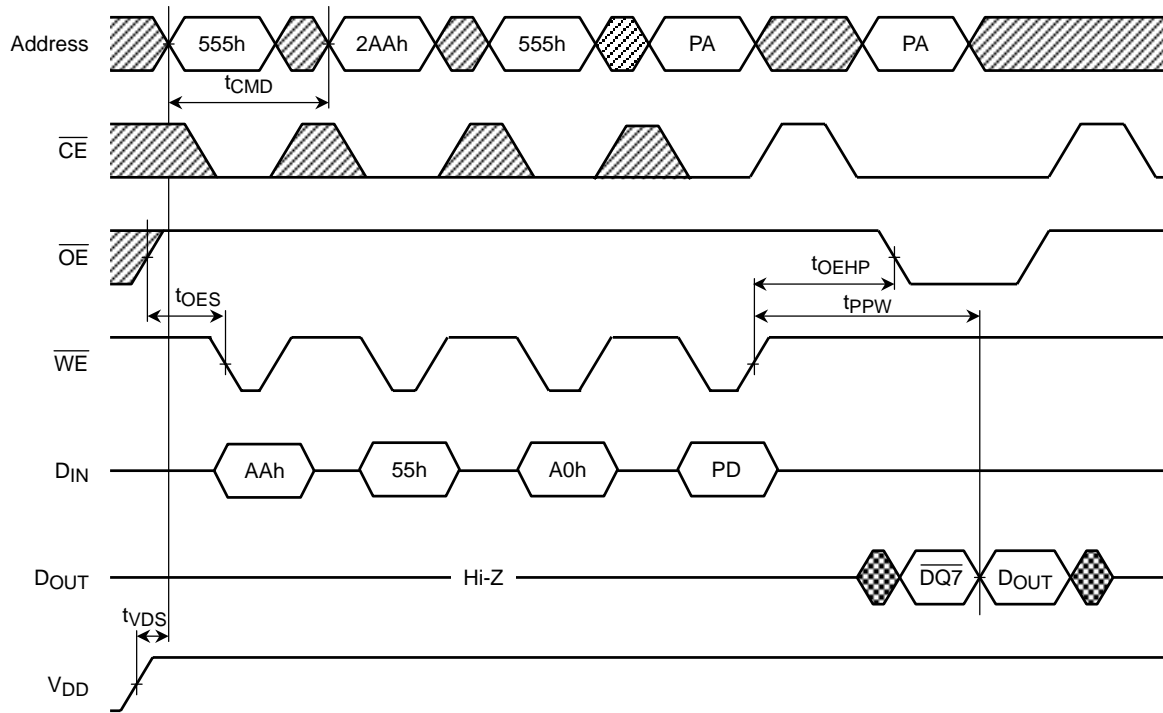
Notes.

1. Below Commands are objects of above timing.

- ID Read Command
- Reset Command in ID Read mode
- CFI Read Command
- Reset Command in CFI Read mode
- Hidden ROM Mode Entry Command
- Hidden ROM Mode Exit Command
- Password Verify Command

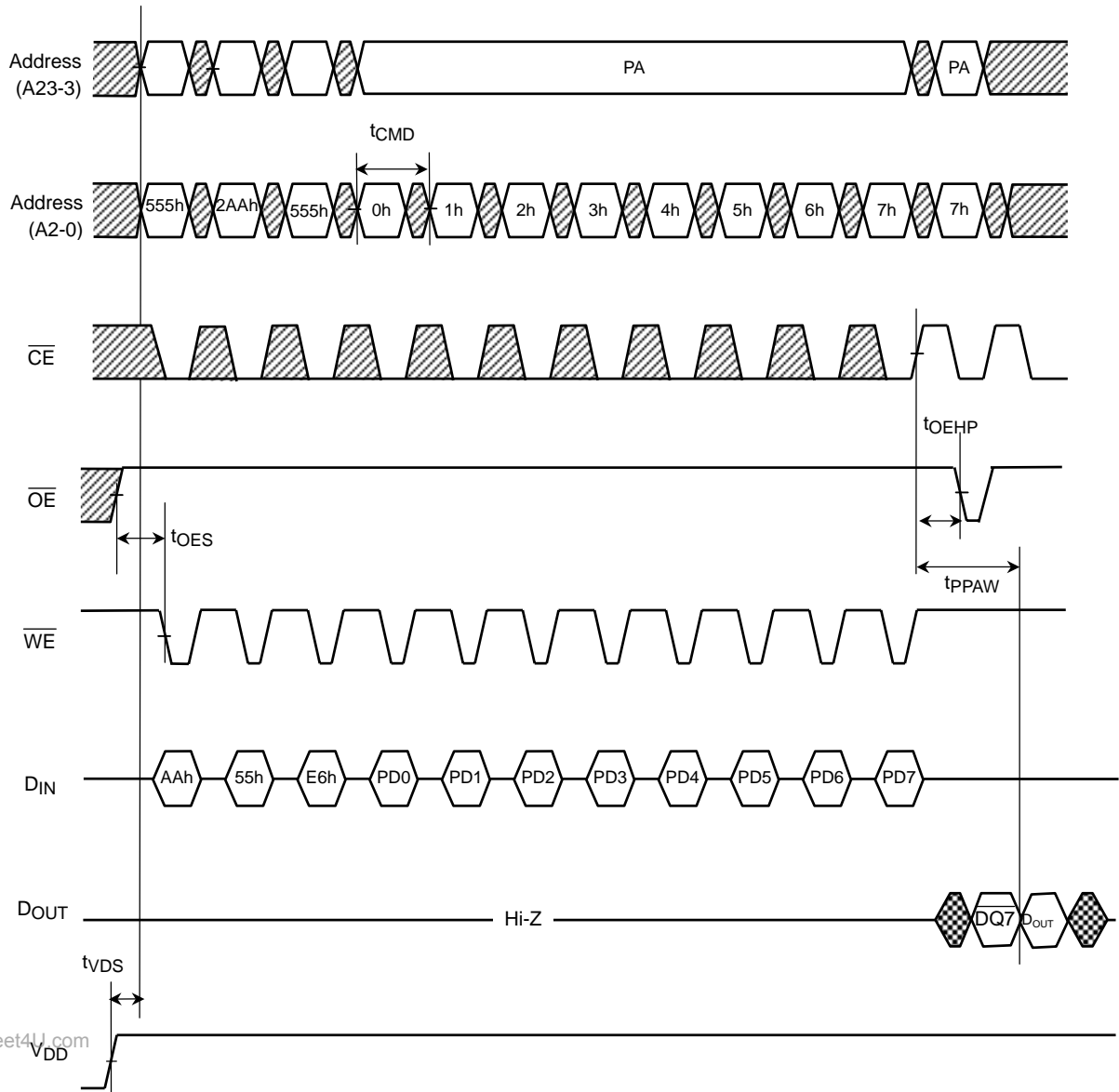
2. Read Mode after last command mode input change to Read mode , ID read mode , CFI read mode or Hidden Rom mode by Read mode address and Comman mode. Above timming is needed in all cases.

Auto-Program Operation (\overline{WE} Control)



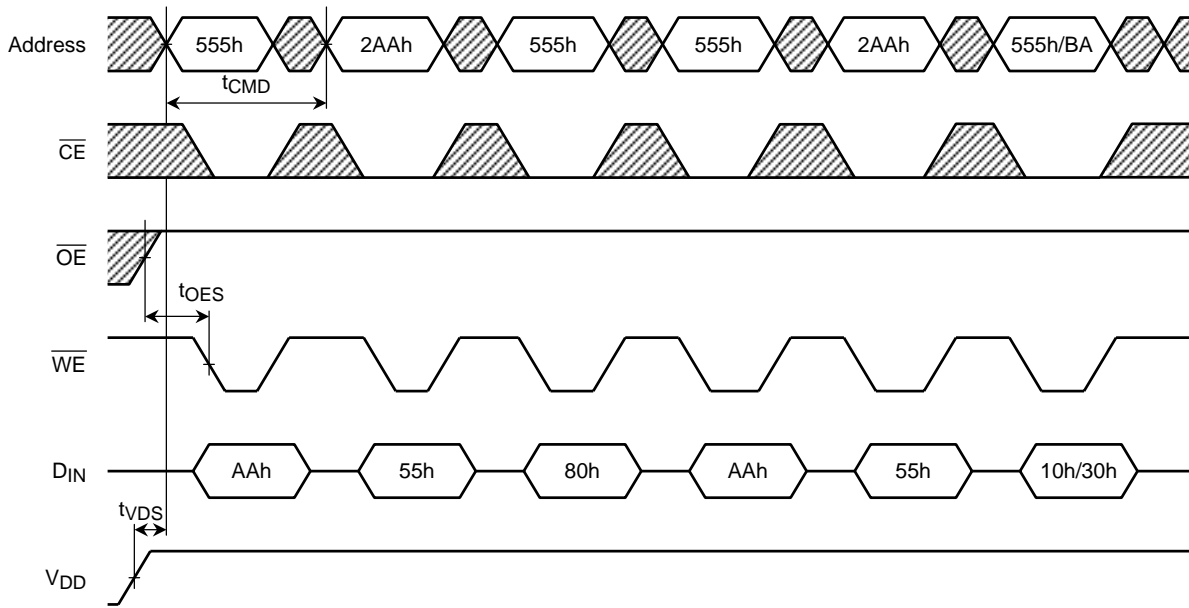
- Notes:
1. PA: Program address
 2. PD: Program dat

Auto Page Program Operation (\overline{WE} Control)



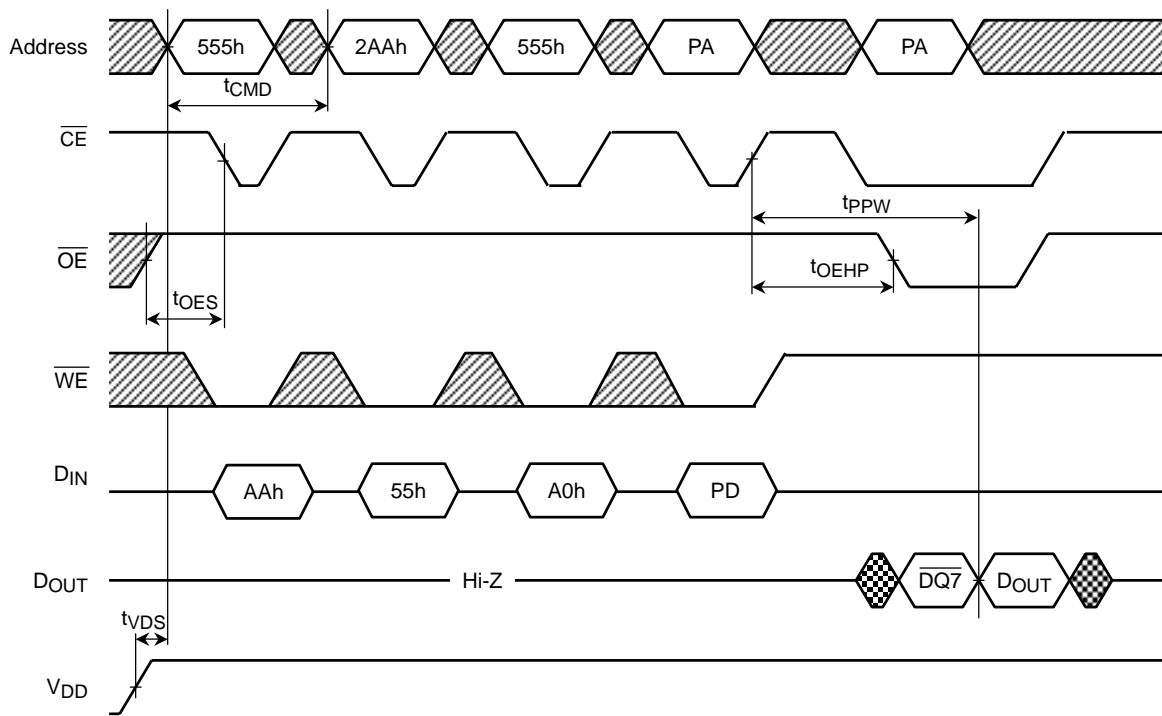
- Notes:
1. PA: Program address
 2. PD: Program Data

Auto Chip Erase/Auto Block Erase Operation (\overline{WE} Control)



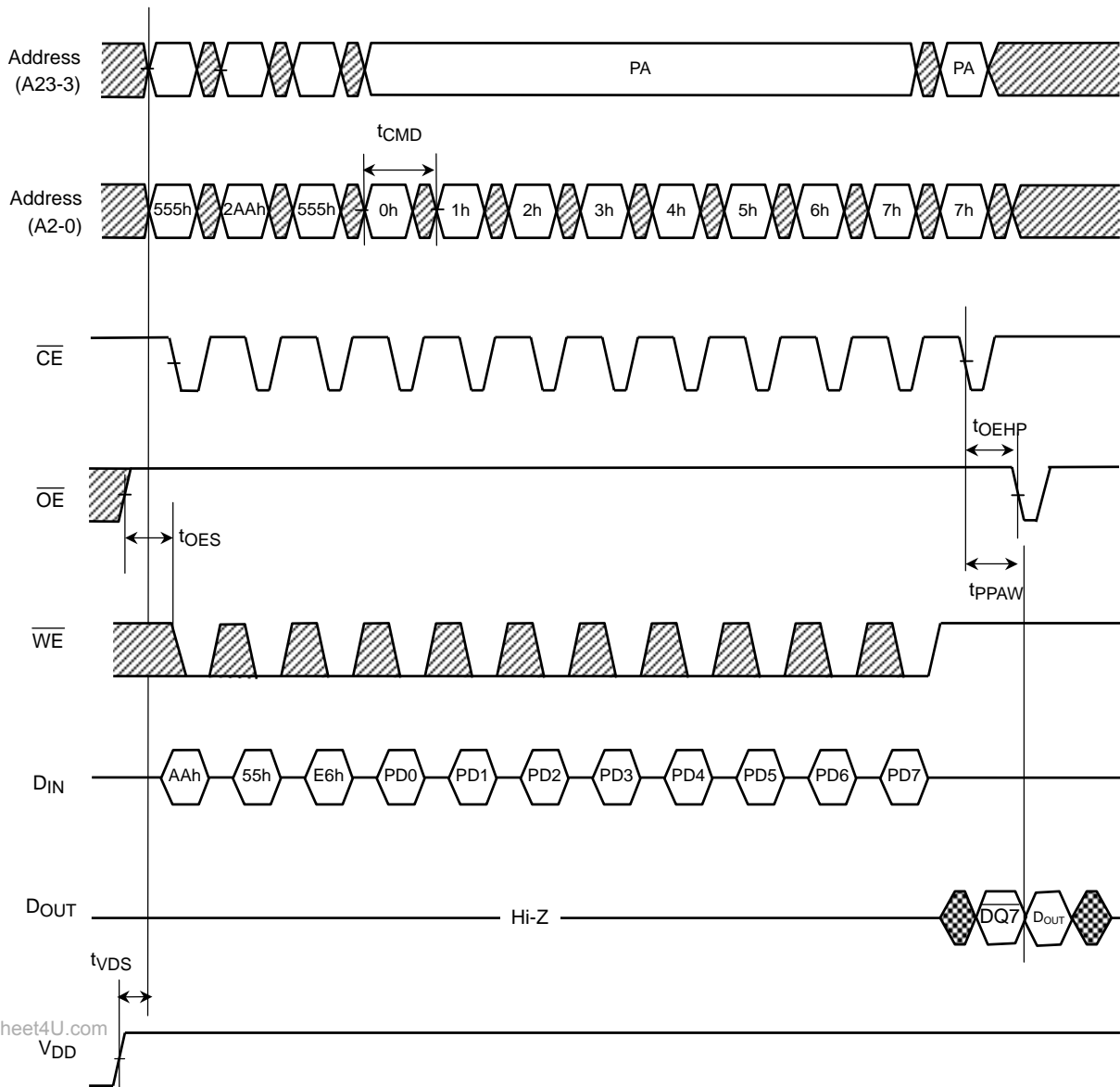
Note. BA: Block address

Auto Program Operation (\overline{CE} Control)



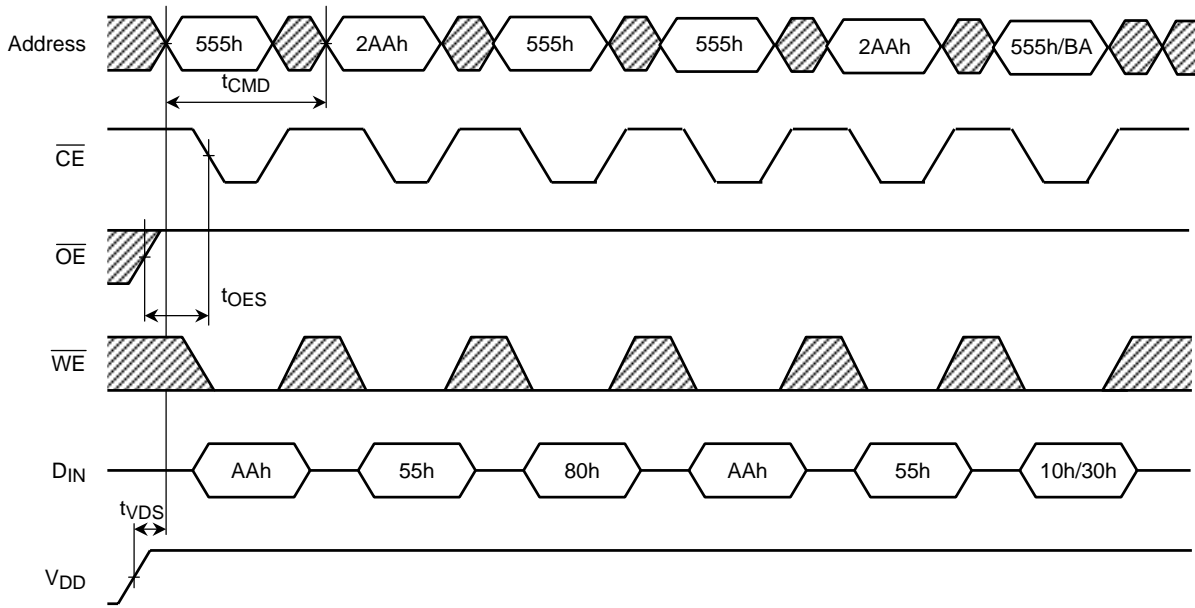
- Notes:
1. PA: Program address
 2. PD: Program data

Auto Page Program Operation (\overline{CE} Control)



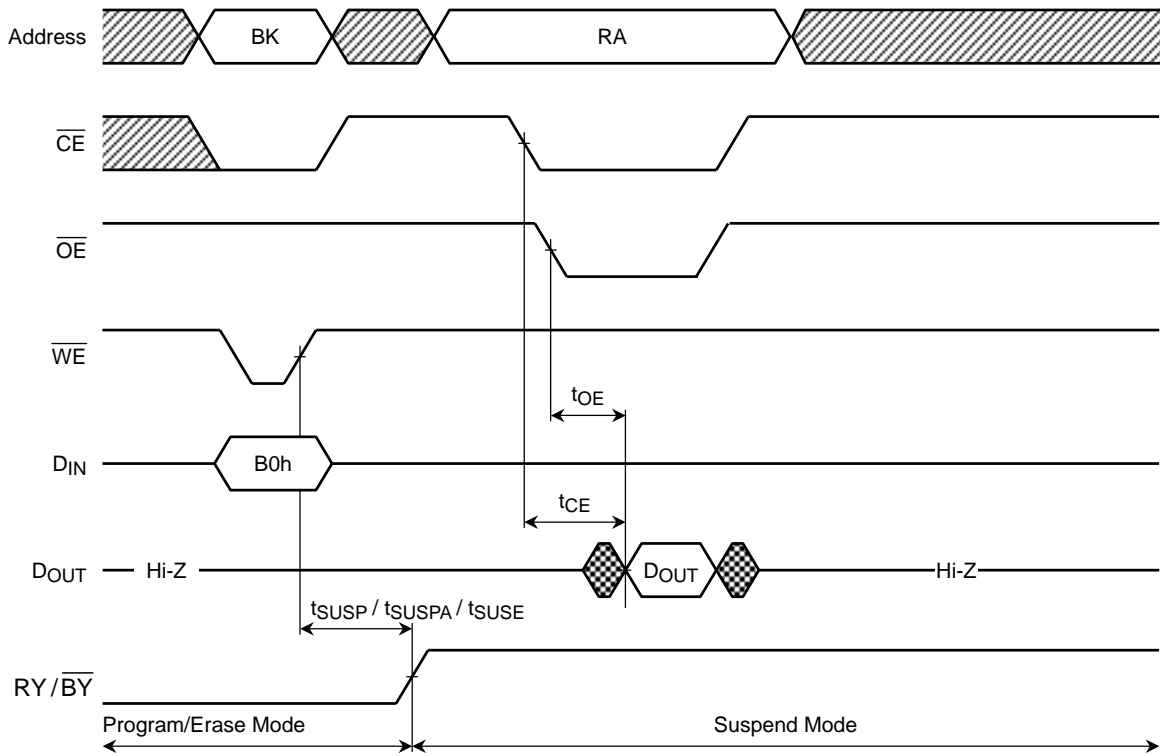
- Notes: 1. PA: Program address
2. PD: Program data

Auto Chip Erase/Auto Block Erase Operation (\overline{CE} Control)



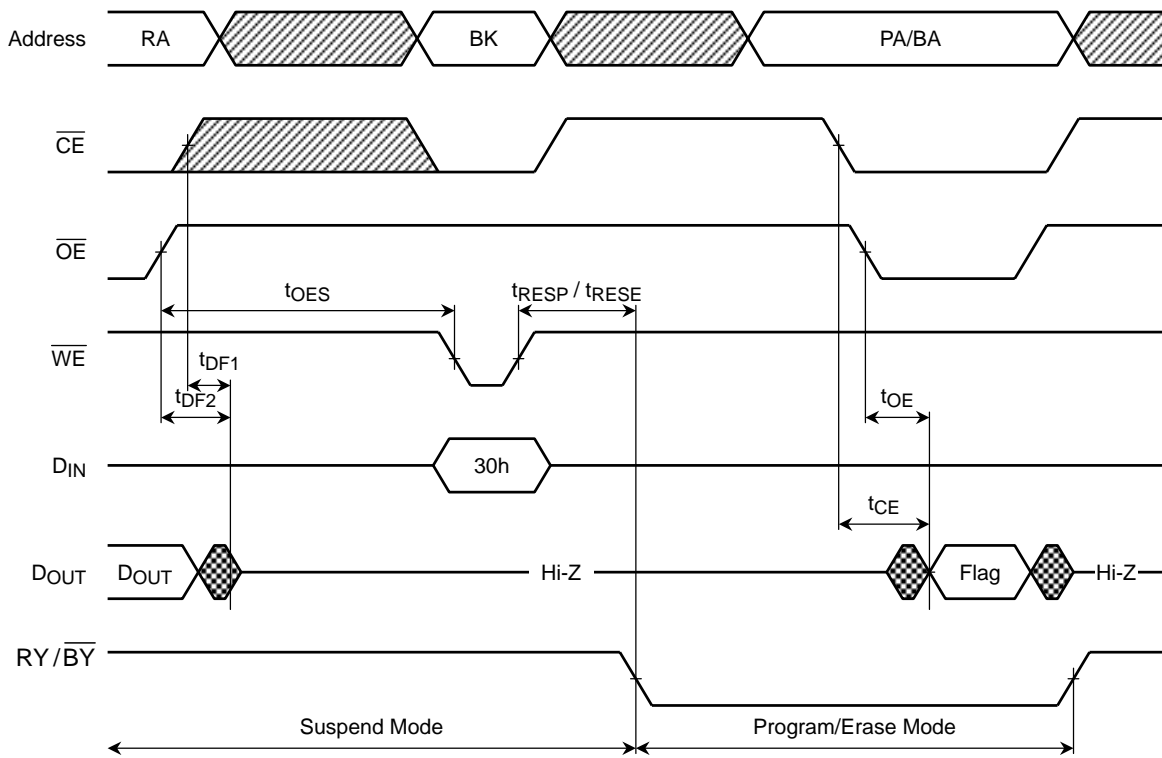
Note: BA: Block address for Auto Block Erase operation

Program/Erase Suspend Operation



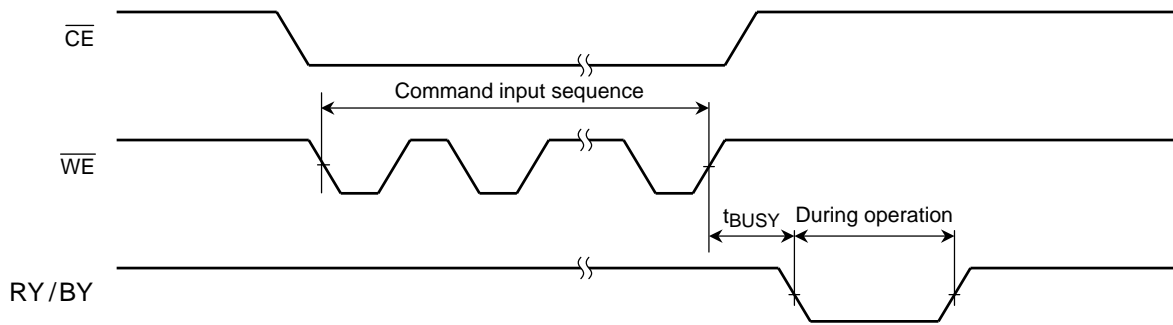
- Notes: 1. BK: Bank address
2. RA: Read address

Program/Erase Resume Operation

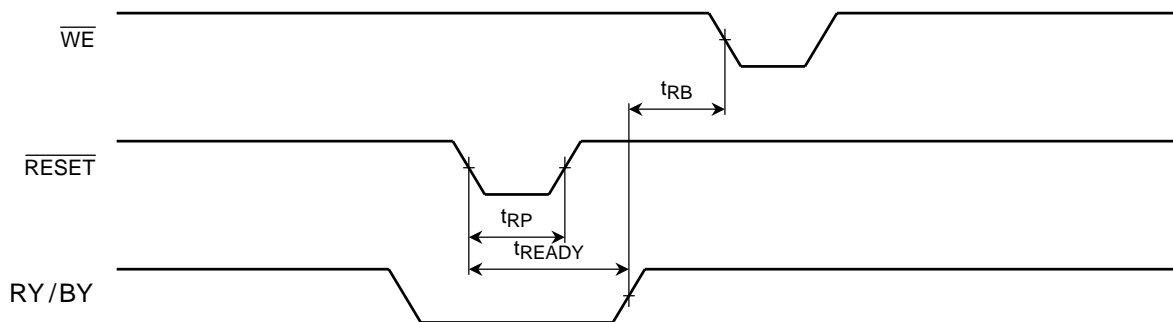


- Notes:
1. PA: Program address
 2. BK: Bank address
 3. BA: Block address
 4. RA: Read address
 5. Flag: Hardware Sequence flag

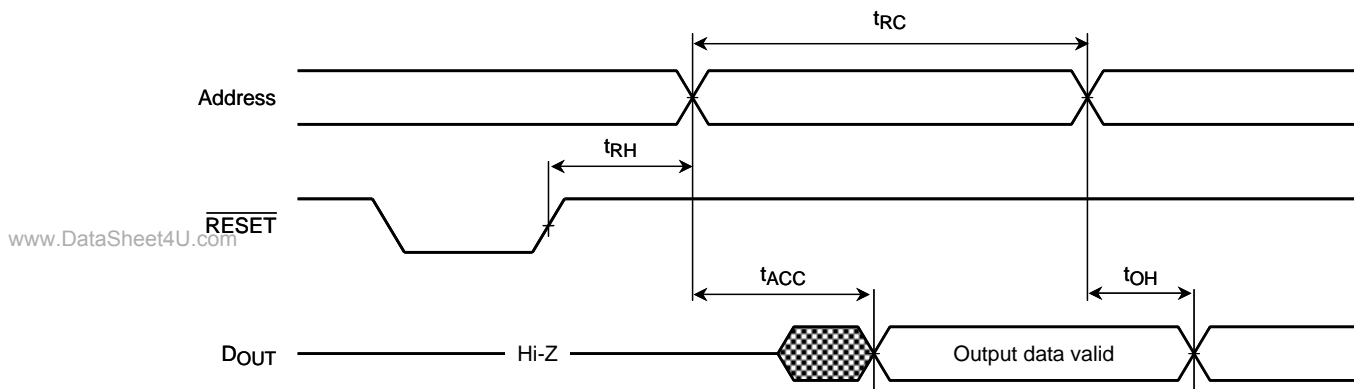
RY/BY during Auto Program/Erase Operation



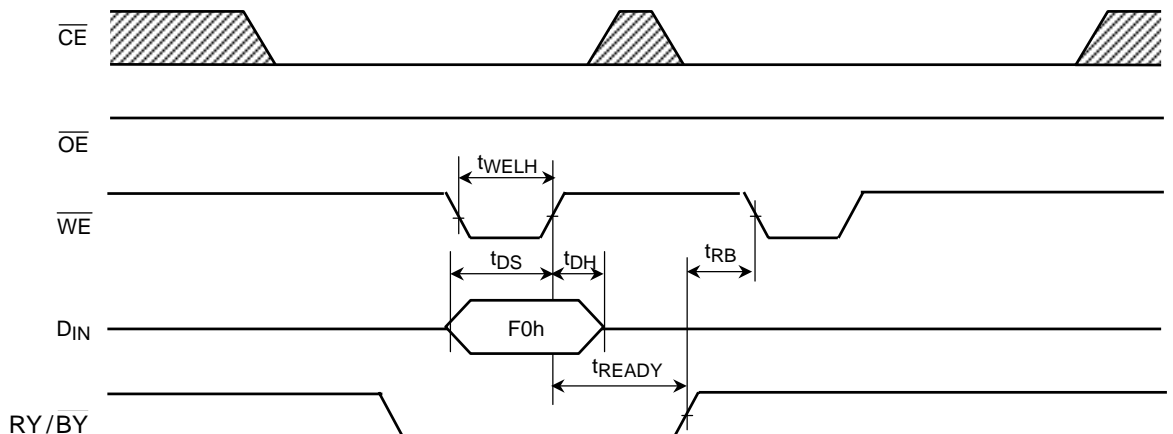
Hardware Reset Operation (At the Auto Operation)



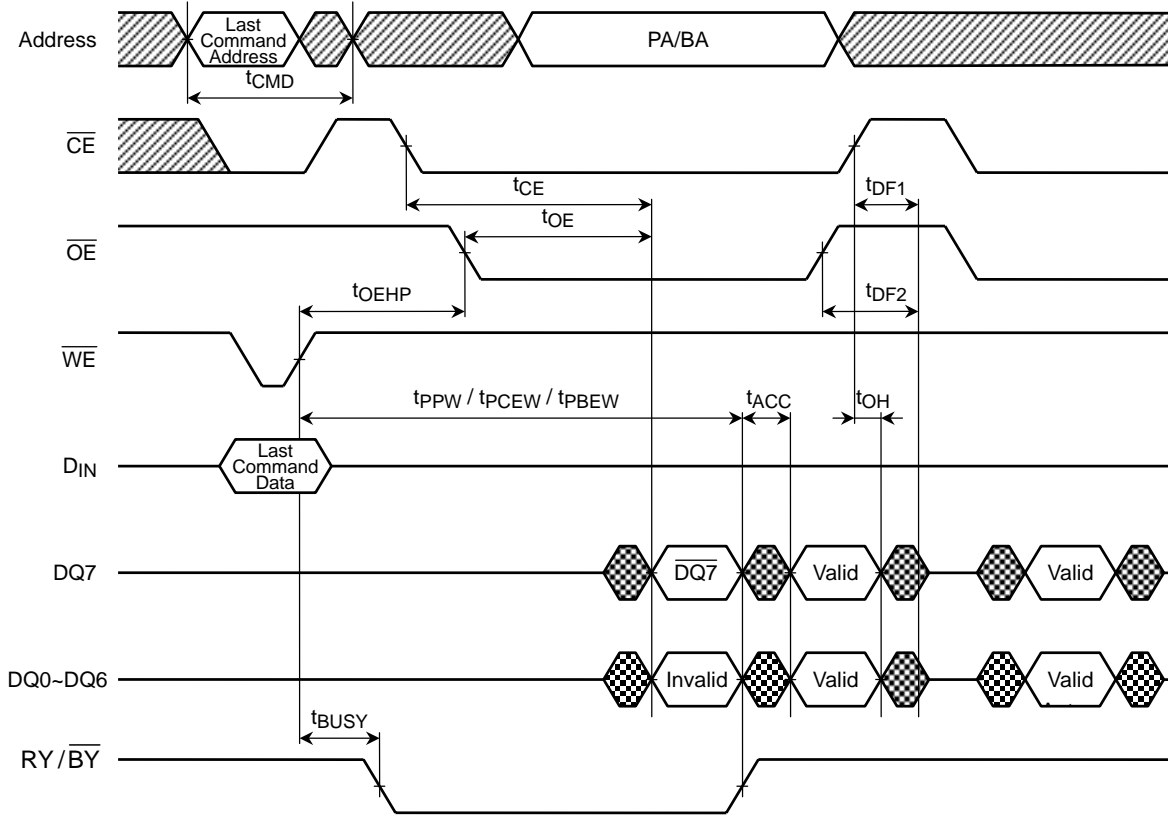
Read after RESET



Software Reset Operation (At the Auto Operation failure)

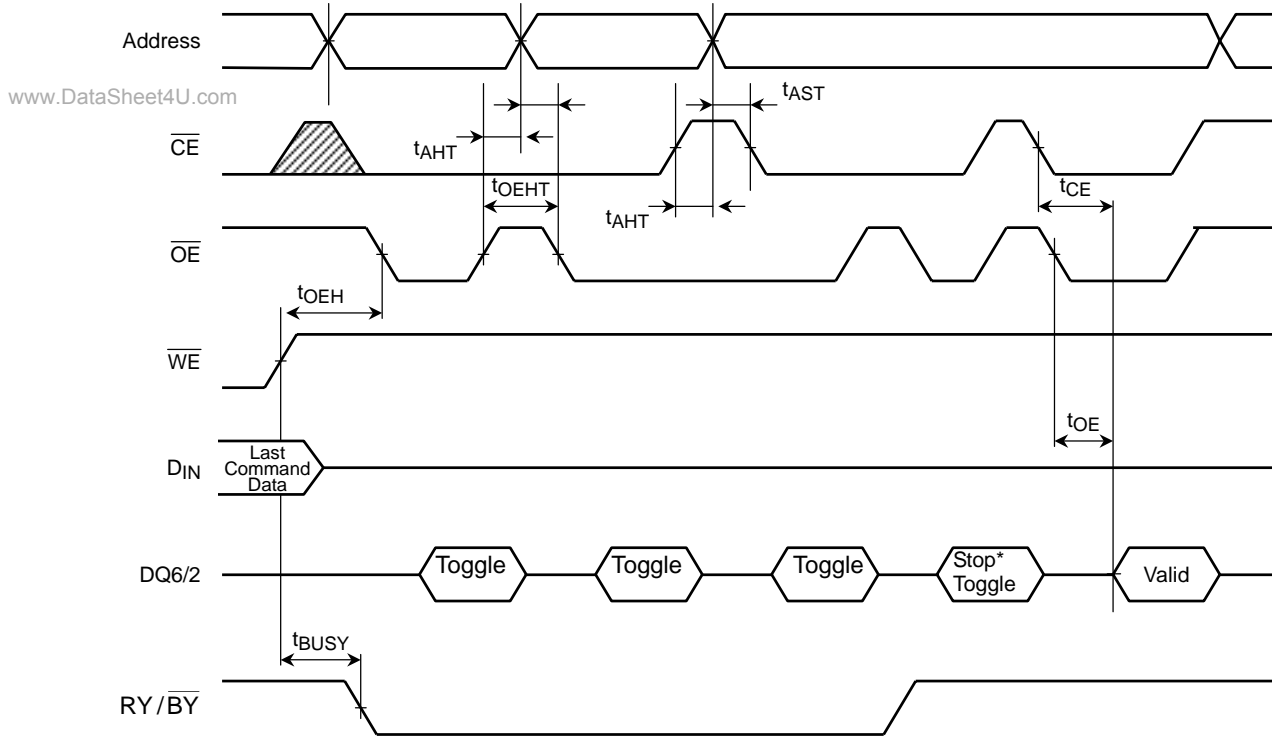


Hardware Sequence Flag ($\overline{\text{DATA}}$ Polling)



- Notes. 1. PA: Program address
2. BA: Block address

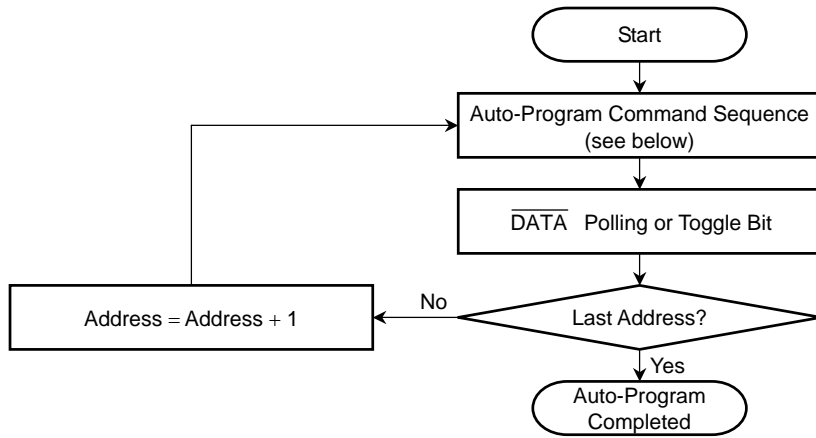
Hardware Sequence Flag (Toggle bit)



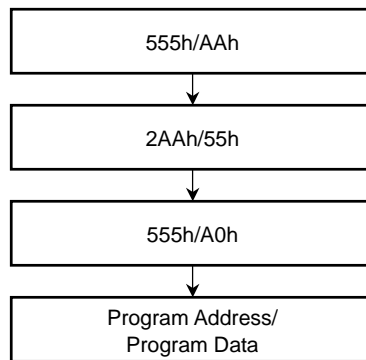
*DQ2/DQ6 stops toggling when auto operation has been completed.

10. FLOW CHARTS

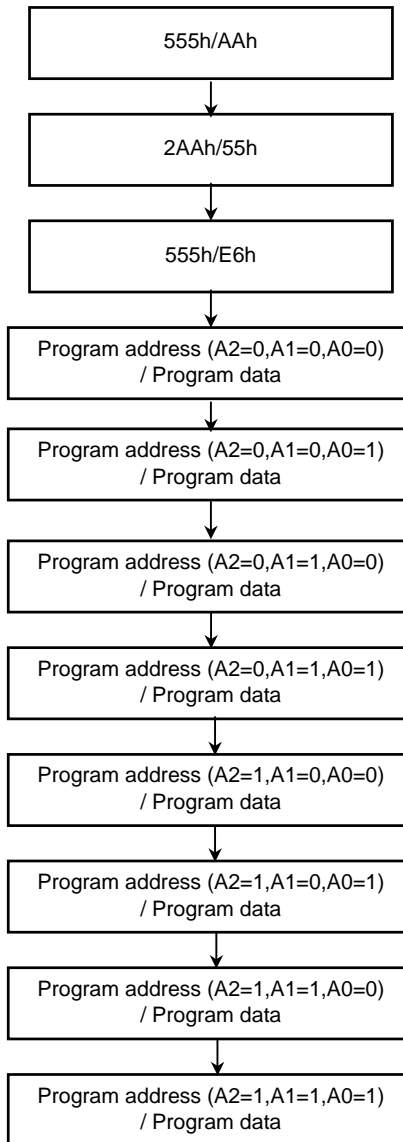
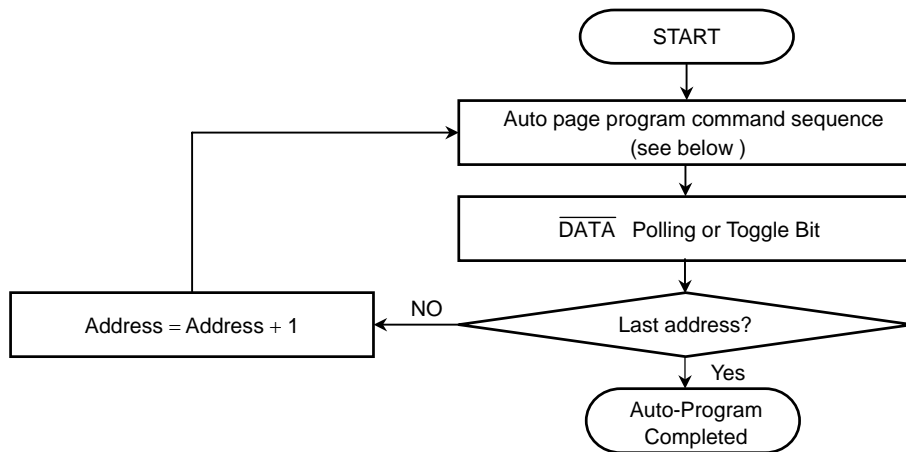
Auto-Program



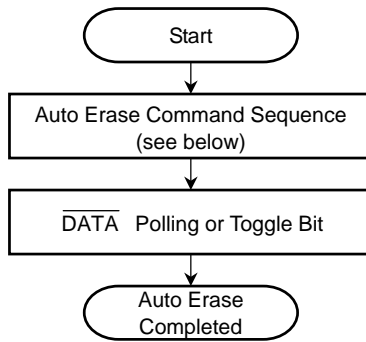
Auto-Program Command Sequence (address/data)



Auto-Page Program



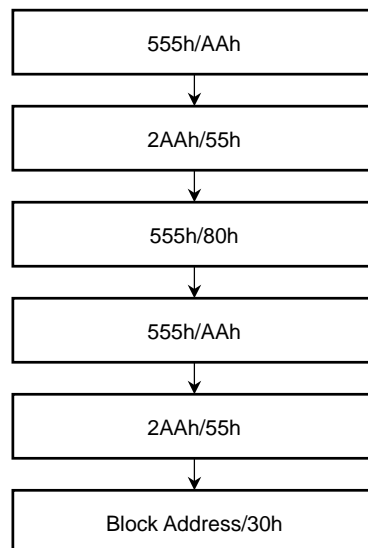
Auto Erase



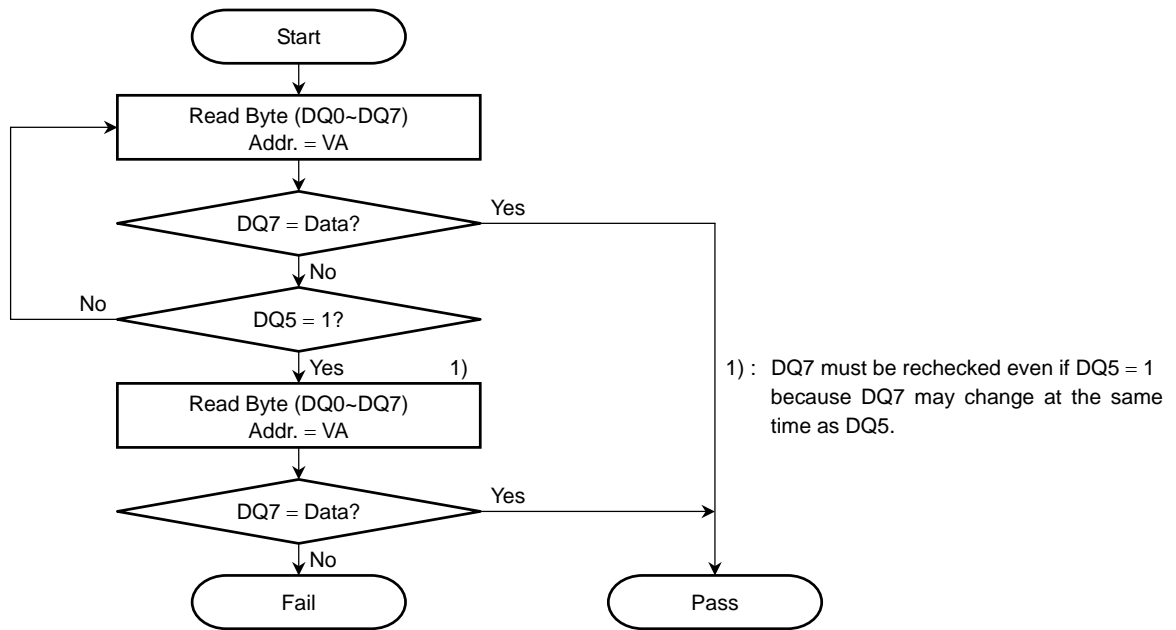
Auto Chip Erase Command Sequence
(address/data)



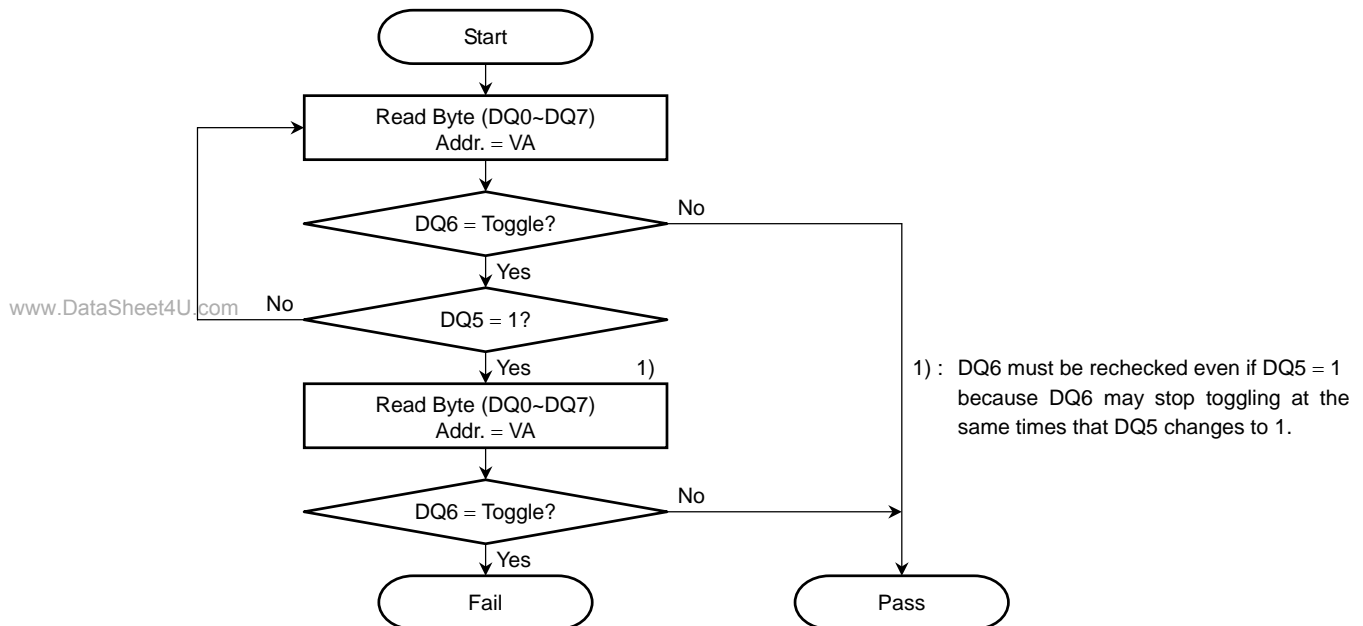
Auto Block Erase Command Sequence
(address/data)



DQ7 DATA Polling



DQ6 Toggle Bit

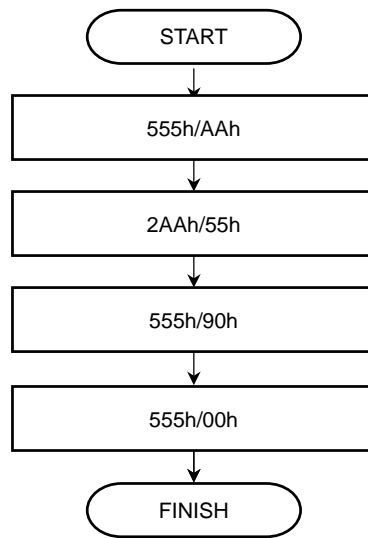


VA: Valid address for programming

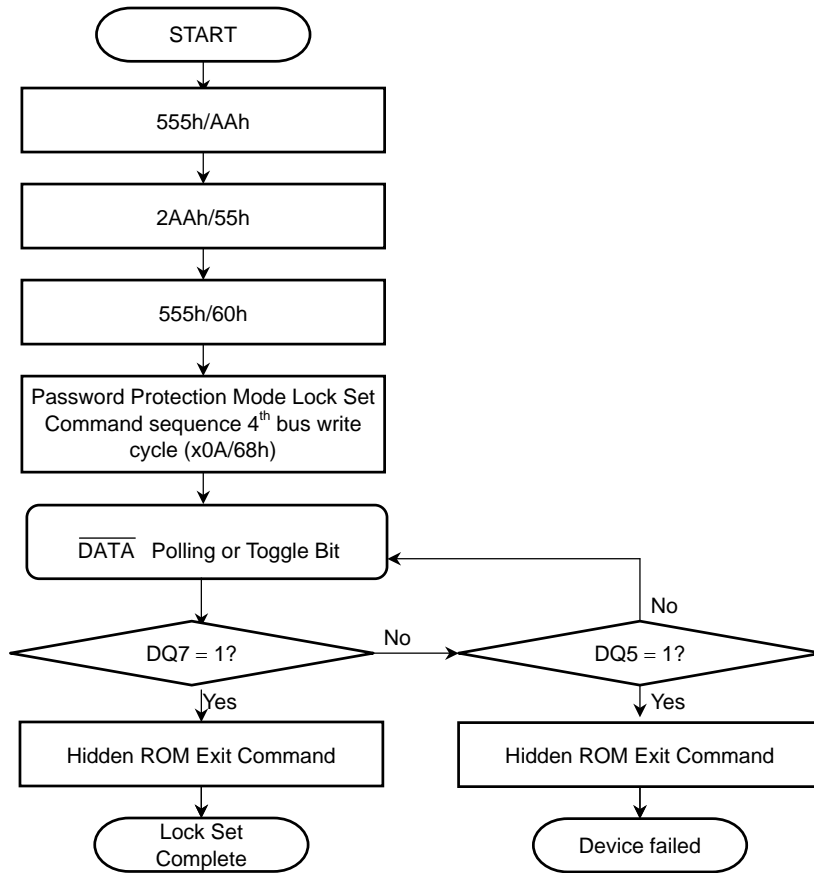
Any of the addresses within the block being erased during a Block Erase operation

"Don't care" during a Chip Erase operation

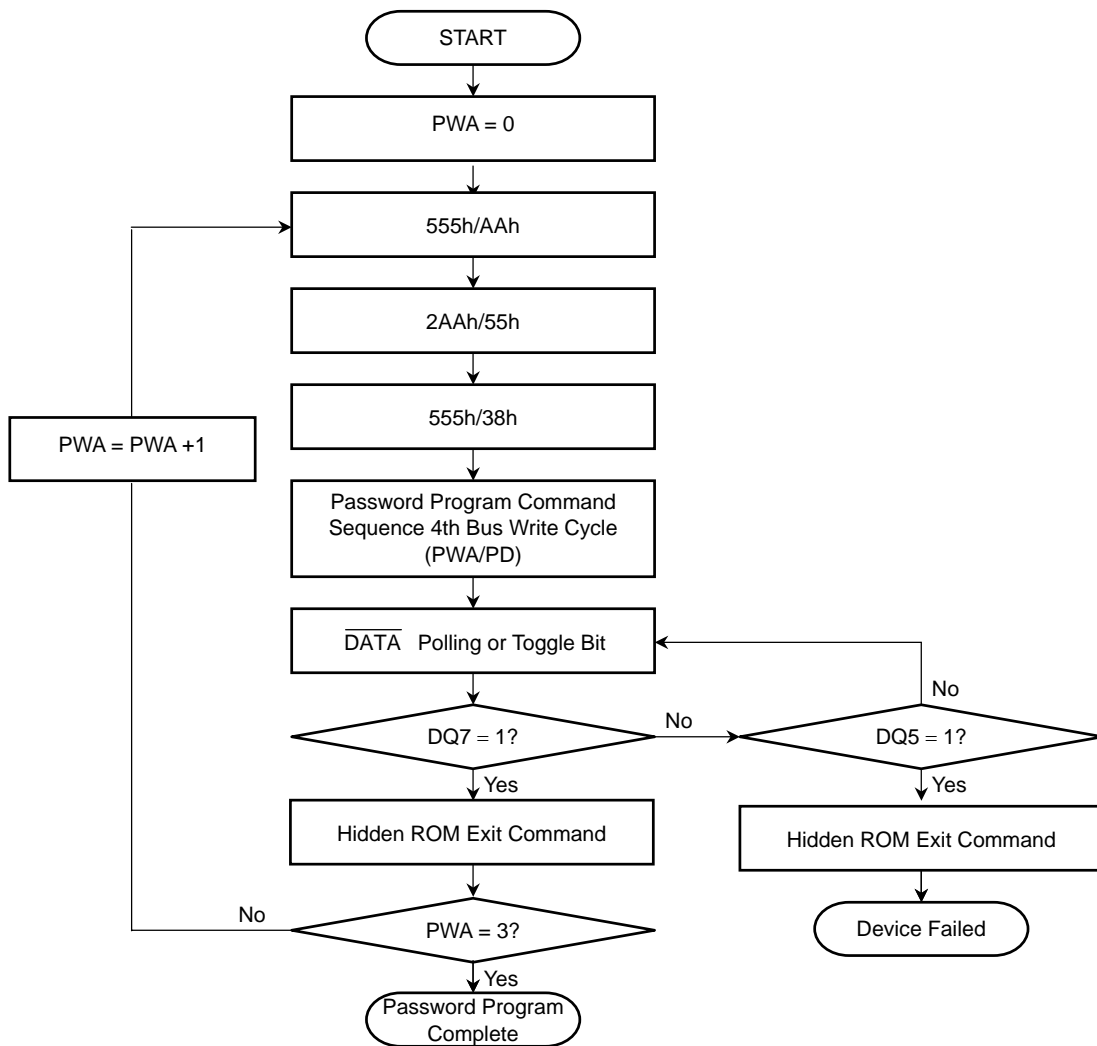
Hidden ROM Exit Command Input



Password Protection Mode Locking Set Operation



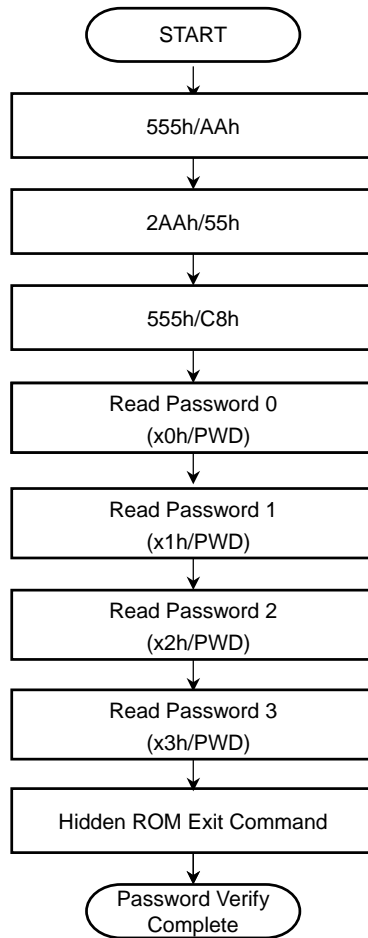
Password Program Operation



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- PWA/PD: Password Address / Password Program Data
- XX0h/PD0 (PD0: Data of 1-16 bits in password (64bits))
 - XX1h/PD1 (PD1: Data of 17-32 bits in password (64bits))
 - XX2h/PD2 (PD2: Data of 33-48 bits in password (64bits))
 - XX3h/PD3 (PD3: Data of 49-64 bits in password (64bits))

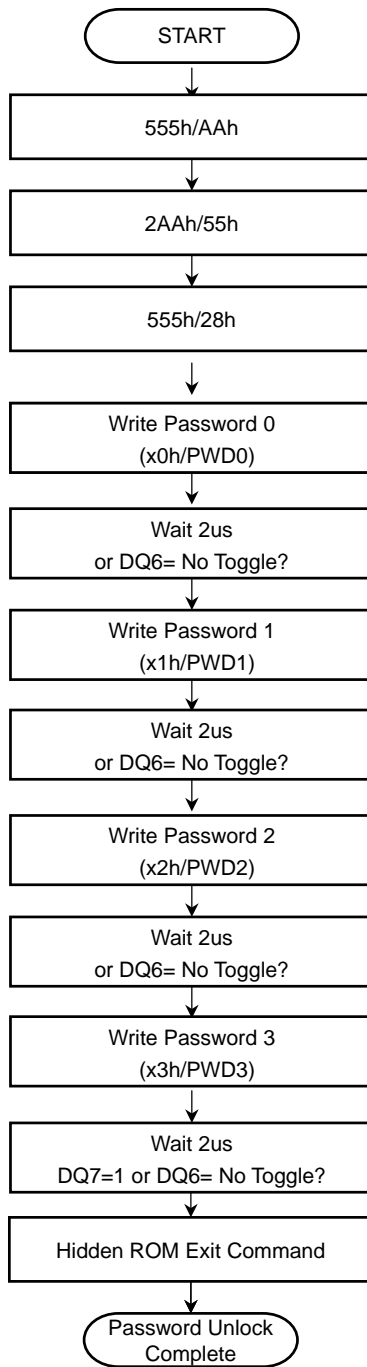
Password Verify Operation



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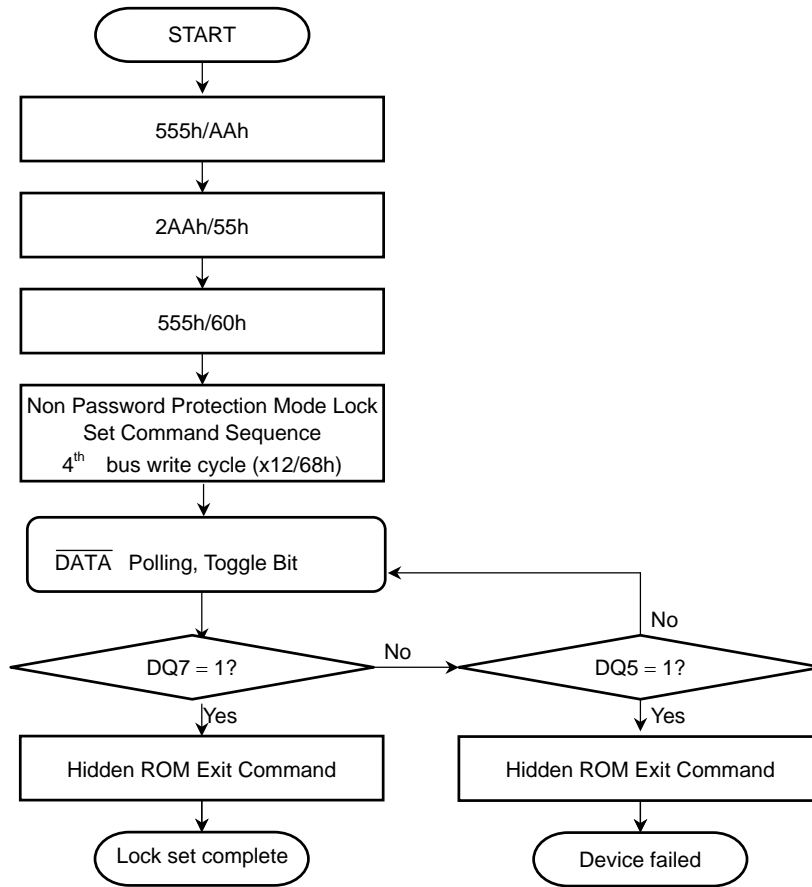
PWD: Password Output Data
PDW0: Data of 1-16 bits in password (64bits)
PDW1: Data of 17-32 bits in password (64bits)
PDW2: Data of 33-48 bits in password (64bits)
PDW3: Data of 49-64 bits in password (64bits)

Password Unlock Command Operation

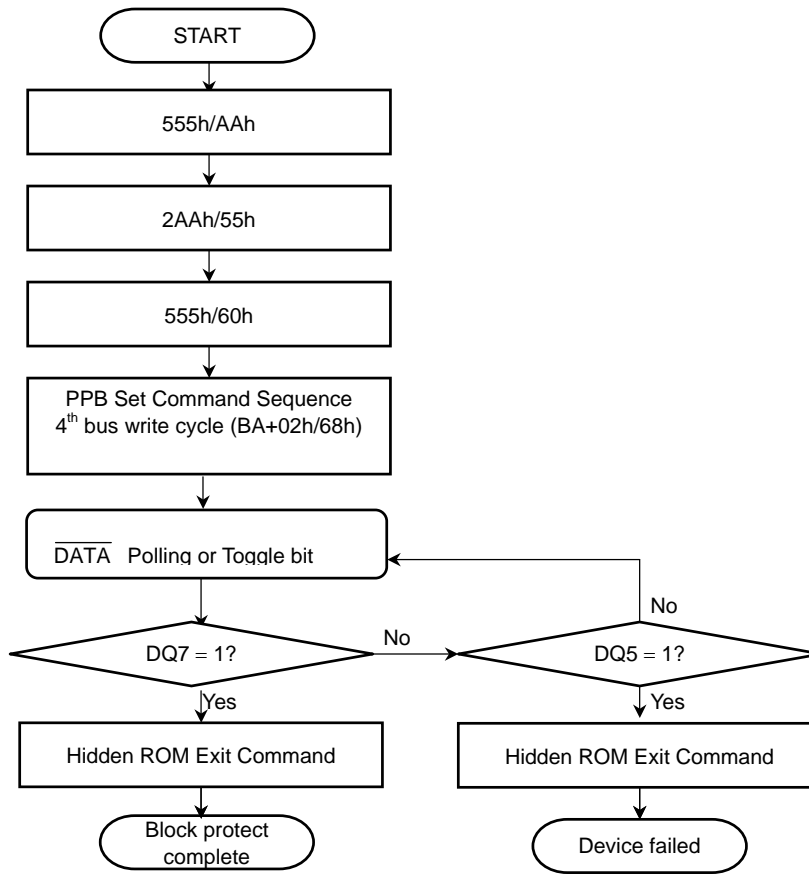


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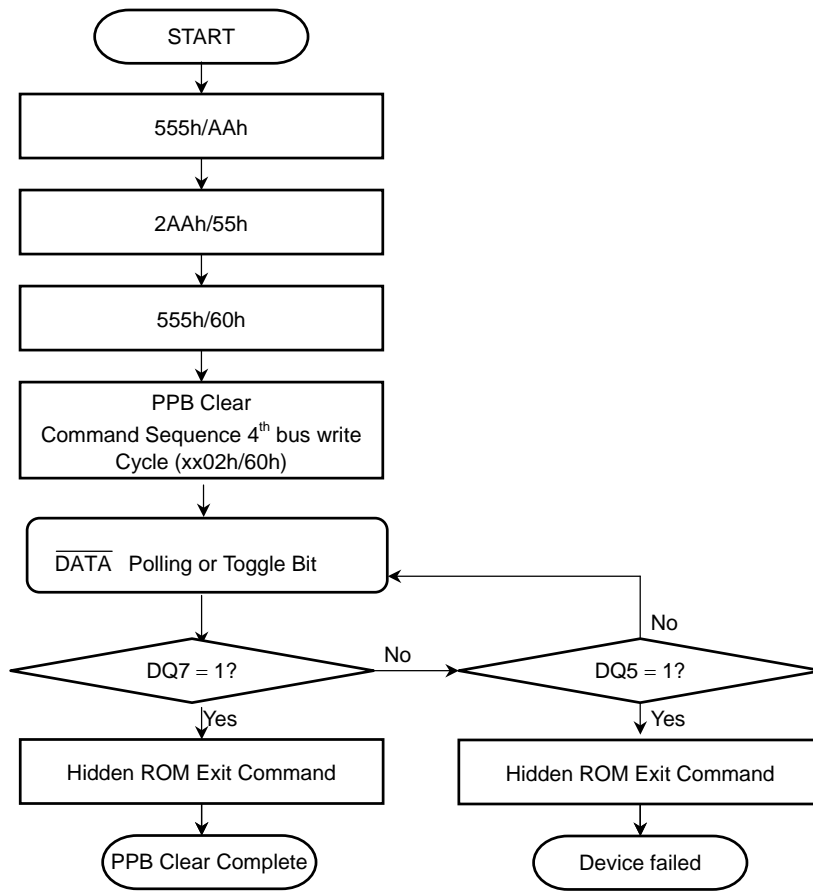
Non-Password Protection Mode Locking Set Operation



PPB Set Command Sequence

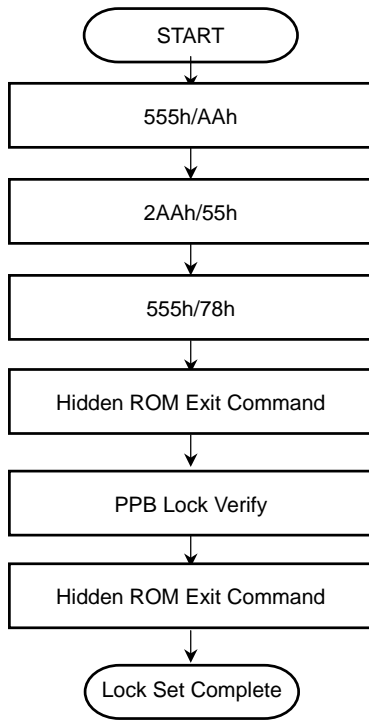


PPB Clear Command Sequence

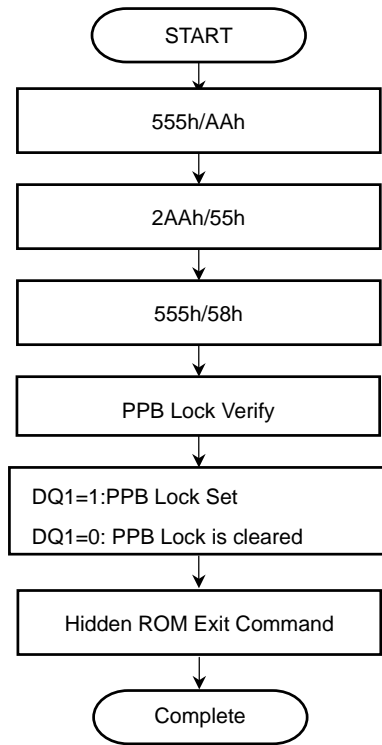


PPB Lock Operation

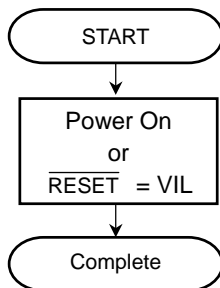
PPB Lock Set



PPB Lock Verify

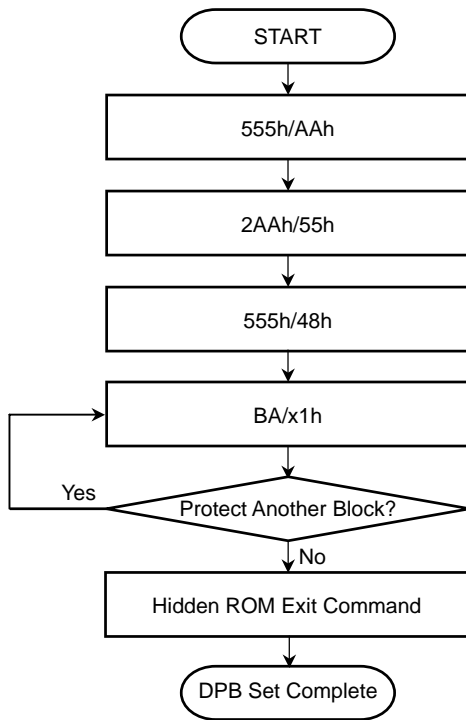


PPB Lock Clear

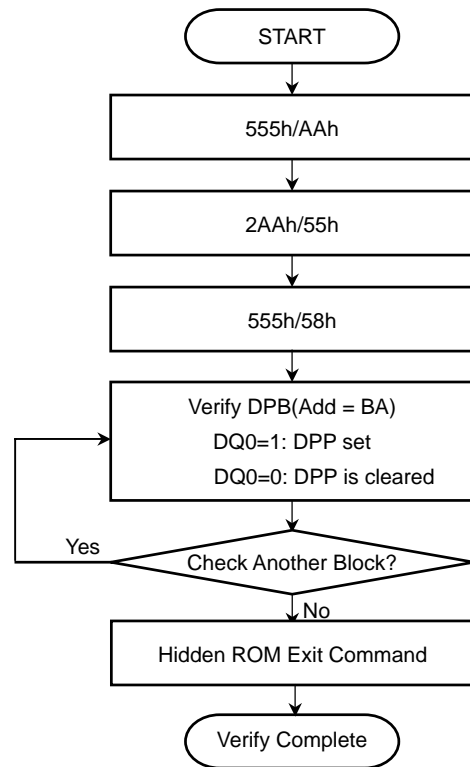


DPB Command Operation

DPB Set

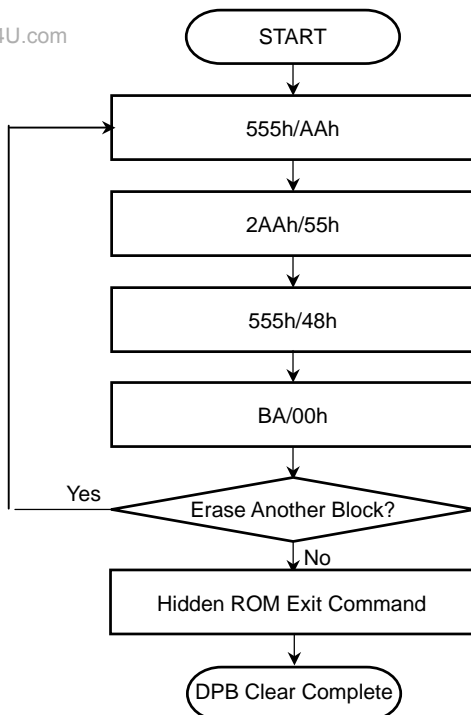


DPB Verify

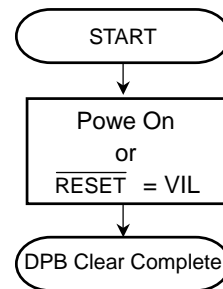


DPB Clear 1

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DPB Clear 2



11. BLOCK ADDRESS TABLES

* : V_{IH} or V_{IL}

11.1. TC58FYM8T7D (Top boot block) 1/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK0	BA0	L	L	L	L	L	L	L	L	*	*	*	00000h~00FFFFh
	BA1	L	L	L	L	L	L	L	H	*	*	*	010000h~01FFFFh
	BA2	L	L	L	L	L	L	H	L	*	*	*	020000h~02FFFFh
	BA3	L	L	L	L	L	L	H	H	*	*	*	030000h~03FFFFh
	BA4	L	L	L	L	L	H	L	L	*	*	*	040000h~04FFFFh
	BA5	L	L	L	L	L	H	L	H	*	*	*	050000h~05FFFFh
	BA6	L	L	L	L	L	H	H	L	*	*	*	060000h~06FFFFh
	BA7	L	L	L	L	L	H	H	H	*	*	*	070000h~07FFFFh
	BA8	L	L	L	L	H	L	L	L	*	*	*	080000h~08FFFFh
	BA9	L	L	L	L	H	L	L	H	*	*	*	090000h~09FFFFh
	BA10	L	L	L	L	H	L	H	L	*	*	*	0A0000h~0AFFFFh
	BA11	L	L	L	L	H	L	H	H	*	*	*	0B0000h~0BFFFFh
	BA12	L	L	L	L	H	H	L	L	*	*	*	0C0000h~0CFFFFh
	BA13	L	L	L	L	H	H	L	H	*	*	*	0D0000h~0DFFFFh
	BA14	L	L	L	L	H	H	H	L	*	*	*	0E0000h~0EFFFFh
BA15	L	L	L	L	H	H	H	H	*	*	*	0F0000h~0FFFFFh	
BK1	BA16	L	L	L	H	L	L	L	L	*	*	*	100000h~10FFFFh
	BA17	L	L	L	H	L	L	L	H	*	*	*	110000h~11FFFFh
	BA18	L	L	L	H	L	L	H	L	*	*	*	120000h~12FFFFh
	BA19	L	L	L	H	L	L	H	H	*	*	*	130000h~13FFFFh
	BA20	L	L	L	H	L	H	L	L	*	*	*	140000h~14FFFFh
	BA21	L	L	L	H	L	H	L	H	*	*	*	150000h~15FFFFh
	BA22	L	L	L	H	L	H	H	L	*	*	*	160000h~16FFFFh
	BA23	L	L	L	H	L	H	H	H	*	*	*	170000h~17FFFFh
	BA24	L	L	L	H	H	L	L	L	*	*	*	180000h~18FFFFh
	BA25	L	L	L	H	H	L	L	L	*	*	*	190000h~19FFFFh
	BA26	L	L	L	H	H	L	H	H	*	*	*	1A0000h~1AFFFFh
	BA27	L	L	L	H	H	L	H	H	*	*	*	1B0000h~1BFFFFh
	BA28	L	L	L	H	H	H	L	L	*	*	*	1C0000h~1CFFFFh
	BA29	L	L	L	H	H	H	L	L	*	*	*	1D0000h~1DFFFFh
	BA30	L	L	L	H	H	H	H	H	*	*	*	1E0000h~1EFFFFh
	BA31	L	L	L	H	H	H	H	H	*	*	*	1F0000h~1FFFFFh

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11.1. TC58FYM8T7D (Top boot block) 2/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK2	BA32	L	L	H	L	L	L	L	L	*	*	*	200000h~20FFFFh
	BA33	L	L	H	L	L	L	L	H	*	*	*	210000h~21FFFFh
	BA34	L	L	H	L	L	L	H	L	*	*	*	220000h~22FFFFh
	BA35	L	L	H	L	L	L	H	H	*	*	*	230000h~23FFFFh
	BA36	L	L	H	L	L	H	L	L	*	*	*	240000h~24FFFFh
	BA37	L	L	H	L	L	H	L	H	*	*	*	250000h~25FFFFh
	BA38	L	L	H	L	L	H	H	L	*	*	*	260000h~26FFFFh
	BA39	L	L	H	L	L	H	H	H	*	*	*	270000h~27FFFFh
	BA40	L	L	H	L	H	L	L	L	*	*	*	280000h~28FFFFh
	BA41	L	L	H	L	H	L	L	H	*	*	*	290000h~29FFFFh
	BA42	L	L	H	L	H	L	H	L	*	*	*	2A0000h~2AFFFFh
	BA43	L	L	H	L	H	L	H	H	*	*	*	2B0000h~2BFFFFh
	BA44	L	L	H	L	H	H	L	L	*	*	*	2C0000h~2CFFFFh
	BA45	L	L	H	L	H	H	L	H	*	*	*	2D0000h~2DFFFFh
	BA46	L	L	H	L	H	H	H	L	*	*	*	2E0000h~2EFFFFh
	BA47	L	L	H	L	H	H	H	H	*	*	*	2F0000h~2FFFFh
BK3	BA48	L	L	H	H	L	L	L	L	*	*	*	300000h~30FFFFh
	BA49	L	L	H	H	L	L	L	H	*	*	*	310000h~31FFFFh
	BA50	L	L	H	H	L	L	H	L	*	*	*	320000h~32FFFFh
	BA51	L	L	H	H	L	L	H	H	*	*	*	330000h~33FFFFh
	BA52	L	L	H	H	L	H	L	L	*	*	*	340000h~34FFFFh
	BA53	L	L	H	H	L	H	L	H	*	*	*	350000h~35FFFFh
	BA54	L	L	H	H	L	H	H	L	*	*	*	360000h~36FFFFh
	BA55	L	L	H	H	L	H	H	H	*	*	*	370000h~37FFFFh
	BA56	L	L	H	H	H	L	L	L	*	*	*	380000h~38FFFFh
	BA57	L	L	H	H	H	L	L	H	*	*	*	390000h~39FFFFh
	BA58	L	L	H	H	H	L	H	L	*	*	*	3A0000h~3AFFFFh
	BA59	L	L	H	H	H	L	H	H	*	*	*	3B0000h~3BFFFFh
	BA60	L	L	H	H	H	H	L	L	*	*	*	3C0000h~3CFFFFh
	BA61	L	L	H	H	H	H	L	H	*	*	*	3D0000h~3DFFFFh
	BA62	L	L	H	H	H	H	H	L	*	*	*	3E0000h~3EFFFFh
	BA63	L	L	H	H	H	H	H	H	*	*	*	3F0000h~3FFFFh

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11.1. TC58FYM8T7D (Top boot block) 3/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK4	BA64	L	H	L	L	L	L	L	L	*	*	*	400000h~40FFFFh
	BA65	L	H	L	L	L	L	L	H	*	*	*	410000h~41FFFFh
	BA66	L	H	L	L	L	L	H	L	*	*	*	420000h~42FFFFh
	BA67	L	H	L	L	L	L	H	H	*	*	*	430000h~43FFFFh
	BA68	L	H	L	L	L	H	L	L	*	*	*	440000h~44FFFFh
	BA69	L	H	L	L	L	H	L	H	*	*	*	450000h~45FFFFh
	BA70	L	H	L	L	L	H	H	L	*	*	*	460000h~46FFFFh
	BA71	L	H	L	L	L	H	H	H	*	*	*	470000h~47FFFFh
	BA72	L	H	L	L	H	L	L	L	*	*	*	480000h~48FFFFh
	BA73	L	H	L	L	H	L	L	H	*	*	*	490000h~49FFFFh
	BA74	L	H	L	L	H	L	H	L	*	*	*	4A0000h~4AFFFFh
	BA75	L	H	L	L	H	L	H	H	*	*	*	4B0000h~4BFFFFh
	BA76	L	H	L	L	H	H	L	L	*	*	*	4C0000h~4CFFFFh
	BA77	L	H	L	L	H	H	L	H	*	*	*	4D0000h~4DFFFFh
	BA78	L	H	L	L	H	H	H	L	*	*	*	4E0000h~4EFFFFh
BA79	L	H	L	L	H	H	H	H	*	*	*	4F0000h~4FFFFFFh	
BK5	BA80	L	H	L	H	L	L	L	L	*	*	*	500000h~50FFFFh
	BA81	L	H	L	H	L	L	L	H	*	*	*	510000h~51FFFFh
	BA82	L	H	L	H	L	L	H	L	*	*	*	520000h~52FFFFh
	BA83	L	H	L	H	L	L	H	H	*	*	*	530000h~53FFFFh
	BA84	L	H	L	H	L	H	L	L	*	*	*	540000h~54FFFFh
	BA85	L	H	L	H	L	H	L	H	*	*	*	550000h~55FFFFh
	BA86	L	H	L	H	L	H	H	L	*	*	*	560000h~56FFFFh
	BA87	L	H	L	H	L	H	H	H	*	*	*	570000h~57FFFFh
	BA88	L	H	L	H	H	L	L	L	*	*	*	580000h~58FFFFh
	BA89	L	H	L	H	H	L	L	H	*	*	*	590000h~59FFFFh
	BA90	L	H	L	H	H	L	H	L	*	*	*	5A0000h~5AFFFFh
	BA91	L	H	L	H	H	L	H	H	*	*	*	5B0000h~5BFFFFh
	BA92	L	H	L	H	H	H	L	L	*	*	*	5C0000h~5CFFFFh
	BA93	L	H	L	H	H	H	L	H	*	*	*	5D0000h~5DFFFFh
	BA94	L	H	L	H	H	H	H	L	*	*	*	5E0000h~5EFFFFh
	BA95	L	H	L	H	H	H	H	H	*	*	*	5F0000h~5FFFFFFh

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11.1. TC58FYM8T7D (Top boot block) 4/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK6	BA96	L	H	H	L	L	L	L	L	*	*	*	600000h~60FFFFh
	BA97	L	H	H	L	L	L	L	H	*	*	*	610000h~61FFFFh
	BA98	L	H	H	L	L	L	H	L	*	*	*	620000h~62FFFFh
	BA99	L	H	H	L	L	L	H	H	*	*	*	630000h~63FFFFh
	BA100	L	H	H	L	L	H	L	L	*	*	*	640000h~64FFFFh
	BA101	L	H	H	L	L	H	L	H	*	*	*	650000h~65FFFFh
	BA102	L	H	H	L	L	H	H	L	*	*	*	660000h~66FFFFh
	BA103	L	H	H	L	L	H	H	H	*	*	*	670000h~67FFFFh
	BA104	L	H	H	L	H	L	L	L	*	*	*	680000h~68FFFFh
	BA105	L	H	H	L	H	L	L	H	*	*	*	690000h~69FFFFh
	BA106	L	H	H	L	H	L	H	L	*	*	*	6A0000h~6AFFFFh
	BA107	L	H	H	L	H	L	H	H	*	*	*	6B0000h~6BFFFFh
	BA108	L	H	H	L	H	H	L	L	*	*	*	6C0000h~6CFFFFh
	BA109	L	H	H	L	H	H	L	H	*	*	*	6D0000h~6DFFFFh
BA110	L	H	H	L	H	H	H	L	*	*	*	6E0000h~6EFFFFh	
BA111	L	H	H	L	H	H	H	H	*	*	*	6F0000h~6FFFFFh	
BK7	BA112	L	H	H	H	L	L	L	L	*	*	*	700000h~70FFFFh
	BA113	L	H	H	H	L	L	L	H	*	*	*	710000h~71FFFFh
	BA114	L	H	H	H	L	L	H	L	*	*	*	720000h~72FFFFh
	BA115	L	H	H	H	L	L	H	H	*	*	*	730000h~73FFFFh
	BA116	L	H	H	H	L	H	L	L	*	*	*	740000h~74FFFFh
	BA117	L	H	H	H	L	H	L	H	*	*	*	750000h~75FFFFh
	BA118	L	H	H	H	L	H	H	L	*	*	*	760000h~76FFFFh
	BA119	L	H	H	H	L	H	H	H	*	*	*	770000h~77FFFFh
	BA120	L	H	H	H	H	L	L	L	*	*	*	780000h~78FFFFh
	BA121	L	H	H	H	H	L	L	H	*	*	*	790000h~79FFFFh
	BA122	L	H	H	H	H	L	H	L	*	*	*	7A0000h~7AFFFFh
	BA123	L	H	H	H	H	L	H	H	*	*	*	7B0000h~7BFFFFh
	BA124	L	H	H	H	H	H	L	L	*	*	*	7C0000h~7CFFFFh
	BA125	L	H	H	H	H	H	L	H	*	*	*	7D0000h~7DFFFFh
BA126	L	H	H	H	H	H	H	L	*	*	*	7E0000h~7EFFFFh	
BA127	L	H	H	H	H	H	H	H	*	*	*	7F0000h~7FFFFFh	

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11.1. TC58FYM8T7D (Top boot block) 5/9

Bank #	Block #	Block Address											Address Range	
		Bank Address				A19	A18	A17	A16	A15	A14	A13		
		A23	A22	A21	A20								Word mode	
BK8	BA128	H	L	L	L	L	L	L	L	*	*	*	800000h~80FFFFh	
	BA129	H	L	L	L	L	L	L	H	*	*	*	810000h~81FFFFh	
	BA130	H	L	L	L	L	L	L	H	L	*	*	*	820000h~82FFFFh
	BA131	H	L	L	L	L	L	L	H	H	*	*	*	830000h~83FFFFh
	BA132	H	L	L	L	L	L	H	L	L	*	*	*	840000h~84FFFFh
	BA133	H	L	L	L	L	L	H	L	H	*	*	*	850000h~85FFFFh
	BA134	H	L	L	L	L	L	H	H	L	*	*	*	860000h~86FFFFh
	BA135	H	L	L	L	L	L	H	H	H	*	*	*	870000h~87FFFFh
	BA136	H	L	L	L	L	H	L	L	L	*	*	*	880000h~88FFFFh
	BA137	H	L	L	L	L	H	L	L	H	*	*	*	890000h~89FFFFh
	BA138	H	L	L	L	L	H	L	H	L	*	*	*	8A0000h~8AFFFFh
	BA139	H	L	L	L	L	H	L	H	H	*	*	*	8B0000h~8BFFFFh
	BA140	H	L	L	L	L	H	H	L	L	*	*	*	8C0000h~8CFFFFh
	BA141	H	L	L	L	L	H	H	L	H	*	*	*	8D0000h~8DFFFFh
	BA142	H	L	L	L	L	H	H	H	L	*	*	*	8E0000h~8EFFFFh
BA143	H	L	L	L	L	H	H	H	H	*	*	*	8F0000h~8FFFFh	
BK9	BA144	H	L	L	H	L	L	L	L	*	*	*	900000h~90FFFFh	
	BA145	H	L	L	H	L	L	L	H	*	*	*	910000h~91FFFFh	
	BA146	H	L	L	H	L	L	H	L	*	*	*	920000h~92FFFFh	
	BA147	H	L	L	H	L	L	H	H	*	*	*	930000h~93FFFFh	
	BA148	H	L	L	H	L	H	L	L	*	*	*	940000h~94FFFFh	
	BA149	H	L	L	H	L	H	L	H	*	*	*	950000h~95FFFFh	
	BA150	H	L	L	H	L	H	H	L	*	*	*	960000h~96FFFFh	
	BA151	H	L	L	H	L	H	H	H	*	*	*	970000h~97FFFFh	
	BA152	H	L	L	H	H	L	L	L	*	*	*	980000h~98FFFFh	
	BA153	H	L	L	H	H	L	L	L	*	*	*	990000h~99FFFFh	
	BA154	H	L	L	H	H	L	H	H	*	*	*	9A0000h~9AFFFFh	
	BA155	H	L	L	H	H	L	H	H	*	*	*	9B0000h~9BFFFFh	
	BA156	H	L	L	H	H	H	L	L	*	*	*	9C0000h~9CFFFFh	
	BA157	H	L	L	H	H	H	L	L	*	*	*	9D0000h~9DFFFFh	
	BA158	H	L	L	H	H	H	H	H	*	*	*	9E0000h~9EFFFFh	
	BA159	H	L	L	H	H	H	H	H	*	*	*	9F0000h~9FFFFh	

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11.1. TC58FYM8T7D (Top boot block) 6/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK10	BA160	H	L	H	L	L	L	L	L	*	*	*	A00000h~A0FFFFh
	BA161	H	L	H	L	L	L	L	H	*	*	*	A10000h~A1FFFFh
	BA162	H	L	H	L	L	L	H	L	*	*	*	A20000h~A2FFFFh
	BA163	H	L	H	L	L	L	H	H	*	*	*	A30000h~A3FFFFh
	BA164	H	L	H	L	L	H	L	L	*	*	*	A40000h~A4FFFFh
	BA165	H	L	H	L	L	H	L	H	*	*	*	A50000h~A5FFFFh
	BA166	H	L	H	L	L	H	H	L	*	*	*	A60000h~A6FFFFh
	BA167	H	L	H	L	L	H	H	H	*	*	*	A70000h~A7FFFFh
	BA168	H	L	H	L	H	L	L	L	*	*	*	A80000h~A8FFFFh
	BA169	H	L	H	L	H	L	L	H	*	*	*	A90000h~A9FFFFh
	BA170	H	L	H	L	H	L	H	L	*	*	*	AA0000h~AAFFFFh
	BA171	H	L	H	L	H	L	H	H	*	*	*	AB0000h~ABFFFFh
	BA172	H	L	H	L	H	H	L	L	*	*	*	AC0000h~ACFFFFh
	BA173	H	L	H	L	H	H	L	H	*	*	*	AD0000h~ADFFFFh
	BA174	H	L	H	L	H	H	H	L	*	*	*	AE0000h~AEFFFFh
BA175	H	L	H	L	H	H	H	H	*	*	*	AF0000h~AFFFFFh	
BK11	BA176	H	L	H	H	L	L	L	L	*	*	*	B00000h~B0FFFFh
	BA177	H	L	H	H	L	L	L	H	*	*	*	B10000h~B1FFFFh
	BA178	H	L	H	H	L	L	H	L	*	*	*	B20000h~B2FFFFh
	BA179	H	L	H	H	L	L	H	H	*	*	*	B30000h~B3FFFFh
	BA180	H	L	H	H	L	H	L	L	*	*	*	B40000h~B4FFFFh
	BA181	H	L	H	H	L	H	L	H	*	*	*	B50000h~B5FFFFh
	BA182	H	L	H	H	L	H	H	L	*	*	*	B60000h~B6FFFFh
	BA183	H	L	H	H	L	H	H	H	*	*	*	B70000h~B7FFFFh
	BA184	H	L	H	H	H	L	L	L	*	*	*	B80000h~B8FFFFh
	BA185	H	L	H	H	H	L	L	H	*	*	*	B90000h~B9FFFFh
	BA186	H	L	H	H	H	L	H	L	*	*	*	BA0000h~BAFFFFh
	BA187	H	L	H	H	H	L	H	H	*	*	*	BB0000h~BBFFFFh
	BA188	H	L	H	H	H	H	L	L	*	*	*	BC0000h~BCFFFFh
	BA189	H	L	H	H	H	H	L	H	*	*	*	BD0000h~BDFFFFh
	BA190	H	L	H	H	H	H	H	L	*	*	*	BE0000h~BEFFFFh
BA191	H	L	H	H	H	H	H	H	*	*	*	BF0000h~BFFFFFFh	

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11.1. TC58FYM8T7D (Top boot block) 7/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK12	BA192	H	H	L	L	L	L	L	L	*	*	*	C00000h~C0FFFFh
	BA193	H	H	L	L	L	L	L	H	*	*	*	C10000h~C1FFFFh
	BA194	H	H	L	L	L	L	H	L	*	*	*	C20000h~C2FFFFh
	BA195	H	H	L	L	L	L	H	H	*	*	*	C30000h~C3FFFFh
	BA196	H	H	L	L	L	H	L	L	*	*	*	C40000h~C4FFFFh
	BA197	H	H	L	L	L	H	L	H	*	*	*	C50000h~C5FFFFh
	BA198	H	H	L	L	L	H	H	L	*	*	*	C60000h~C6FFFFh
	BA199	H	H	L	L	L	H	H	H	*	*	*	C70000h~C7FFFFh
	BA200	H	H	L	L	H	L	L	L	*	*	*	C80000h~C8FFFFh
	BA201	H	H	L	L	H	L	L	H	*	*	*	C90000h~C9FFFFh
	BA202	H	H	L	L	H	L	H	L	*	*	*	CA0000h~CAFFFFh
	BA203	H	H	L	L	H	L	H	H	*	*	*	CB0000h~CBFFFFh
	BA204	H	H	L	L	H	H	L	L	*	*	*	CC0000h~CCFFFFh
	BA205	H	H	L	L	H	H	L	H	*	*	*	CD0000h~CDFFFFh
	BA206	H	H	L	L	H	H	H	L	*	*	*	CE0000h~CEFFFFh
BA207	H	H	L	L	H	H	H	H	*	*	*	CF0000h~CFFFFFh	
BK13	BA208	H	H	L	H	L	L	L	L	*	*	*	D00000h~D0FFFFh
	BA209	H	H	L	H	L	L	L	H	*	*	*	D10000h~D1FFFFh
	BA210	H	H	L	H	L	L	H	L	*	*	*	D20000h~D2FFFFh
	BA211	H	H	L	H	L	L	H	H	*	*	*	D30000h~D3FFFFh
	BA212	H	H	L	H	L	H	L	L	*	*	*	D40000h~D4FFFFh
	BA213	H	H	L	H	L	H	L	H	*	*	*	D50000h~D5FFFFh
	BA214	H	H	L	H	L	H	H	L	*	*	*	D60000h~D6FFFFh
	BA215	H	H	L	H	L	H	H	H	*	*	*	D70000h~D7FFFFh
	BA216	H	H	L	H	H	L	L	L	*	*	*	D80000h~D8FFFFh
	BA217	H	H	L	H	H	L	L	H	*	*	*	D90000h~D9FFFFh
	BA218	H	H	L	H	H	L	H	L	*	*	*	DA0000h~DAFFFFh
	BA219	H	H	L	H	H	L	H	H	*	*	*	DB0000h~DBFFFFh
	BA220	H	H	L	H	H	H	L	L	*	*	*	DC0000h~DCFFFFh
	BA221	H	H	L	H	H	H	L	H	*	*	*	DD0000h~DDFFFFh
	BA222	H	H	L	H	H	H	H	L	*	*	*	DE0000h~DEFFFFh
	BA223	H	H	L	H	H	H	H	H	*	*	*	DF0000h~DFFFFFh

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11.1. TC58FYM8T7D (Top boot block) 8/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK14	BA224	H	H	H	L	L	L	L	L	*	*	*	E0000h~E0FFFFh
	BA225	H	H	H	L	L	L	L	H	*	*	*	E10000h~E1FFFFh
	BA226	H	H	H	L	L	L	H	L	*	*	*	E20000h~E2FFFFh
	BA227	H	H	H	L	L	L	H	H	*	*	*	E30000h~E3FFFFh
	BA228	H	H	H	L	L	H	L	L	*	*	*	E40000h~E4FFFFh
	BA229	H	H	H	L	L	H	L	H	*	*	*	E50000h~E5FFFFh
	BA230	H	H	H	L	L	H	H	L	*	*	*	E60000h~E6FFFFh
	BA231	H	H	H	L	L	H	H	H	*	*	*	E70000h~E7FFFFh
	BA232	H	H	H	L	H	L	L	L	*	*	*	E80000h~E8FFFFh
	BA233	H	H	H	L	H	L	L	H	*	*	*	E90000h~E9FFFFh
	BA234	H	H	H	L	H	L	H	L	*	*	*	EA0000h~EAFFFFh
	BA235	H	H	H	L	H	L	H	H	*	*	*	EB0000h~EBFFFFh
	BA236	H	H	H	L	H	H	L	L	*	*	*	EC0000h~ECFFFFh
	BA237	H	H	H	L	H	H	L	H	*	*	*	ED0000h~EDFFFFh
	BA238	H	H	H	L	H	H	H	L	*	*	*	EE0000h~EEFFFFh
BA239	H	H	H	L	H	H	H	H	*	*	*	EF0000h~EFFFFFh	
BA15	BA240	H	H	H	H	L	L	L	L	*	*	*	F0000h~F0FFFFh
	BA241	H	H	H	H	L	L	L	H	*	*	*	F10000h~F1FFFFh
	BA242	H	H	H	H	L	L	H	L	*	*	*	F20000h~F2FFFFh
	BA243	H	H	H	H	L	L	H	H	*	*	*	F30000h~F3FFFFh
	BA244	H	H	H	H	L	H	L	L	*	*	*	F40000h~F4FFFFh
	BA245	H	H	H	H	L	H	L	H	*	*	*	F50000h~F5FFFFh
	BA246	H	H	H	H	L	H	H	L	*	*	*	F60000h~F6FFFFh
	BA247	H	H	H	H	L	H	H	H	*	*	*	F70000h~F7FFFFh
	BA248	H	H	H	H	H	L	L	L	*	*	*	F80000h~F8FFFFh
	BA249	H	H	H	H	H	L	L	H	*	*	*	F90000h~F9FFFFh
	BA250	H	H	H	H	H	L	H	L	*	*	*	FA0000h~FAFFFFh
	BA251	H	H	H	H	H	L	H	H	*	*	*	FB0000h~FBFFFFh
	BA252	H	H	H	H	H	H	L	L	*	*	*	FC0000h~FCFFFFh
	BA253	H	H	H	H	H	H	L	H	*	*	*	FD0000h~FDFFFFh
	BA254	H	H	H	H	H	H	H	L	*	*	*	FE0000h~FEFFFFh

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11.1. TC58FYM8T7D (Top boot block) 9/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	Word mode
		A23	A22	A21	A20								
BK15	BA255	H	H	H	H	H	H	H	H	L	L	L	FF0000h~FF1FFFh
	BA256	H	H	H	H	H	H	H	H	L	L	H	FF2000h~FF3FFFh
	BA257	H	H	H	H	H	H	H	H	L	H	L	FF4000h~FF5FFFh
	BA258	H	H	H	H	H	H	H	H	L	H	H	FF6000h~FF7FFFh
	BA259	H	H	H	H	H	H	H	H	H	L	L	FF8000h~FF9FFFh
	BA260	H	H	H	H	H	H	H	H	H	L	H	FFA000h~FFBFFFh
	BA261	H	H	H	H	H	H	H	H	H	H	L	FFC000h~FFDFFFh
	BA262	H	H	H	H	H	H	H	H	H	H	H	FFE000h~FFFFFh

11.2. TC58FYM8B7D (Bottom boot block) 1/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	Word mode
		A23	A22	A21	A20								
BK0	BA0	L	L	L	L	L	L	L	L	L	L	L	000000h~001FFFh
	BA1	L	L	L	L	L	L	L	L	L	L	H	002000h~003FFFh
	BA2	L	L	L	L	L	L	L	L	L	L	H	004000h~005FFFh
	BA3	L	L	L	L	L	L	L	L	L	L	H	006000h~007FFFh
	BA4	L	L	L	L	L	L	L	L	L	H	L	008000h~009FFFh
	BA5	L	L	L	L	L	L	L	L	L	H	L	00A000h~00BFFFh
	BA6	L	L	L	L	L	L	L	L	L	H	H	00C000h~00DFFFh
	BA7	L	L	L	L	L	L	L	L	L	H	H	00E000h~00FFFFh

11.2. TC58FYM8B7D (Bottom boot block) 2/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK0	BA8	L	L	L	L	L	L	L	H	*	*	*	010000h~01FFFFh
	BA9	L	L	L	L	L	L	H	L	*	*	*	020000h~02FFFFh
	BA10	L	L	L	L	L	L	H	H	*	*	*	030000h~03FFFFh
	BA11	L	L	L	L	L	H	L	L	*	*	*	040000h~04FFFFh
	BA12	L	L	L	L	L	H	L	H	*	*	*	050000h~05FFFFh
	BA13	L	L	L	L	L	H	H	L	*	*	*	060000h~06FFFFh
	BA14	L	L	L	L	L	H	H	H	*	*	*	070000h~07FFFFh
	BA15	L	L	L	L	H	L	L	L	*	*	*	080000h~08FFFFh
	BA16	L	L	L	L	H	L	L	H	*	*	*	090000h~09FFFFh
	BA17	L	L	L	L	H	L	H	L	*	*	*	0A0000h~0AFFFFh
	BA18	L	L	L	L	H	L	H	H	*	*	*	0B0000h~0BFFFFh
	BA19	L	L	L	L	H	H	L	L	*	*	*	0C0000h~0CFFFFh
	BA20	L	L	L	L	H	H	L	H	*	*	*	0D0000h~0DFFFFh
	BA21	L	L	L	L	H	H	H	L	*	*	*	0E0000h~0EFFFFh
BA22	L	L	L	L	H	H	H	H	*	*	*	0F0000h~0FFFFFh	
BK1	BA23	L	L	L	H	L	L	L	L	*	*	*	100000h~10FFFFh
	BA24	L	L	L	H	L	L	L	H	*	*	*	110000h~11FFFFh
	BA25	L	L	L	H	L	L	H	L	*	*	*	120000h~12FFFFh
	BA26	L	L	L	H	L	L	H	H	*	*	*	130000h~13FFFFh
	BA27	L	L	L	H	L	H	L	L	*	*	*	140000h~14FFFFh
	BA28	L	L	L	H	L	H	L	H	*	*	*	150000h~15FFFFh
	BA29	L	L	L	H	L	H	H	L	*	*	*	160000h~16FFFFh
	BA30	L	L	L	H	L	H	H	H	*	*	*	170000h~17FFFFh
	BA31	L	L	L	H	H	L	L	L	*	*	*	180000h~18FFFFh
	BA32	L	L	L	H	H	L	L	H	*	*	*	190000h~19FFFFh
	BA33	L	L	L	H	H	L	H	L	*	*	*	1A0000h~1AFFFFh
	BA34	L	L	L	H	H	L	H	H	*	*	*	1B0000h~1BFFFFh
	BA35	L	L	L	H	H	H	L	L	*	*	*	1C0000h~1CFFFFh
	BA36	L	L	L	H	H	H	L	H	*	*	*	1D0000h~1DFFFFh
	BA37	L	L	L	H	H	H	H	L	*	*	*	1E0000h~1EFFFFh
	BA38	L	L	L	H	H	H	H	H	*	*	*	1F0000h~1FFFFFh

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11.2. TC58FYM8B7D (Bottom boot block) 3/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK2	BA39	L	L	H	L	L	L	L	L	*	*	*	200000h~20FFFFh
	BA40	L	L	H	L	L	L	L	H	*	*	*	210000h~21FFFFh
	BA41	L	L	H	L	L	L	H	L	*	*	*	220000h~22FFFFh
	BA42	L	L	H	L	L	L	H	H	*	*	*	230000h~23FFFFh
	BA43	L	L	H	L	L	H	L	L	*	*	*	240000h~24FFFFh
	BA44	L	L	H	L	L	H	L	H	*	*	*	250000h~25FFFFh
	BA45	L	L	H	L	L	H	H	L	*	*	*	260000h~26FFFFh
	BA46	L	L	H	L	L	H	H	H	*	*	*	270000h~27FFFFh
	BA47	L	L	H	L	H	L	L	L	*	*	*	280000h~28FFFFh
	BA48	L	L	H	L	H	L	L	H	*	*	*	290000h~29FFFFh
	BA49	L	L	H	L	H	L	H	L	*	*	*	2A0000h~2AFFFFh
	BA50	L	L	H	L	H	L	H	H	*	*	*	2B0000h~2BFFFFh
	BA51	L	L	H	L	H	H	L	L	*	*	*	2C0000h~2CFFFFh
	BA52	L	L	H	L	H	H	L	H	*	*	*	2D0000h~2DFFFFh
BA53	L	L	H	L	H	H	H	L	*	*	*	2E0000h~2EFFFFh	
BA54	L	L	H	L	H	H	H	H	*	*	*	2F0000h~2FFFFh	
BK3	BA55	L	L	H	H	L	L	L	L	*	*	*	300000h~30FFFFh
	BA56	L	L	H	H	L	L	L	H	*	*	*	310000h~31FFFFh
	BA57	L	L	H	H	L	L	H	L	*	*	*	320000h~32FFFFh
	BA58	L	L	H	H	L	L	H	H	*	*	*	330000h~33FFFFh
	BA59	L	L	H	H	L	H	L	L	*	*	*	340000h~34FFFFh
	BA60	L	L	H	H	L	H	L	H	*	*	*	350000h~35FFFFh
	BA61	L	L	H	H	L	H	H	L	*	*	*	360000h~36FFFFh
	BA62	L	L	H	H	L	H	H	H	*	*	*	370000h~37FFFFh
	BA63	L	L	H	H	H	L	L	L	*	*	*	380000h~38FFFFh
	BA64	L	L	H	H	H	L	L	H	*	*	*	390000h~39FFFFh
	BA65	L	L	H	H	H	L	H	L	*	*	*	3A0000h~3AFFFFh
	BA66	L	L	H	H	H	L	H	H	*	*	*	3B0000h~3BFFFFh
	BA67	L	L	H	H	H	H	L	L	*	*	*	3C0000h~3CFFFFh
	BA68	L	L	H	H	H	H	L	H	*	*	*	3D0000h~3DFFFFh
	BA69	L	L	H	H	H	H	H	L	*	*	*	3E0000h~3EFFFFh
	BA70	L	L	H	H	H	H	H	H	*	*	*	3F0000h~3FFFFh

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11.2. TC58FYM8B7D (Bottom boot block) 4/9

Bank #	Block #	Block Address											Address Range	
		Bank Address				A19	A18	A17	A16	A15	A14	A13		
		A23	A22	A21	A20								Word mode	
BK4	BA71	L	H	L	L	L	L	L	L	*	*	*	40000h~40FFFFh	
	BA72	L	H	L	L	L	L	L	H	*	*	*	41000h~41FFFFh	
	BA73	L	H	L	L	L	L	L	H	*	*	*	42000h~42FFFFh	
	BA74	L	H	L	L	L	L	L	H	H	*	*	*	43000h~43FFFFh
	BA75	L	H	L	L	L	L	H	L	L	*	*	*	44000h~44FFFFh
	BA76	L	H	L	L	L	L	H	L	H	*	*	*	45000h~45FFFFh
	BA77	L	H	L	L	L	L	H	H	L	*	*	*	46000h~46FFFFh
	BA78	L	H	L	L	L	L	H	H	H	*	*	*	47000h~47FFFFh
	BA79	L	H	L	L	H	L	L	L	L	*	*	*	48000h~48FFFFh
	BA80	L	H	L	L	H	L	L	H	*	*	*	49000h~49FFFFh	
	BA81	L	H	L	L	H	L	H	L	*	*	*	4A000h~4AFFFFh	
	BA82	L	H	L	L	H	L	H	H	*	*	*	4B000h~4BFFFFh	
	BA83	L	H	L	L	H	H	L	L	*	*	*	4C000h~4CFFFFh	
	BA84	L	H	L	L	H	H	L	H	*	*	*	4D000h~4DFFFFh	
	BA85	L	H	L	L	H	H	H	L	*	*	*	4E000h~4EFFFFh	
	BA86	L	H	L	L	H	H	H	H	*	*	*	4F000h~4FFFFh	
BK5	BA87	L	H	L	H	L	L	L	L	*	*	*	50000h~50FFFFh	
	BA88	L	H	L	H	L	L	L	H	*	*	*	51000h~51FFFFh	
	BA89	L	H	L	H	L	L	H	L	*	*	*	52000h~52FFFFh	
	BA90	L	H	L	H	L	L	H	H	*	*	*	53000h~53FFFFh	
	BA91	L	H	L	H	L	H	L	L	*	*	*	54000h~54FFFFh	
	BA92	L	H	L	H	L	H	L	H	*	*	*	55000h~55FFFFh	
	BA93	L	H	L	H	L	H	H	L	*	*	*	56000h~56FFFFh	
	BA94	L	H	L	H	L	H	H	H	*	*	*	57000h~57FFFFh	
	BA95	L	H	L	H	H	L	L	L	*	*	*	58000h~58FFFFh	
	BA96	L	H	L	H	H	L	L	H	*	*	*	59000h~59FFFFh	
	BA97	L	H	L	H	H	L	H	L	*	*	*	5A000h~5AFFFFh	
	BA98	L	H	L	H	H	L	H	H	*	*	*	5B000h~5BFFFFh	
	BA99	L	H	L	H	H	H	L	L	*	*	*	5C000h~5CFFFFh	
	BA100	L	H	L	H	H	H	L	H	*	*	*	5D000h~5DFFFFh	
	BA101	L	H	L	H	H	H	H	L	*	*	*	5E000h~5EFFFFh	
	BA102	L	H	L	H	H	H	H	H	*	*	*	5F000h~5FFFFh	

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11.2. TC58FYM8B7D (Bottom boot block) 5/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK6	BA103	L	H	H	L	L	L	L	L	*	*	*	600000h~60FFFFh
	BA104	L	H	H	L	L	L	L	H	*	*	*	610000h~61FFFFh
	BA105	L	H	H	L	L	L	H	L	*	*	*	620000h~62FFFFh
	BA106	L	H	H	L	L	L	H	H	*	*	*	630000h~63FFFFh
	BA107	L	H	H	L	L	H	L	L	*	*	*	640000h~64FFFFh
	BA108	L	H	H	L	L	H	L	H	*	*	*	650000h~65FFFFh
	BA109	L	H	H	L	L	H	H	L	*	*	*	660000h~66FFFFh
	BA110	L	H	H	L	L	H	H	H	*	*	*	670000h~67FFFFh
	BA111	L	H	H	L	H	L	L	L	*	*	*	680000h~68FFFFh
	BA112	L	H	H	L	H	L	L	H	*	*	*	690000h~69FFFFh
	BA113	L	H	H	L	H	L	H	L	*	*	*	6A0000h~6AFFFFh
	BA114	L	H	H	L	H	L	H	H	*	*	*	6B0000h~6BFFFFh
	BA115	L	H	H	L	H	H	L	L	*	*	*	6C0000h~6CFFFFh
	BA116	L	H	H	L	H	H	L	H	*	*	*	6D0000h~6DFFFFh
BA117	L	H	H	L	H	H	H	L	*	*	*	6E0000h~6EFFFFh	
BA118	L	H	H	L	H	H	H	H	*	*	*	6F0000h~6FFFFFh	
BK7	BA119	L	H	H	H	L	L	L	L	*	*	*	700000h~70FFFFh
	BA120	L	H	H	H	L	L	L	H	*	*	*	710000h~71FFFFh
	BA121	L	H	H	H	L	L	H	L	*	*	*	720000h~72FFFFh
	BA122	L	H	H	H	L	L	H	H	*	*	*	730000h~73FFFFh
	BA123	L	H	H	H	L	H	L	L	*	*	*	740000h~74FFFFh
	BA124	L	H	H	H	L	H	L	H	*	*	*	750000h~75FFFFh
	BA125	L	H	H	H	L	H	H	L	*	*	*	760000h~76FFFFh
	BA126	L	H	H	H	L	H	H	H	*	*	*	770000h~77FFFFh
	BA127	L	H	H	H	H	L	L	L	*	*	*	780000h~78FFFFh
	BA128	L	H	H	H	H	L	L	H	*	*	*	790000h~79FFFFh
	BA129	L	H	H	H	H	L	H	L	*	*	*	7A0000h~7AFFFFh
	BA130	L	H	H	H	H	L	H	H	*	*	*	7B0000h~7BFFFFh
	BA131	L	H	H	H	H	H	L	L	*	*	*	7C0000h~7CFFFFh
	BA132	L	H	H	H	H	H	L	H	*	*	*	7D0000h~7DFFFFh
BA133	L	H	H	H	H	H	H	L	*	*	*	7E0000h~7EFFFFh	
BA134	L	H	H	H	H	H	H	H	*	*	*	7F0000h~7FFFFFh	

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11.2. TC58FYM8B7D (Bottom boot block) 6/9

Bank #	Block #	Block Address											Address Range	
		Bank Address				A19	A18	A17	A16	A15	A14	A13		
		A23	A22	A21	A20								Word mode	
BK8	BA135	H	L	L	L	L	L	L	L	*	*	*	800000h~80FFFFh	
	BA136	H	L	L	L	L	L	L	H	*	*	*	810000h~81FFFFh	
	BA137	H	L	L	L	L	L	L	H	L	*	*	*	820000h~82FFFFh
	BA138	H	L	L	L	L	L	L	H	H	*	*	*	830000h~83FFFFh
	BA139	H	L	L	L	L	L	H	L	L	*	*	*	840000h~84FFFFh
	BA140	H	L	L	L	L	L	H	L	H	*	*	*	850000h~85FFFFh
	BA141	H	L	L	L	L	L	H	H	L	*	*	*	860000h~86FFFFh
	BA142	H	L	L	L	L	L	H	H	H	*	*	*	870000h~87FFFFh
	BA143	H	L	L	L	L	H	L	L	L	*	*	*	880000h~88FFFFh
	BA144	H	L	L	L	L	H	L	L	H	*	*	*	890000h~89FFFFh
	BA145	H	L	L	L	L	H	L	H	L	*	*	*	8A0000h~8AFFFFh
	BA146	H	L	L	L	L	H	L	H	H	*	*	*	8B0000h~8BFFFFh
	BA147	H	L	L	L	L	H	H	L	L	*	*	*	8C0000h~8CFFFFh
	BA148	H	L	L	L	L	H	H	L	H	*	*	*	8D0000h~8DFFFFh
BA149	H	L	L	L	L	H	H	H	L	*	*	*	8E0000h~8EFFFFh	
BA150	H	L	L	L	L	H	H	H	H	*	*	*	8F0000h~8FFFFFh	
BK9	BA151	H	L	L	H	L	L	L	L	*	*	*	900000h~90FFFFh	
	BA152	H	L	L	H	L	L	L	H	*	*	*	910000h~91FFFFh	
	BA153	H	L	L	H	L	L	H	L	*	*	*	920000h~92FFFFh	
	BA154	H	L	L	H	L	L	H	H	*	*	*	930000h~93FFFFh	
	BA155	H	L	L	H	L	H	L	L	*	*	*	940000h~94FFFFh	
	BA156	H	L	L	H	L	H	L	H	*	*	*	950000h~95FFFFh	
	BA157	H	L	L	H	L	H	H	L	*	*	*	960000h~96FFFFh	
	BA158	H	L	L	H	L	H	H	H	*	*	*	970000h~97FFFFh	
	BA159	H	L	L	H	H	L	L	L	*	*	*	980000h~98FFFFh	
	BA160	H	L	L	H	H	L	L	H	*	*	*	990000h~99FFFFh	
	BA161	H	L	L	H	H	L	H	L	*	*	*	9A0000h~9AFFFFh	
	BA162	H	L	L	H	H	L	H	H	*	*	*	9B0000h~9BFFFFh	
	BA163	H	L	L	H	H	H	L	L	*	*	*	9C0000h~9CFFFFh	
	BA164	H	L	L	H	H	H	L	H	*	*	*	9D0000h~9DFFFFh	
	BA165	H	L	L	H	H	H	H	L	*	*	*	9E0000h~9EFFFFh	
	BA166	H	L	L	H	H	H	H	H	*	*	*	9F0000h~9FFFFFh	

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11.2. TC58FYM8B7D (Bottom boot block) 7/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK10	BA167	H	L	H	L	L	L	L	L	*	*	*	A00000h~A0FFFFh
	BA168	H	L	H	L	L	L	L	H	*	*	*	A10000h~A1FFFFh
	BA169	H	L	H	L	L	L	H	L	*	*	*	A20000h~A2FFFFh
	BA170	H	L	H	L	L	L	H	H	*	*	*	A30000h~A3FFFFh
	BA171	H	L	H	L	L	H	L	L	*	*	*	A40000h~A4FFFFh
	BA172	H	L	H	L	L	H	L	H	*	*	*	A50000h~A5FFFFh
	BA173	H	L	H	L	L	H	H	L	*	*	*	A60000h~A6FFFFh
	BA174	H	L	H	L	L	H	H	H	*	*	*	A70000h~A7FFFFh
	BA175	H	L	H	L	H	L	L	L	*	*	*	A80000h~A8FFFFh
	BA176	H	L	H	L	H	L	L	H	*	*	*	A90000h~A9FFFFh
	BA177	H	L	H	L	H	L	H	L	*	*	*	AA0000h~AAFFFFh
	BA178	H	L	H	L	H	L	H	H	*	*	*	AB0000h~ABFFFFh
	BA179	H	L	H	L	H	H	L	L	*	*	*	AC0000h~ACFFFFh
	BA180	H	L	H	L	H	H	L	H	*	*	*	AD0000h~ADFFFFh
	BA181	H	L	H	L	H	H	H	L	*	*	*	AE0000h~AEFFFFh
BA182	H	L	H	L	H	H	H	H	*	*	*	AF0000h~AFFFFFh	
BK11	BA183	H	L	H	H	L	L	L	L	*	*	*	B00000h~B0FFFFh
	BA184	H	L	H	H	L	L	L	H	*	*	*	B10000h~B1FFFFh
	BA185	H	L	H	H	L	L	H	L	*	*	*	B20000h~B2FFFFh
	BA186	H	L	H	H	L	L	H	H	*	*	*	B30000h~B3FFFFh
	BA187	H	L	H	H	L	H	L	L	*	*	*	B40000h~B4FFFFh
	BA188	H	L	H	H	L	H	L	H	*	*	*	B50000h~B5FFFFh
	BA189	H	L	H	H	L	H	H	L	*	*	*	B60000h~B6FFFFh
	BA190	H	L	H	H	L	H	H	H	*	*	*	B70000h~B7FFFFh
	BA191	H	L	H	H	H	L	L	L	*	*	*	B80000h~B8FFFFh
	BA192	H	L	H	H	H	L	L	H	*	*	*	B90000h~B9FFFFh
	BA193	H	L	H	H	H	L	H	L	*	*	*	BA0000h~BAFFFFh
	BA194	H	L	H	H	H	L	H	H	*	*	*	BB0000h~BBFFFFh
	BA195	H	L	H	H	H	H	L	L	*	*	*	BC0000h~BCFFFFh
	BA196	H	L	H	H	H	H	L	H	*	*	*	BD0000h~BDFFFFh
	BA197	H	L	H	H	H	H	H	L	*	*	*	BE0000h~BEFFFFh
	BA198	H	L	H	H	H	H	H	H	*	*	*	BF0000h~BFFFFFFh

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11.2. TC58FYM8B7D (Bottom boot block) 8/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	
		A23	A22	A21	A20								Word mode
BK12	BA199	H	H	L	L	L	L	L	L	*	*	*	C00000h~C0FFFFh
	BA200	H	H	L	L	L	L	L	H	*	*	*	C10000h~C1FFFFh
	BA201	H	H	L	L	L	L	H	L	*	*	*	C20000h~C2FFFFh
	BA202	H	H	L	L	L	L	H	H	*	*	*	C30000h~C3FFFFh
	BA203	H	H	L	L	L	H	L	L	*	*	*	C40000h~C4FFFFh
	BA204	H	H	L	L	L	H	L	H	*	*	*	C50000h~C5FFFFh
	BA205	H	H	L	L	L	H	H	L	*	*	*	C60000h~C6FFFFh
	BA206	H	H	L	L	L	H	H	H	*	*	*	C70000h~C7FFFFh
	BA207	H	H	L	L	H	L	L	L	*	*	*	C80000h~C8FFFFh
	BA208	H	H	L	L	H	L	L	H	*	*	*	C90000h~C9FFFFh
	BA209	H	H	L	L	H	L	H	L	*	*	*	CA0000h~CAFFFFh
	BA210	H	H	L	L	H	L	H	H	*	*	*	CB0000h~CBFFFFh
	BA211	H	H	L	L	H	H	L	L	*	*	*	CC0000h~CCFFFFh
	BA212	H	H	L	L	H	H	L	H	*	*	*	CD0000h~CDFFFFh
BA213	H	H	L	L	H	H	H	L	*	*	*	CE0000h~CEFFFFh	
BA214	H	H	L	L	H	H	H	H	*	*	*	CF0000h~CFFFFFh	
BK13	BA215	H	H	L	H	L	L	L	L	*	*	*	D00000h~D0FFFFh
	BA216	H	H	L	H	L	L	L	H	*	*	*	D10000h~D1FFFFh
	BA217	H	H	L	H	L	L	H	L	*	*	*	D20000h~D2FFFFh
	BA218	H	H	L	H	L	L	H	H	*	*	*	D30000h~D3FFFFh
	BA219	H	H	L	H	L	H	L	L	*	*	*	D40000h~D4FFFFh
	BA220	H	H	L	H	L	H	L	H	*	*	*	D50000h~D5FFFFh
	BA221	H	H	L	H	L	H	H	L	*	*	*	D60000h~D6FFFFh
	BA222	H	H	L	H	L	H	H	H	*	*	*	D70000h~D7FFFFh
	BA223	H	H	L	H	H	L	L	L	*	*	*	D80000h~D8FFFFh
	BA224	H	H	L	H	H	L	L	H	*	*	*	D90000h~D9FFFFh
	BA225	H	H	L	H	H	L	H	L	*	*	*	DA0000h~DAFFFFh
	BA226	H	H	L	H	H	L	H	H	*	*	*	DB0000h~DBFFFFh
	BA227	H	H	L	H	H	H	L	L	*	*	*	DC0000h~DCFFFFh
	BA228	H	H	L	H	H	H	L	H	*	*	*	DD0000h~DDFFFFh
	BA229	H	H	L	H	H	H	H	L	*	*	*	DE0000h~DEFFFFh
	BA230	H	H	L	H	H	H	H	H	*	*	*	DF0000h~DFFFFFh

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11.2. TC58FYM8B7D (Bottom boot block) 9/9

Bank #	Block #	Block Address											Address Range
		Bank Address				A19	A18	A17	A16	A15	A14	A13	Word mode
		A23	A22	A21	A20								
BK14	BA231	H	H	H	L	L	L	L	L	*	*	*	E0000h~E0FFFFh
	BA232	H	H	H	L	L	L	L	H	*	*	*	E1000h~E1FFFFh
	BA233	H	H	H	L	L	L	H	L	*	*	*	E2000h~E2FFFFh
	BA234	H	H	H	L	L	L	H	H	*	*	*	E3000h~E3FFFFh
	BA235	H	H	H	L	L	H	L	L	*	*	*	E4000h~E4FFFFh
	BA236	H	H	H	L	L	H	L	H	*	*	*	E5000h~E5FFFFh
	BA237	H	H	H	L	L	H	H	L	*	*	*	E6000h~E6FFFFh
	BA238	H	H	H	L	L	H	H	H	*	*	*	E7000h~E7FFFFh
	BA239	H	H	H	L	H	L	L	L	*	*	*	E8000h~E8FFFFh
	BA240	H	H	H	L	H	L	L	H	*	*	*	E9000h~E9FFFFh
	BA241	H	H	H	L	H	L	H	L	*	*	*	EA000h~EAFFFFh
	BA242	H	H	H	L	H	L	H	H	*	*	*	EB000h~EBFFFFh
	BA243	H	H	H	L	H	H	L	L	*	*	*	EC000h~ECFFFFh
	BA244	H	H	H	L	H	H	L	H	*	*	*	ED000h~EDFFFFh
BA245	H	H	H	L	H	H	H	L	*	*	*	EE000h~EEFFFFh	
BA246	H	H	H	L	H	H	H	H	*	*	*	EF000h~EFFFFFh	
BK15	BA247	H	H	H	H	L	L	L	L	*	*	*	F0000h~F0FFFFh
	BA248	H	H	H	H	L	L	L	H	*	*	*	F1000h~F1FFFFh
	BA249	H	H	H	H	L	L	H	L	*	*	*	F2000h~F2FFFFh
	BA250	H	H	H	H	L	L	H	H	*	*	*	F3000h~F3FFFFh
	BA251	H	H	H	H	L	H	L	L	*	*	*	F4000h~F4FFFFh
	BA252	H	H	H	H	L	H	L	H	*	*	*	F5000h~F5FFFFh
	BA253	H	H	H	H	L	H	H	L	*	*	*	F6000h~F6FFFFh
	BA254	H	H	H	H	L	H	H	H	*	*	*	F7000h~F7FFFFh
	BA255	H	H	H	H	H	L	L	L	*	*	*	F8000h~F8FFFFh
	BA256	H	H	H	H	H	L	L	H	*	*	*	F9000h~F9FFFFh
	BA257	H	H	H	H	H	L	H	L	*	*	*	FA000h~FAFFFFh
	BA258	H	H	H	H	H	L	H	H	*	*	*	FB000h~FBFFFFh
	BA259	H	H	H	H	H	H	L	L	*	*	*	FC000h~FCFFFFh
	BA260	H	H	H	H	H	H	L	H	*	*	*	FD000h~FDFFFFh
	BA261	H	H	H	H	H	H	H	L	*	*	*	FE000h~FEFFFFh
	BA262	H	H	H	H	H	H	H	H	*	*	*	FF000h~FFFFFFh

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12. BLOCK SIZE TABLE

12.1. TC58FYM8T7D (Top boot block)

Block #	Block size	Bank #	Bank size	Number of block
BA0~BA15	64Kwords x 16	BK0	1024Kwords	16
BA16~BA31	64Kwords x 16	BK1	1024Kwords	16
BA32~BA47	64Kwords x 16	BK2	1024Kwords	16
BA48~BA63	64Kwords x 16	BK3	1024Kwords	16
BA64~BA79	64Kwords x 16	BK4	1024Kwords	16
BA80~BA95	64Kwords x 16	BK5	1024Kwords	16
BA96~BA111	64Kwords x 16	BK6	1024Kwords	16
BA112~BA127	64Kwords x 16	BK7	1024Kwords	16
BA128~BA143	64Kwords x 16	BK8	1024Kwords	16
BA144~BA159	64Kwords x 16	BK9	1024Kwords	16
BA160~BA175	64Kwords x 16	BK10	1024Kwords	16
BA176~BA191	64Kwords x 16	BK11	1024Kwords	16
BA192~BA207	64Kwords x 16	BK12	1024Kwords	16
BA208~BA223	64Kwords x 16	BK13	1024Kwords	16
BA224~BA239	64Kwords x 16	BK14	1024Kwords	16
BA240~BA254	64Kwords x 15	BK15	1024Kwords	23
BA255~BA262	8Kwords x 8			

12.2. TC58FYM8B7D (Bottom boot block)

Block #	Block size	Bank #	Bank size	Number of block
BA0~BA7	8Kwords x 8	BK0	1024Kwords	23
BA8~BA22	64Kwords x 15			
BA23~BA38	64Kwords x 16	BK1	1024Kwords	16
BA39~BA54	64Kwords x 16	BK2	1024Kwords	16
BA55~BA70	64Kwords x 16	BK3	1024Kwords	16
BA71~BA86	64Kwords x 16	BK4	1024Kwords	16
BA87~BA102	64Kwords x 16	BK5	1024Kwords	16
BA103~BA118	64Kwords x 16	BK6	1024Kwords	16
BA119~BA134	64Kwords x 16	BK7	1024Kwords	16
BA135~BA150	64Kwords x 16	BK8	1024Kwords	16
BA151~BA166	64Kwords x 16	BK9	1024Kwords	16
BA167~BA182	64Kwords x 16	BK10	1024Kwords	16
BA183~BA198	64Kwords x 16	BK11	1024Kwords	16
BA199~BA214	64Kwords x 16	BK12	1024Kwords	16
BA215~BA230	64Kwords x 16	BK13	1024Kwords	16
BA231~BA246	64Kwords x 16	BK14	1024Kwords	16
BA247~BA262	64Kwords x 16	BK15	1024Kwords	16